



# THE DATASHEET OF MC56F84766VLK

# MC56F847XX

## MC56F847XX

Supports the 56F84789VLL,  
56F84786VLK, 56F84769VLL,  
56F84766VLK, 56F84763VLH

### Features

- This family of digital signal controllers (DSCs) is based on the 32-bit 56800EX core. Each device combines, on a single chip, the processing power of a DSP and the functionality of an MCU with a flexible set of peripherals to support many target applications:
  - Industrial control
  - Home appliances
  - Smart sensors
  - Fire and security systems
  - Switched-mode power supply and power management
  - Uninterruptible Power Supply (UPS)
  - Solar and wind power generator
  - Power metering
  - Motor control (ACIM, BLDC, PMSM, SR, stepper)
  - Handheld power tools
  - Circuit breaker
  - Medical device/equipment
  - Instrumentation
  - Lighting
- DSC based on 32-bit 56800EX core
  - Up to 100 MIPS at 100 MHz core frequency
  - DSP and MCU functionality in a unified, C-efficient architecture
- On-chip memory
  - Up to 288 KB (256 KB + 32 KB) flash memory, including up to 32 KB FlexNVM
  - Up to 32 KB RAM
  - Up to 2 KB FlexRAM with EEE capability
  - 100 MHz program execution from both internal flash memory and RAM
  - On-chip flash memory and RAM can be mapped into both program and data memory spaces
- Analog
  - Two high-speed, 8-channel, 12-bit ADCs with dynamic x2, x4 programmable amplifier
  - One 20-channel, 16-bit ADC
  - Four analog comparators with integrated 6-bit DAC references
  - One 12-bit DAC
- PWMs and timers
  - Two eFlexPWM modules with up to 24 PWM outputs, one including 8 channels with high resolution NanoEdge placement
  - Two 16-bit quad timer (2 x 4 16-bit timers)
  - Two Periodic Interval Timers (PITs)
  - One Quadrature Decoder
  - Two Programmable Delay Blocks (PDBs)
- Communication interfaces
  - Three high-speed queued SCI (QSCI) modules with LIN slave functionality
  - Up to three queued SPI (QSPI) modules
  - Two SMBus-compatible I2C ports
  - One flexible controller area network (FlexCAN) module
- Security and integrity
  - Cyclic Redundancy Check (CRC) generator
  - Computer operating properly (COP) watchdog
  - External Watchdog Monitor (EWM)
- Clocks
  - Two on-chip relaxation oscillators: 8 MHz (400 kHz at standby mode) and 32 kHz
  - Crystal / resonator oscillator
- System
  - DMA controller
  - Integrated power-on reset (POR) and low-voltage interrupt (LVI) and brown-out reset module
  - Inter-module crossbar connection
  - JTAG/enhanced on-chip emulation (EOnCE) for unobtrusive, real-time debugging

Freescale reserves the right to change the detail specifications as may be required to permit improvements in the design of its products.

- Operating characteristics
  - Single supply: 3.0 V to 3.6 V
  - 5 V–tolerant I/O (except RESETB pin)
- LQFP packages:
  - 64-pin
  - 80-pin
  - 100-pin

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# 1 Overview

## 1.1 MC56F844xx/5xx/7xx product family

The following table lists major features, including features that differ among members of the family. Features not listed are shared by all members of the family.

**Table 1. 56F844xx/5xx/7xx family**

| Part Number                                              | MC56F84 |        |        |        |        |        |        |        |        |        |        |        |        |        |        |        |        |        |
|----------------------------------------------------------|---------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|
|                                                          | 789     | 786    | 769    | 766    | 763    | 553    | 550    | 543    | 540    | 587    | 585    | 567    | 565    | 462    | 452    | 451    | 442    | 441    |
| Core freq. (MHz)                                         | 100     | 100    | 100    | 100    | 100    | 80     | 80     | 80     | 80     | 80     | 80     | 80     | 80     | 60     | 60     | 60     | 60     | 60     |
| Flash memory (KB)                                        | 256     | 256    | 128    | 128    | 128    | 96     | 96     | 64     | 64     | 256    | 256    | 128    | 128    | 128    | 96     | 96     | 64     | 64     |
| FlevNVM/ FlexRAM (KB)                                    | 32/2    | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   | 32/2   |
| Total flash memory (KB) <sup>1</sup>                     | 288     | 288    | 160    | 160    | 160    | 128    | 128    | 96     | 96     | 288    | 288    | 160    | 160    | 160    | 128    | 128    | 96     | 96     |
| RAM (KB)                                                 | 32      | 32     | 24     | 24     | 24     | 16     | 16     | 8      | 8      | 32     | 32     | 24     | 24     | 24     | 16     | 16     | 8      | 8      |
| Memory resource protection                               | Yes     | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    | Yes    |
| External Watchdog                                        | 1       | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      | 1      |
| 12-bit Cyclic ADC Channels (ADCA and ADCB)               | 2x8     | 2x8    | 2x8    | 2x8    | 2x8    | 2x8    | 2x5    | 2x8    | 2x5    | 2x8    | 2x8    | 2x8    | 2x8    | 2x8    | 2x8    | 2x5    | 2x8    | 2x5    |
| 12-bit Cyclic ADC Conversion time (ADCA and ADCB)        | 300 ns  | 300 ns | 300 ns | 300 ns | 300 ns | 300 ns | 300 ns | 300 ns | 300 ns | 600 ns | 600 ns | 600 ns | 600 ns | 600 ns | 600 ns | 600 ns | 600 ns | 600 ns |
| 16-bit SAR ADC (with Temperature Sensor) channels (ADCC) | 16      | 10     | 16     | 10     | 8      | 8      | –      | 8      | –      | 16     | 10     | 16     | 10     | –      | 8      | –      | 8      | –      |
| PWMA High-res channels                                   | 8       | 8      | 8      | 8      | 8      | 8      | 6      | 8      | 6      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |

Table continues on the next page...

**Table 1. 56F844xx/5xx/7xx family (continued)**

| Part Number                 | MC56F84 |                |     |                |     |     |     |     |     |     |                |     |                |     |     |     |     |     |
|-----------------------------|---------|----------------|-----|----------------|-----|-----|-----|-----|-----|-----|----------------|-----|----------------|-----|-----|-----|-----|-----|
|                             | 789     | 786            | 769 | 766            | 763 | 553 | 550 | 543 | 540 | 587 | 585            | 567 | 565            | 462 | 452 | 451 | 442 | 441 |
| PWMA Std channels           | 4       | 1              | 4   | 1              | 1   | 1   | 0   | 1   | 0   | 12  | 12             | 12  | 12             | 9   | 9   | 6   | 9   | 6   |
| PWMA Input capture channels | 12      | 9              | 12  | 9              | 9   | 9   | 6   | 9   | 6   | 12  | 12             | 12  | 12             | 9   | 9   | 6   | 9   | 6   |
| PWMB Std channels           | 12      | 9 <sup>2</sup> | 12  | 9 <sup>2</sup> | –   | –   | –   | –   | –   | 12  | 9 <sup>2</sup> | 12  | 9 <sup>2</sup> | –   | –   | –   | –   | –   |
| PWMB Input capture channels | 12      | 7              | 12  | 7              | –   | –   | –   | –   | –   | 12  | 7              | 12  | 7              | –   | –   | –   | –   | –   |
| 12-bit DAC                  | 1       | 1              | 1   | 1              | 1   | 1   | 1   | 1   | 1   | 1   | 1              | –   | –              | 1   | –   | –   | –   | –   |
| Quad Decoder                | 1       | 1              | 1   | 1              | 1   | 1   | 1   | 1   | 1   | 1   | 1              | 1   | 1              | 1   | 1   | 1   | 1   | 1   |
| DMA                         | Yes     | Yes            | Yes | Yes            | Yes | Yes | Yes | Yes | Yes | Yes | Yes            | Yes | Yes            | Yes | Yes | Yes | Yes | Yes |
| CMP                         | 4       | 4              | 4   | 4              | 4   | 4   | 3   | 4   | 3   | 4   | 4              | 4   | 4              | 4   | 4   | 3   | 4   | 3   |
| QSCI                        | 3       | 3              | 3   | 3              | 2   | 2   | 2   | 2   | 2   | 3   | 3              | 3   | 3              | 2   | 2   | 2   | 2   | 2   |
| QSPI                        | 3       | 2              | 3   | 2              | 1   | 1   | 1   | 1   | 1   | 3   | 2              | 3   | 2              | 1   | 1   | 1   | 1   | 1   |
| I2C/SMBus                   | 2       | 2              | 2   | 2              | 2   | 2   | 2   | 2   | 2   | 2   | 2              | 2   | 2              | 2   | 2   | 2   | 2   | 2   |
| FlexCAN                     | 1       | 1              | 1   | 1              | 1   | 1   | 1   | 1   | 1   | 1   | 1              | 1   | 1              | 1   | 1   | 1   | 0   | 0   |
| LQFP package pin count      | 100     | 80             | 100 | 80             | 64  | 64  | 48  | 64  | 48  | 100 | 80             | 100 | 80             | 64  | 64  | 48  | 64  | 48  |

1. This total includes FlexNVM and assumes no FlexNVM is used with FlexRAM for EEPROM.

2. The outputs of PWMB\_3A and PWM\_3B are available through the on-chip inter-module crossbar.

## 1.2 56800EX 32-bit Digital Signal Controller (DSC) core

- Efficient 32-bit 56800EX Digital Signal Processor (DSP) engine with modified dual Harvard architecture:
  - Three internal address buses
  - Four internal data buses: two 32-bit primary buses, one 16-bit secondary data bus, and one 16-bit instruction bus
  - 32-bit data accesses
  - Supports concurrent instruction fetches in the same cycle, and dual data accesses in the same cycle
  - 20 addressing modes
- As many as 100 million instructions per second (MIPS) at 100 MHz core frequency
- 162 basic instructions
- Instruction set supports both fractional arithmetic and integer arithmetic

- 32-bit internal primary data buses support 8-bit, 16-bit, and 32-bit data movement, plus addition, subtraction, and logical operations
- Single-cycle  $16 \times 16$ -bit  $\rightarrow$  32-bit and  $32 \times 32$ -bit  $\rightarrow$  64-bit multiplier-accumulator (MAC) with dual parallel moves
- 32-bit arithmetic and logic multi-bit shifter
- Four 36-bit accumulators, including extension bits
- Parallel instruction set with unique DSP addressing modes
- Hardware DO and REP loops
- Bit reverse address mode, which effectively supports DSP and Fast Fourier Transform algorithms
- Full shadowing of the register stack for zero-overhead context saves and restores: nine shadow registers correspond to nine address registers (R0, R1, R2, R3, R4, R5, N, N3, M01)
- Instruction set supports both DSP and controller functions
- Controller-style addressing modes and instructions enable compact code
- Enhanced bit manipulation instruction set
- Efficient C compiler and local variable support
- Software subroutine and interrupt stack, with the stack's depth limited only by memory
- Priority level setting for interrupt levels
- JTAG/Enhanced On-Chip Emulation (OnCE) for unobtrusive, real-time debugging that is independent of processor speed

### 1.3 Operation parameters

- Up to 100 MHz operation at  $-40^{\circ}\text{C}$  to  $105^{\circ}\text{C}$  ambient temperature
- Single 3.3 V power supply
- Supply range:  $V_{\text{DD}} - V_{\text{SS}} = 2.7\text{ V}$  to  $3.6\text{ V}$ ,  $V_{\text{DDA}} - V_{\text{SSA}} = 2.7\text{ V}$  to  $3.6\text{ V}$

### 1.4 On-chip memory and memory protection

- Modified dual Harvard architecture permits as many as three simultaneous accesses to program and data memory
- Internal flash memory with security and protection to prevent unauthorized access
- Memory resource protection (MRP) unit to protect supervisor programs and resources from user programs
- Programming code can reside in flash memory during flash programming
- The dual-ported RAM controller supports concurrent instruction fetches and data accesses, or dual data accesses, by the DSC core.

- Concurrent accesses provide increased performance.
- The data and instruction arrive at the core in the same cycle, reducing latency.
- On-chip memory
  - Up to 144 KW program/data flash memory, including FlexNVM
  - Up to 16 KW dual port data/program RAM
  - Up to 16 KW FlexNVM, which can be used as additional program or data flash memory
  - Up to 1 KW FlexRAM, which can be configured as enhanced EEPROM (used in conjunction with FlexNVM) or used as additional RAM

## 1.5 Interrupt Controller

- Five interrupt priority levels
  - Three user-programmable priority levels for each interrupt source: level 0, level 1, level 2
  - Unmaskable level 3 interrupts include illegal instruction, hardware stack overflow, misaligned data access, SWI3 instruction
  - Interrupt level 3 is highest priority and non-maskable. Its sources include:
    - Illegal instructions
    - Hardware stack overflow
    - SWI instruction
    - EOnce interrupts
    - Misaligned data accesses
  - Lowest-priority software interrupt: level LP
- Support for nested interrupts, so that a higher priority level interrupt request can interrupt lower priority interrupt subroutine
- Masking of interrupt priority level is managed by the 56800EX core
- Two programmable fast interrupts that can be assigned to any interrupt source
- Notification to System Integration Module (SIM) to restart clock when in wait and stop states
- Ability to relocate interrupt vector table

## 1.6 Peripheral highlights

### 1.6.1 Enhanced Flex Pulse Width Modulator (eFlexPWM)

- Two PWM modules contain 4 identical submodules, each with up to 3 outputs per submodule, and up to 100 MHz PWM operating clock
- 16 bits of resolution for center, edge-aligned, and asymmetrical PWMs

- PWMA with NanoEdge high resolution
  - Fractional delay for enhanced resolution of the PWM period and edge placement
  - Arbitrary PWM edge placement
  - 390 ps PWM frequency and duty-cycle resolution when NanoEdge functionality is enabled.
  - Fractional clock digital dithering: 5-bit digital fractional clock accumulation for enhanced resolution of PWM period and edge placement, which is effectively equivalent to 390 ps resolution in the overall accumulative period.
- PWM outputs can be configured as complementary output pairs or independent outputs
- PWMB with 10 ns resolution at 100 MHz PWM operation clock
- Dedicated time-base counter with period and frequency control per submodule
- Independent top and bottom deadtime insertion for each complementary pair
- Independent control of both edges of each PWM output
- Enhanced input capture and output compare functionality on each input:
  - Channels not used for PWM generation can be used for buffered output compare functions.
  - Channels not used for PWM generation can be used for input capture functions.
  - Enhanced dual edge capture functionality
- Synchronization of submodule to external hardware (or other PWM) is supported.
- Double-buffered PWM registers
  - Integral reload rates from 1 to 16
  - Half-cycle reload capability
- Multiple output trigger events can be generated per PWM cycle via hardware.
- Support for double-switching PWM outputs
- Up to eight fault inputs can be assigned to control multiple PWM outputs
  - Programmable filters for fault inputs
- Independently programmable PWM output polarity
- Individual software control of each PWM output
- All outputs can be programmed to change simultaneously via a FORCE\_OUT event.
- PWMX pin can optionally output a third PWM signal from each submodule
- Option to supply the source for each complementary PWM signal pair from any of the following:
  - Crossbar module outputs
  - External ADC input, taking into account values set in ADC high and low limit registers

### 1.6.2 12-bit Analog-to-Digital Converter (Cyclic type)

- Two independent 12-bit analog-to-digital converters (ADCs):
  - 2 x 8-channel external inputs

- Built-in x1, x2, x4 programmable gain pre-amplifier
- Maximum ADC clock frequency up to 20 MHz, having period as low as a 50-ns
- Single conversion time of 8.5 ADC clock cycles
- Additional conversion time of 6 ADC clock cycles
- Support of analog inputs for single-ended and differential conversions
- Sequential, parallel, and independent scan mode
- First 8 samples have offset, limit and zero-crossing calculation supported
- ADC conversions can be synchronized by *any* module connected to the internal crossbar module, such as PWM, timer, GPIO, and comparator modules.
- Support for simultaneous triggering and software-triggering conversions
- Support for a multi-triggering mode with a programmable number of conversions on each trigger
- Each ADC has ability to scan and store up to 8 conversion results.
- Current injection protection

### 1.6.3 Inter-Module Crossbar and AND-OR-INVERT logic

- Provides generalized connections between and among on-chip peripherals: ADCs, 12-bit DAC, comparators, quad-timers, eFlexPWMs, PDBs, EWM, quadrature decoder, and select I/O pins
- User-defined input/output pins for all modules connected to the crossbar
- DMA request and interrupt generation from the crossbar
- Write-once protection for all registers
- AND-OR-INVERT function provides a universal Boolean function generator that uses a four-term sum-of-products expression, with each product term containing true or complement values of the four selected inputs (A, B, C, D).

### 1.6.4 Comparator

- Full rail-to-rail comparison range
- Support for high and low speed modes
- Selectable input source includes external pins and internal DACs
- Programmable output polarity
- 6-bit programmable DAC as a voltage reference per comparator
- Three programmable hysteresis levels
- Selectable interrupt on rising-edge, falling-edge, or toggle of a comparator output

### 1.6.5 12-bit Digital-to-Analog Converter

- 12-bit resolution

- Powerdown mode
- Automatic mode allows the DAC to automatically generate pre-programmed output waveforms, including square, triangle, and sawtooth waveforms (for applications like slope compensation)
- Programmable period, update rate, and range
- Output can be routed to an internal comparator, ADC, or optionally to an off-chip destination

### 1.6.6 Quad Timer

- Four 16-bit up/down counters, with a programmable prescaler for each counter
- Operation modes: edge count, gated count, signed count, capture, compare, PWM, signal shot, single pulse, pulse string, cascaded, quadrature decode
- Programmable input filter
- Counting start can be synchronized across counters

### 1.6.7 Queued Serial Communications Interface (QSCI) modules

- Operating clock can be up to two times the CPU operating frequency
- Four-word-deep FIFOs available on both transmit and receive buffers
- Standard mark/space non-return-to-zero (NRZ) format
- 13-bit integer and 3-bit fractional baud rate selection
- Full-duplex or single-wire operation
- Programmable 8-bit or 9-bit data format
- Error detection capability
- Two receiver wakeup methods:
  - Idle line
  - Address mark
- 1/16 bit-time noise detection

### 1.6.8 Queued Serial Peripheral Interface (QSPI) modules

- Maximum 25 Mbit/s baud rate
- Selectable baud rate clock sources for low baud rate communication
- Baud rate as low as  $\text{Baudrate\_Freq\_in} / 8192$
- Full-duplex operation
- Master and slave modes
- Double-buffered operation with separate transmit and receive registers
- Four-word-deep FIFOs available on transmit and receive buffers

- Programmable length transmissions (2 bits to 16 bits)
- Programmable transmit and receive shift order (MSB as first bit transmitted)

### 1.6.9 Inter-Integrated Circuit (I2C)/System Management Bus (SMBus) modules

- Compatible with I2C bus standard
- Support for System Management Bus (SMBus) specification, version 2
- Multi-master operation
- General call recognition
- 10-bit address extension
- Start/Repeat and Stop indication flags
- Support for dual slave addresses or configuration of a range of slave addresses
- Programmable glitch input filter

### 1.6.10 Flex Controller Area Network (FlexCAN) module

- Clock source from PLL or XOSC/CLKIN
- Implementation of CAN protocol Version 2.0 A/B
- Standard and extended data frames
- Data length of 0 to 8 bytes
- Programmable bit rate up to 1 Mbps
- Support for remote frames
- Sixteen Message Buffers: each Message Buffer can be configured as receive or transmit, and supports standard and extended messages
- Individual Rx Mask Registers per Message Buffer
- Internal timer for time-stamping of received and transmitted messages
- Listen-only mode capability
- Programmable loopback mode, supporting self-test operation
- Programmable transmission priority scheme: lowest ID, lowest buffer number, or highest priority
- Global network time, synchronized by a specific message
- Low power modes, with programmable wakeup on bus activity

### 1.6.11 Computer Operating Properly (COP) watchdog

- Programmable timeout period
- Support for operation in all power modes: run mode, wait mode, stop mode
- Causes loss of reference reset 128 cycles after loss of reference clock to the PLL is detected

- Selectable reference clock source in support of EN60730 and IEC61508
- Selectable clock sources:
  - External crystal oscillator/external clock source
  - On-chip low-power 32 kHz oscillator
  - System bus (IPBus up to 100 MHz)
  - 8 MHz / 400 kHz ROSC
- Support for interrupt triggered when the counter reaches the timeout value

### 1.6.12 Power supervisor

- Power-on reset (POR) to reset CPU, peripherals, and JTAG/EOnCE controllers ( $V_{DD} > 2.1$  V)
- Brownout reset ( $V_{DD} < 1.9$  V)
- Critical warn low-voltage interrupt (LVI2.0)
- Peripheral low-voltage interrupt (LVI2.7)

### 1.6.13 Phase-locked loop

- Wide programmable output frequency: 240 MHz to 400 MHz
- Input reference clock frequency: 8 MHz to 16 MHz
- Detection of loss of lock and loss of reference clock
- Ability to power down

### 1.6.14 Clock sources

#### 1.6.14.1 On-chip oscillators

- Tunable 8 MHz relaxation oscillator with 400 kHz at standby mode (divide-by-two output)
- 32 kHz low frequency clock as secondary clock source for COP, EWM, PIT

#### 1.6.14.2 Crystal oscillator

- Support for both high ESR crystal oscillator (ESR greater than 100  $\Omega$ ) and ceramic resonator
- Operating frequency: 4–16 MHz

### 1.6.15 Cyclic Redundancy Check (CRC) generator

- Hardware 16/32-bit CRC generator
- High-speed hardware CRC calculation

- Programmable initial seed value
- Programmable 16/32-bit polynomial
- Error detection for all single, double, odd, and most multi-bit errors
- Option to transpose input data or output data (CRC result) bitwise or bytewise,<sup>1</sup> which is required for certain CRC standards
- Option for inversion of final CRC result

### 1.6.16 General Purpose I/O (GPIO)

- 5 V tolerance (except RESETB pin)
- Individual control of peripheral mode or GPIO mode for each pin
- Programmable push-pull or open drain output
- Configurable pullup or pulldown on all input pins
- All pins (except JTAG and RESETB) default to be GPIO inputs
- 2 mA / 9 mA source/sink capability
- Controllable output slew rate

## 1.7 Block diagrams

The 56800EX core is based on a modified dual Harvard-style architecture, consisting of three execution units operating in parallel, and allowing as many as six operations per instruction cycle. The MCU-style programming model and optimized instruction set enable straightforward generation of efficient and compact code for the DSP and control functions. The instruction set is also efficient for C compilers, to enable rapid development of optimized control applications.

The device's basic architecture appears in [Figure 1](#) and [Figure 2](#). [Figure 1](#) shows how the 56800EX system buses communicate with internal memories, and the IPBus interface and the internal connections among the units of the 56800EX core. [Figure 2](#) shows the peripherals and control blocks connected to the IPBus bridge. See the specific device's Reference Manual for details.

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1. A bytewise transposition is not possible when accessing the CRC data register via 8-bit accesses. In this case, user software must perform the bytewise transposition.

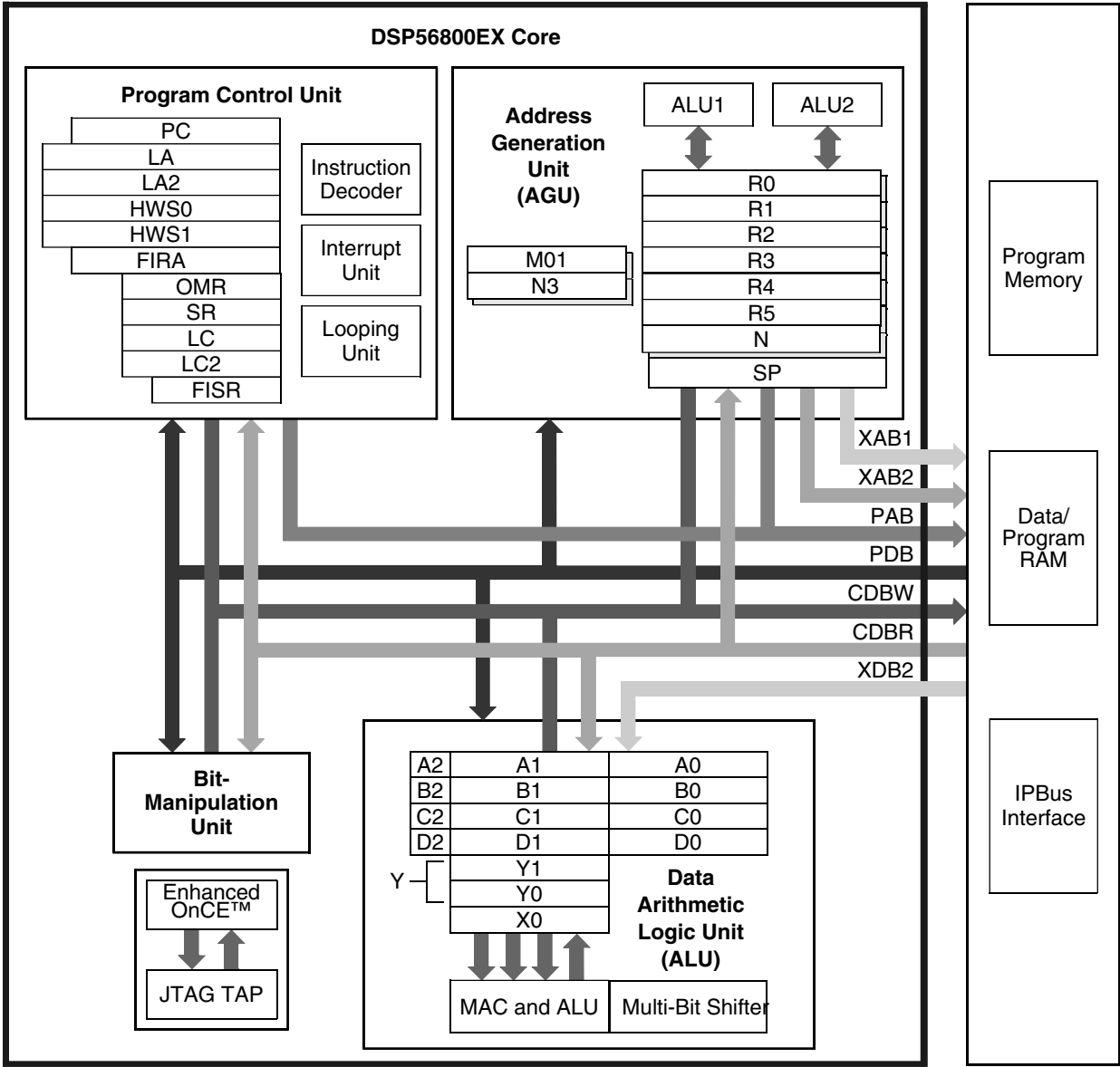


Figure 1. 56800EX basic block diagram

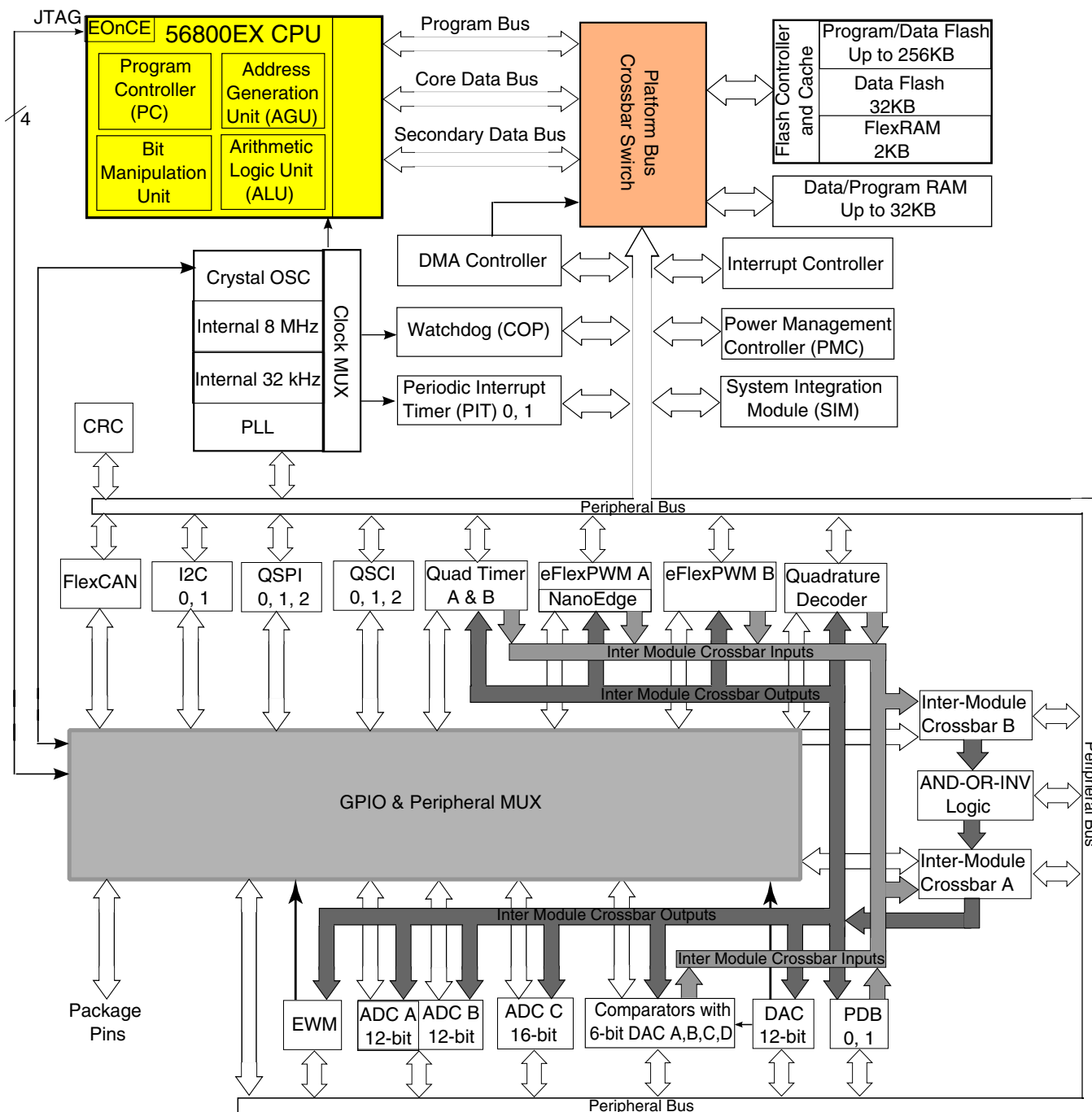


Figure 2. System diagram

## 2 MC56F847xx signal and pin descriptions

After reset, each pin is configured for its primary function (listed first). Any alternative functionality, shown in parentheses, must be programmed through the GPIO module peripheral enable registers (GPIO\_x\_PER) and the SIM module GPIO peripheral select (GPSx) registers. All GPIO ports can be individually programmed as an input or output (using bit manipulation).

- There are 2 PWM modules: PWMA, PWMB. Each PWM module has 4 submodules: PWMA has PWMA\_0, PWMA\_1, PWMA\_2, PWMA\_3; PWMB has PWMB\_0, PWMB\_1, PWMB\_2, PWMB\_3. Each PWM module's submodules have 3 pins (A, B, X) each, with the syntax for the pins being PWMA\_0A, PWMA\_0B, PWMA\_0X, and PWMA\_1A, PWMA\_1B, PWMA\_1X, and so on. Each submodule pin can be configured as a PWM output or as a capture input.
- PWMA\_FAULT0, PWMA\_FAULT1, and similar signals are inputs used to disable selected PWMA (or PWMB) outputs, in cases where the fault conditions originate off-chip.
- EWM\_OUT\_B is the output of the External Watchdog Module (EWM), and is active low (denoted by the "\_B" part of the syntax).

For the MC56F847XX products, which use 64-pin LQFP, 80-pin LQFP, and 100-pin LQFP packages:

**Table 2. Signal descriptions**

| Signal Name      | 100 LQFP | 80 LQFP | 64 LQFP | Type   | State During Reset <sup>1</sup> | Signal Description                                                                                              |
|------------------|----------|---------|---------|--------|---------------------------------|-----------------------------------------------------------------------------------------------------------------|
| V <sub>DD</sub>  | 7        | -       | -       | Supply | Supply                          | I/O Power — Supplies 3.3 V power to the chip I/O interface.                                                     |
| V <sub>DD</sub>  | 43       | 35      | 29      |        |                                 |                                                                                                                 |
| V <sub>DD</sub>  | 67       | 54      | 44      |        |                                 |                                                                                                                 |
| V <sub>DD</sub>  | 96       | 76      | 60      |        |                                 |                                                                                                                 |
| V <sub>SS</sub>  | 8        | -       | -       | Supply | Supply                          | I/O Ground — Provide ground for the device I/O interface.                                                       |
| V <sub>SS</sub>  | 15       | 11      | -       |        |                                 |                                                                                                                 |
| V <sub>SS</sub>  | 44       | 36      | 30      |        |                                 |                                                                                                                 |
| V <sub>SS</sub>  | 66       | 53      | 43      |        |                                 |                                                                                                                 |
| V <sub>SS</sub>  | 97       | 77      | 61      |        |                                 |                                                                                                                 |
| V <sub>DDA</sub> | 31       | 26      | 22      | Supply | Supply                          | Analog Power — Supplies 3.3 V power to the analog modules. It must be connected to a clean analog power supply. |
| V <sub>SSA</sub> | 32       | 27      | 23      | Supply | Supply                          | Analog Ground — Supplies an analog ground to the analog modules. It must be connected to a clean power supply.  |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name      | 100 LQFP | 80 LQFP | 64 LQFP | Type                             | State During Reset <sup>1</sup>  | Signal Description                                                                                                                                                                                                                                                                    |
|------------------|----------|---------|---------|----------------------------------|----------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| V <sub>CAP</sub> | 16       | 12      | -       | On-chip regulator output voltage | On-chip regulator output voltage | Connect a 2.2uF or greater bypass capacitor between this pin and V <sub>SS</sub> to stabilize the core voltage regulator output required for proper device operation. V <sub>CAP</sub> is used to observe core voltage.                                                               |
| V <sub>CAP</sub> | 35       | 30      | 26      |                                  |                                  |                                                                                                                                                                                                                                                                                       |
| V <sub>CAP</sub> | 93       | 73      | 57      |                                  |                                  |                                                                                                                                                                                                                                                                                       |
| <b>TDI</b>       | 100      | 80      | 64      | Input                            | Input, internal pullup enabled   | Test Data Input — Provides a serial input data stream to the JTAG/EOnCE port. It is sampled on the rising edge of TCK and has an internal pullup resistor. After reset, the default state is TDI.                                                                                     |
| (GPIO D0)        |          |         |         | Input/Output                     | Input, internal pullup enabled   | GPIO Port D0                                                                                                                                                                                                                                                                          |
| <b>TDO</b>       | 98       | 78      | 62      | Output                           | Output                           | Test Data Output — This tri-stateable pin provides a serial output data stream from the JTAG/EOnCE port. It is driven in the shift-IR and shift-DR controller states, and it changes on the falling edge of TCK. After reset, the default state is TDO.                               |
| (GPIO D1)        |          |         |         | Input/Output                     | Input, internal pullup enabled   | GPIO Port D1                                                                                                                                                                                                                                                                          |
| <b>TCK</b>       | 1        | 1       | 1       | Input                            | Input, internal pullup enabled   | Test Clock Input — This input pin provides a gated clock to synchronize the test logic and shift serial data to the JTAG/EOnCE port. The pin is connected internally to a pullup resistor. A Schmitt-trigger input is used for noise immunity. After reset, the default state is TCK. |
| (GPIO D2)        |          |         |         | Input/Output                     | Input, internal pullup enabled   | GPIO Port D2                                                                                                                                                                                                                                                                          |

Table continues on the next page...

Table 2. Signal descriptions (continued)

| Signal Name                   | 100 LQFP | 80 LQFP | 64 LQFP | Type                     | State During Reset <sup>1</sup>                         | Signal Description                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-------------------------------|----------|---------|---------|--------------------------|---------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>TMS</b>                    | 99       | 79      | 63      | Input                    | Input, internal pullup enabled                          | Test Mode Select Input — Used to sequence the JTAG TAP controller state machine. It is sampled on the rising edge of TCK and has an internal pullup resistor. After reset, the default state is TMS.<br><br><b>NOTE:</b> Always tie the TMS pin to V <sub>DD</sub> through a 2.2K resistor, if needed to keep an on-board debug capability. Otherwise, tie the TMS pin directly to V <sub>DD</sub> .                                                           |
| (GPIO D3)                     |          |         |         | Input/Output             | Input, internal pullup enabled                          | GPIO Port D3                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| <b>RESET</b> or <b>RESETB</b> | 2        | 2       | 2       | Input                    | Input, internal pullup enabled (This pin is 3.3V only.) | Reset — A direct hardware reset on the processor. When <b>RESET</b> is asserted low, the device is initialized and placed in the reset state. A Schmitt-trigger input is used for noise immunity. The internal reset signal is deasserted synchronously with the internal clocks after a fixed number of internal clocks. After reset, the default state is <b>RESET</b> . To filter noise on the <b>RESETB</b> pin, install a capacitor (up to 0.1 uF) on it. |
| (GPIO D4)                     |          |         |         | Input/ Open-drain Output | Input, internal pullup enabled                          | GPIO Port D4 — Can be individually programmed as an input or open-drain output pin. <b>RESET</b> functionality is disabled in this mode and the device can be reset only through Power-On Reset (POR), COP reset, or software reset.                                                                                                                                                                                                                           |
| <b>GPIOA0</b>                 | 22       | 17      | 13      | Input/Output             | Input                                                   | GPIO Port A0; after reset, the default state is GPIOA0.                                                                                                                                                                                                                                                                                                                                                                                                        |
| (ANA0&CMPA_IN3)               |          |         |         | Input                    |                                                         | ANA0 is input to channel 0 of ADCA; CMPA_IN3 is input 3 of analog comparator A. When used as an analog input, the signal goes to both places (ANA0 and CMPA_IN3), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin.                                                                                                                                                                                    |
| (CMPC_O)                      |          |         |         | Output                   |                                                         | Analog comparator C output                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| <b>GPIOA1</b>                 | 23       | 18      | 14      | Input/Output             | Input                                                   | GPIO Port A1: After reset, the default state is GPIOA1.                                                                                                                                                                                                                                                                                                                                                                                                        |
| (ANA1&CMPA_IN0)               |          |         |         | Input                    |                                                         | ANA1 is input to channel 1 of ADCA; CMPA_IN0 is input 0 of analog comparator A. When used as an analog input, the signal goes to both places (ANA1 and CMPA_IN0), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin.                                                                                                                                                                                    |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name            | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                                                                                                                                                                                                                       |
|------------------------|----------|---------|---------|--------------|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOA2</b>          | 24       | 19      | 15      | Input/Output | Input                           | GPIO Port A2: After reset, the default state is GPIOA2.                                                                                                                                                                                                                                                                                                                                                  |
| (ANA2&VREFHA&CMPA_IN1) |          |         |         | Input        |                                 | ANA2 is input to channel 2 of ADCA; VREFHA is the reference high of ADCA; CMPA_IN1 is input 1 of analog comparator A. When used as an analog input, the signal goes to both places (ANA2 and CMPA_IN1), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin. This input can be configured as either ANA2 or VREFHA using the ADCA control register. |
| <b>GPIOA3</b>          | 25       | 20      | 16      | Input/Output | Input                           | GPIO Port A3: After reset, the default state is GPIOA3.                                                                                                                                                                                                                                                                                                                                                  |
| (ANA3&VREFLA&CMPA_IN2) |          |         |         | Input        |                                 | ANA3 is input to channel 3 of ADCA; VREFLA is the reference low of ADCA; CMPA_IN2 is input 2 of analog comparator A. When used as an analog input, the signal goes to both places (ANA3 and CMPA_IN2), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin. This input can be configured as either ANA3 or VREFLA using the ADCA control register.  |
| <b>GPIOA4</b>          | 21       | 16      | 12      | Input/Output | Input                           | GPIO Port A4: After reset, the default state is GPIOA4.                                                                                                                                                                                                                                                                                                                                                  |
| (ANA4&ANC8&CMPD_IN0)   |          |         |         | Input        |                                 | ANA4 is input to channel 4 of ADCA; ANC8 is input to channel 8 of ADCC; CMPD_IN0 is input 0 of analog comparator D. When used as an analog input, the signal goes to all three places (ANA4 and ANC8 and CMPA_IN0), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin.                                                                            |
| <b>GPIOA5</b>          | 20       | 15      | 11      | Input/Output | Input                           | GPIO Port A5: After reset, the default state is GPIOA5.                                                                                                                                                                                                                                                                                                                                                  |
| (ANA5&ANC9)            |          |         |         | Input        |                                 | ANA5 is input to channel 5 of ADCA; ANC9 is input to channel 9 of ADCC. When used as an analog input, the signal goes to both places (ANA5 and ANC9), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin.                                                                                                                                          |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name      | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                                                                                             |
|------------------|----------|---------|---------|--------------|---------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOA6</b>    | 19       | 14      | 10      | Input/Output | Input                           | GPIO Port A6: After reset, the default state is GPIOA6.                                                                                                                                                                                                                        |
| (ANA6&ANC10)     |          |         |         | Input        |                                 | ANA6 is input to channel 6 of ADCA; ANC10 is input to channel 10 of ADCC. When used as an analog input, the signal goes to both places (ANA6 and ANC10), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin.             |
| <b>GPIOA7</b>    | 17       | 13      | 9       | Input/Output | Input                           | GPIO Port A7: After reset, the default state is GPIOA7.                                                                                                                                                                                                                        |
| (ANA7&ANC11)     |          |         |         | Input        |                                 | ANA7 is input to channel 7 of ADCA; ANC11 is input to channel 11 of ADCC. When used as an analog input, the signal goes to both places (ANA7 and ANC11), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin.             |
| <b>GPIOA8</b>    | 18       | -       | -       | Input/Output | Input                           | GPIO Port A8: After reset, the default state is GPIOA8.                                                                                                                                                                                                                        |
| (ANC16&CMPD_IN1) |          |         |         | Input        |                                 | ANC16 is input to channel 16 of ADCC; CMPD_IN1 is input 1 of analog comparator D. When used as an analog input, the signal goes to both places (ANC16 and CMPD_IN1), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin. |
| <b>GPIOA9</b>    | 14       | -       | -       | Input/Output | Input                           | GPIO Port A9: After reset, the default state is GPIOA9.                                                                                                                                                                                                                        |
| (ANC17&CMPD_IN2) |          |         |         | Input        |                                 | ANC17 is input to channel 17 of ADCC; CMPD_IN2 is input 2 of analog comparator D. When used as an analog input, the signal goes to both places (ANC17 and CMPD_IN2), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin. |
| <b>GPIOA10</b>   | 13       | -       | -       | Input/Output | Input                           | GPIO Port A10: After reset, the default state is GPIOA10.                                                                                                                                                                                                                      |
| (ANC18&CMPD_IN3) |          |         |         | Input        |                                 | ANC18 is input to channel 18 of ADCC; CMPD_IN3 is input 3 of analog comparator D. When used as an analog input, the signal goes to both places (ANC18 and CMPD_IN3), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin. |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name            | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                                                                                                                                                                                                                       |
|------------------------|----------|---------|---------|--------------|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOA11</b>         | 37       | 32      | -       | Input/Output | Input                           | GPIO Port A11: After reset, the default state is GPIOA11.                                                                                                                                                                                                                                                                                                                                                |
| (ANC19&VREFHC)         |          |         |         | Input        |                                 | ANC19 is input to channel 19 of ADCC. VREFHC is the analog reference high of ADCC.                                                                                                                                                                                                                                                                                                                       |
| <b>GPIOB0</b>          | 33       | 28      | 24      | Input/Output | Input                           | GPIO Port B0: After reset, the default state is GPIOB0.                                                                                                                                                                                                                                                                                                                                                  |
| (ANB0&CMPB_IN3)        |          |         |         | Input        |                                 | ANB0 is input to channel 0 of ADCB; CMPB_IN3 is input 3 of analog comparator B. When used as an analog input, the signal goes to both places (ANB0 and CMPB_IN3), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin.                                                                                                                              |
| <b>GPIOB1</b>          | 34       | 29      | 25      | Input/Output | Input                           | GPIO Port B1: After reset, the default state is GPIOB1.                                                                                                                                                                                                                                                                                                                                                  |
| (ANB1&CMPB_IN0)        |          |         |         | Input        |                                 | ANB1 is input to channel 1 of ADCB; CMPB_IN0 is input 0 of analog comparator B. When used as an analog input, the signal goes to both places (ANB1 and CMPB_IN0), but the glitch on this pin during ADC sampling may interfere with other analog inputs shared on this pin.                                                                                                                              |
| <b>GPIOB2</b>          | 36       | 31      | 27      | Input/Output | Input                           | GPIO Port B2: After reset, the default state is GPIOB2.                                                                                                                                                                                                                                                                                                                                                  |
| (ANB2&VREFHB&CMPC_IN3) |          |         |         | Input        |                                 | ANB2 is input to channel 2 of ADCB; VREFHB is the reference high of ADCB; CMPC_IN3 is input 3 of analog comparator C. When used as an analog input, the signal goes to both places (ANB2 and CMPC_IN3), but the glitch during ADC sampling on this pin may interfere with other analog inputs shared on this pin. This input can be configured as either ANB2 or VREFHB using the ADCB control register. |
| <b>GPIOB3</b>          | 42       | 34      | 28      | Input/Output | Input                           | GPIO Port B3: After reset, the default state is GPIOB3.                                                                                                                                                                                                                                                                                                                                                  |
| (ANB3&VREFLB&CMPC_IN0) |          |         |         | Input        |                                 | ANB3 is input to channel 3 of ADCB; VREFLB is the reference low of ADCB; CMPC_IN0 is input 0 of analog comparator C. When used as an analog input, the signal goes to both places (ANB3 and CMPC_IN0), but the glitch during ADC sampling on this pin may interfere with other analog inputs shared on this pin. This input can be configured as either ANB3 or VREFLB using the ADCB control register.  |

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**Table 2. Signal descriptions (continued)**

| Signal Name           | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                                                                                                                                               |
|-----------------------|----------|---------|---------|--------------|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOB4</b>         | 30       | 25      | 21      | Input/Output | Input                           | GPIO Port B4: After reset, the default state is GPIOB4.                                                                                                                                                                                                                                                                          |
| (ANB4&ANC12&CMPC_IN1) |          |         |         | Input        |                                 | ANB4 is input to channel 4 of ADCB; ANC12 is input to channel 12 of ADCC; CMPC_IN1 is input 1 of analog comparator C. When used as an analog input, the signal goes to all three places (ANB4 and ANC12 and CMPC_IN1), but the glitch during ADC sampling on this pin may interfere with other analog inputs shared on this pin. |
| <b>GPIOB5</b>         | 29       | 24      | 20      | Input/Output | Input                           | GPIO Port B5: After reset, the default state is GPIOB5.                                                                                                                                                                                                                                                                          |
| (ANB5&ANC13&CMPC_IN2) |          |         |         | Input        |                                 | ANB5 is input to channel 5 of ADCB; ANC13 is input to channel 13 of ADCC; CMPC_IN2 is input 2 of analog comparator C. When used as an analog input, the signal goes to all three places (ANB5 and ANC13 and CMPC_IN2), but the glitch during ADC sampling on this pin may interfere with other analog inputs shared on this pin. |
| <b>GPIOB6</b>         | 28       | 23      | 19      | Input/Output | Input                           | GPIO Port B6: After reset, the default state is GPIOB6.                                                                                                                                                                                                                                                                          |
| (ANB6&ANC14&CMPB_IN1) |          |         |         | Input        |                                 | ANB6 is input to channel 6 of ADCB; ANC14 is input to channel 14 of ADCC; CMPB_IN1 is input 1 of analog comparator B. When used as an analog input, the signal goes to all three places (ANB6 and ANC14 and CMPB_IN1), but the glitch during ADC sampling on this pin may interfere with other analog inputs shared on this pin. |
| <b>GPIOB7</b>         | 26       | 21      | 17      | Input/Output | Input                           | GPIO Port B7: After reset, the default state is GPIOB7.                                                                                                                                                                                                                                                                          |
| (ANB7&ANC15&CMPB_IN2) |          |         |         | Input        |                                 | ANB7 is input to channel 7 of ADCB; ANC15 is input to channel 14 of ADCC; CMPB_IN2 is input 2 of analog comparator B. When used as an analog input, the signal goes to all three places (ANB7 and ANC15 and CMPB_IN2), but the glitch during ADC sampling on this pin may interfere with other analog inputs shared on this pin. |
| <b>GPIOB8</b>         | 38       | 33      | 33      | Input/Output | Input                           | GPIO Port B8: After reset, the default state is GPIOB8.                                                                                                                                                                                                                                                                          |
| (ANC20&VREFLC)        |          |         |         | Input        |                                 | ANC20 is input to channel 20 of ADCC; VREFLC is the reference low of ADCC .                                                                                                                                                                                                                                                      |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name    | 100 LQFP | 80 LQFP | 64 LQFP | Type          | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                                                 |
|----------------|----------|---------|---------|---------------|---------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOB9</b>  | 39       | -       | -       | Input/Output  | Input                           | GPIO Port B9: After reset, the default state is GPIOB9.                                                                                                                                                                            |
| (ANC21)        |          |         |         | Input         |                                 | Input to channel 21 of ADCC                                                                                                                                                                                                        |
| (XB_IN9)       |          |         |         | Input         |                                 | Crossbar module input 9                                                                                                                                                                                                            |
| (MISO2)        |          |         |         | Input/Output  |                                 | Master in/slave out for SPI2 —In master mode, MISO2 pin is the data input. In slave mode, MISO2 pin is the data output. The MISO line of a slave device is placed in the high-impedance state if the slave device is not selected. |
| <b>GPIOB10</b> | 40       | -       | -       | Input/Output  | Input                           | GPIO Port B10: After reset, the default state is GPIOB10.                                                                                                                                                                          |
| (ANC22)        |          |         |         | Input         |                                 | Input to channel 22 of ADCC                                                                                                                                                                                                        |
| (XB_IN8)       |          |         |         | Input         |                                 | Crossbar module input 8                                                                                                                                                                                                            |
| (MOSI2)        |          |         |         | Input/Output  |                                 | Master out/slave in for SPI2— In master mode, MOSI2 pin is the data output. In slave mode, MOSI2 pin is the data input.                                                                                                            |
| <b>GPIOB11</b> | 41       | -       | -       | Input/Output  | Input                           | GPIO Port B11: After reset, the default state is GPIOB11.                                                                                                                                                                          |
| (ANC23)        |          |         |         | Input         |                                 | Input to channel 23 of ADCC                                                                                                                                                                                                        |
| (XB_IN7)       |          |         |         | Input         |                                 | Crossbar module input 7                                                                                                                                                                                                            |
| (SCLK2)        |          |         |         | Input/Output  |                                 | SPI2 serial clock — In master mode, SCLK2 pin is an output, clocking slaved listeners. In slave mode, SCLK2 pin is the data clock input.                                                                                           |
| <b>GPIOC0</b>  | 3        | 3       | 3       | Input/Output  | Input                           | GPIO Port C0: After reset, the default state is GPIOC0.                                                                                                                                                                            |
| (EXTAL)        |          |         |         | Analog Input  |                                 | The external crystal oscillator input (EXTAL) connects the internal crystal oscillator input to an external crystal or ceramic resonator.                                                                                          |
| (CLKIN0)       |          |         |         | Input         |                                 | External clock input. <sup>2</sup>                                                                                                                                                                                                 |
| <b>GPIOC1</b>  | 4        | 4       | 4       | Input/Output  | Input                           | GPIO Port C1: After reset, the default state is GPIOC1.                                                                                                                                                                            |
| (XTAL)         |          |         |         | Analog Output |                                 | The external crystal oscillator output (XTAL) connects the internal crystal oscillator output to an external crystal or ceramic resonator.                                                                                         |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name   | 100 LQFP | 80 LQFP | 64 LQFP | Type          | State During Reset <sup>1</sup> | Signal Description                                                                                                                               |
|---------------|----------|---------|---------|---------------|---------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOC2</b> | 5        | 5       | 5       | Input/Output  | Input                           | GPIO Port C2: After reset, the default state is GPIOC2.                                                                                          |
| (TXD0)        |          |         |         | Output        |                                 | SCI0 transmit data output or transmit/receive in single-wire operation                                                                           |
| (TB0)         |          |         |         | Input/Output  |                                 | Quad timer module B channel 0 input/output                                                                                                       |
| (XB_IN2)      |          |         |         | Input         |                                 | Crossbar module input 2                                                                                                                          |
| (CLKO0)       |          |         |         | Output        |                                 | Buffered clock output 0: the clock source is selected by clockout select (CLKOSEL) bits in the clock output select register (CLKOUT) of the SIM. |
| <b>GPIOC3</b> | 11       | 9       | 7       | Input/Output  | Input                           | GPIO Port C3: After reset, the default state is GPIOC3.                                                                                          |
| (TA0)         |          |         |         | Input/Output  |                                 | Quad timer module A channel 0 input/output                                                                                                       |
| (CMPA_O)      |          |         |         | Output        |                                 | Analog comparator A output                                                                                                                       |
| (RXD0)        |          |         |         | Input         |                                 | SCI0 receive data input                                                                                                                          |
| (CLKIN1)      |          |         |         | Input         |                                 | External clock input 1                                                                                                                           |
| <b>GPIOC4</b> | 12       | 10      | 8       | Input/Output  | Input                           | GPIO Port C4: After reset, the default state is GPIOC4.                                                                                          |
| (TA1)         |          |         |         | Input/Output  |                                 | Quad timer module A channel 1 input/output                                                                                                       |
| (CMPB_O)      |          |         |         | Output        |                                 | Analog comparator B output                                                                                                                       |
| (XB_IN8)      |          |         |         | Input         |                                 | Crossbar module input 8                                                                                                                          |
| (EWM_OUT_B)   |          |         |         | Output        |                                 | External Watchdog Module output                                                                                                                  |
| <b>GPIOC5</b> | 27       | 22      | 18      | Input/Output  | Input                           | GPIO Port C5: After reset, the default state is GPIOC5.                                                                                          |
| (DACO)        |          |         |         | Analog Output |                                 | 12-bit digital-to-analog output                                                                                                                  |
| (XB_IN7)      |          |         |         | Input         |                                 | Crossbar module input 7                                                                                                                          |
| <b>GPIOC6</b> | 49       | 39      | 31      | Input/Output  | Input                           | GPIO Port C6: After reset, the default state is GPIOC6                                                                                           |
| (TA2)         |          |         |         | Input/Output  |                                 | Quad timer module A channel 2 input/output                                                                                                       |
| (XB_IN3)      |          |         |         | Input         |                                 | Crossbar module input 3                                                                                                                          |
| (CMP_REF)     |          |         |         | Analog Input  |                                 | Input 5 of analog comparator A and B and C and D.                                                                                                |

Table continues on the next page...

Table 2. Signal descriptions (continued)

| Signal Name    | 100 LQFP | 80 LQFP | 64 LQFP | Type                    | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                                          |
|----------------|----------|---------|---------|-------------------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOC7</b>  | 50       | 40      | 32      | Input/Output            | Input                           | GPIO Port C7: After reset, the default state is GPIOC7.                                                                                                                                                                     |
| (SS0_B)        |          |         |         | Input/Output            |                                 | In slave mode, SS0_B indicates to the SPI module that the current transfer is to be received.                                                                                                                               |
| (TXD0)         |          |         |         | Output                  |                                 | SCI0 transmit data output or transmit/receive in single-wire operation                                                                                                                                                      |
| <b>GPIOC8</b>  | 52       | 41      | 33      | Input/Output            | Input                           | GPIO Port C8: After reset, the default state is GPIOC8.                                                                                                                                                                     |
| (MISO0)        |          |         |         | Input/Output            |                                 | Master in/slave out — In master mode, MISO0 pin is the data input. In slave mode, MISO0 pin is the data output. The MISO0 line of a slave device is placed in the high-impedance state if the slave device is not selected. |
| (RXD0)         |          |         |         | Input                   |                                 | SCI0 receive data input.                                                                                                                                                                                                    |
| (XB_IN9)       |          |         |         | Input                   |                                 | Crossbar module input 9                                                                                                                                                                                                     |
| <b>GPIOC9</b>  | 53       | 42      | 34      | Input/Output            | Input                           | GPIO Port C9: After reset, the default state is GPIOC9.                                                                                                                                                                     |
| (SCLK0)        |          |         |         | Input/Output            |                                 | SPI0 serial clock — In master mode, SCLK0 pin is an output, clocking slaved listeners. In slave mode, SCLK0 pin is the data clock input.                                                                                    |
| (XB_IN4)       |          |         |         | Input                   |                                 | Crossbar module input 4                                                                                                                                                                                                     |
| <b>GPIOC10</b> | 54       | 43      | 35      | Input/Output            | Input                           | GPIO Port C10: After reset, the default state is GPIOC10.                                                                                                                                                                   |
| (MOSI0)        |          |         |         | Input/Output            |                                 | Master out/slave in — In master mode, MOSI0 pin is the data output. In slave mode, MOSI0 pin is the data input.                                                                                                             |
| (XB_IN5)       |          |         |         | Input                   |                                 | Crossbar module input 5                                                                                                                                                                                                     |
| (MISO0)        |          |         |         | Input/Output            |                                 | Master in/slave out — In master mode, MISO0 pin is the data input. In slave mode, MISO0 pin is the data output. The MISO0 line of a slave device is placed in the high-impedance state if the slave device is not selected. |
| <b>GPIOC11</b> | 58       | 47      | 37      | Input/Output            | Input                           | GPIO Port C11: After reset, the default state is GPIOC11.                                                                                                                                                                   |
| (CANTX)        |          |         |         | Open-drain Output       |                                 | CAN transmit data output                                                                                                                                                                                                    |
| (SCL1)         |          |         |         | Input/Open-drain Output |                                 | I <sup>2</sup> C1 serial clock                                                                                                                                                                                              |
| (TXD1)         |          |         |         | Output                  |                                 | SCI1 transmit data output or transmit/receive in single wire operation                                                                                                                                                      |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name    | 100 LQFP | 80 LQFP | 64 LQFP | Type                     | State During Reset <sup>1</sup> | Signal Description                                                     |
|----------------|----------|---------|---------|--------------------------|---------------------------------|------------------------------------------------------------------------|
| <b>GPIOC12</b> | 59       | 48      | 38      | Input/Output             | Input                           | GPIO Port C12: After reset, the default state is GPIOC12.              |
| (CANRX)        |          |         |         | Input                    |                                 | CAN receive data input                                                 |
| (SDA1)         |          |         |         | Input/ Open-drain Output |                                 | I <sup>2</sup> C1 serial data line                                     |
| (RXD1)         |          |         |         | Input                    |                                 | SCI1 receive data input                                                |
| <b>GPIOC13</b> | 76       | 61      | 49      | Input/Output             | Input                           | GPIO Port C13: After reset, the default state is GPIOC13.              |
| (TA3)          |          |         |         | Input/Output             |                                 | Quad timer module A channel 3 input/output                             |
| (XB_IN6)       |          |         |         | Input                    |                                 | Crossbar module input 6                                                |
| (EWM_OUT_B)    |          |         |         | Output                   |                                 | External Watchdog Module output                                        |
| <b>GPIOC14</b> | 87       | 70      | 55      | Input/Output             | Input                           | GPIO Port C14: After reset, the default state is GPIOC14.              |
| (SDA0)         |          |         |         | Input/ Open-drain Output |                                 | I <sup>2</sup> C0 serial data line                                     |
| (XB_OUT4)      |          |         |         | Output                   |                                 | Crossbar module output 4                                               |
| <b>GPIOC15</b> | 88       | 71      | 56      | Input/Output             | Input                           | GPIO Port C15: After reset, the default state is GPIOC15.              |
| (SCL0)         |          |         |         | Input/ Open-drain Output |                                 | I <sup>2</sup> C0 serial clock                                         |
| (XB_OUT5)      |          |         |         | Input                    |                                 | Crossbar module output 5                                               |
| <b>GPIOD5</b>  | 10       | 8       | -       | Input/Output             | Input                           | GPIO Port D5: After reset, the default state is GPIOD5.                |
| (RXD2)         |          |         |         | Input                    |                                 | SCI2 receive data input                                                |
| (XB_IN5)       |          |         |         | Input                    |                                 | Crossbar module input 5                                                |
| (XB_OUT9)      |          |         |         | Output                   |                                 | Crossbar module output 9                                               |
| <b>GPIOD6</b>  | 9        | 7       | -       | Input/Output             | Input                           | GPIO Port D6: After reset, the default state is GPIOD6.                |
| (TXD2)         |          |         |         | Output                   |                                 | SCI2 transmit data output or transmit/receive in single-wire operation |
| (XB_IN4)       |          |         |         | Input                    |                                 | Crossbar module input 4                                                |
| (XB_OUT8)      |          |         |         | Output                   |                                 | Crossbar module output 8                                               |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name   | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                                                 |
|---------------|----------|---------|---------|--------------|---------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOD7</b> | 47       | 37      | -       | Input/Output | Input                           | GPIO Port D7: After reset, the default state is GPIOD7.                                                                                                                                                                            |
| (XB_OUT11)    |          |         |         | Output       |                                 | Crossbar module output 11                                                                                                                                                                                                          |
| (XB_IN7)      |          |         |         | Input        |                                 | Crossbar module input 7                                                                                                                                                                                                            |
| (MISO1)       |          |         |         | Input/Output |                                 | Master in/slave out for SPI1 —In master mode, MISO1 pin is the data input. In slave mode, MISO1 pin is the data output. The MISO line of a slave device is placed in the high-impedance state if the slave device is not selected. |
| <b>GPIOE0</b> | 68       | 55      | 45      | Input/Output | Input                           | GPIO Port E0: After reset, the default state is GPIOE0.                                                                                                                                                                            |
| PWMA_0B       |          |         |         | Input/Output |                                 | PWM module A (NanoEdge), submodule 0, output B or input capture B                                                                                                                                                                  |
| <b>GPIOE1</b> | 69       | 56      | 46      | Input/Output | Input                           | GPIO Port E1: After reset, the default state is GPIOE1.                                                                                                                                                                            |
| (PWMA_0A)     |          |         |         | Input/Output |                                 | PWM module A (NanoEdge), submodule 0, output A or input capture A                                                                                                                                                                  |
| <b>GPIOE2</b> | 74       | 59      | 47      | Input/Output | Input                           | GPIO Port E2: After reset, the default state is GPIOE2.                                                                                                                                                                            |
| (PWMA_1B)     |          |         |         | Input/Output |                                 | PWM module A (NanoEdge), submodule 1, output B or input capture B                                                                                                                                                                  |
| <b>GPIOE3</b> | 75       | 60      | 48      | Input/Output | Input                           | GPIO Port E3: After reset, the default state is GPIOE3.                                                                                                                                                                            |
| (PWMA_1A)     |          |         |         | Input/Output |                                 | PWM module A (NanoEdge), submodule 1, output A or input capture A                                                                                                                                                                  |
| <b>GPIOE4</b> | 82       | 65      | 51      | Input/Output | Input                           | GPIO Port E4: After reset, the default state is GPIOE4.                                                                                                                                                                            |
| (PWMA_2B)     |          |         |         | Input/Output |                                 | PWM module A (NanoEdge), submodule 2, output B or input capture B                                                                                                                                                                  |
| (XB_IN2)      |          |         |         | Input        |                                 | Crossbar module input 2                                                                                                                                                                                                            |
| <b>GPIOE5</b> | 83       | 66      | 52      | Input/Output | Input                           | GPIO Port E5: After reset, the default state is GPIOE5.                                                                                                                                                                            |
| (PWMA_2A)     |          |         |         | Input/Output |                                 | PWM module A (NanoEdge), submodule 2, output A or input capture A                                                                                                                                                                  |
| (XB_IN3)      |          |         |         | Input        |                                 | Crossbar module input 3                                                                                                                                                                                                            |
| <b>GPIOE6</b> | 84       | 67      | 53      | Input/Output | Input                           | GPIO Port E6: After reset, the default state is GPIOE6.                                                                                                                                                                            |
| (PWMA_3B)     |          |         |         | Input/Output |                                 | PWM module A (NanoEdge), submodule 3, output B or input capture B                                                                                                                                                                  |
| (XB_IN4)      |          |         |         | Input        |                                 | Crossbar module input 4                                                                                                                                                                                                            |
| (PWMB_2B)     |          |         |         | Input/Output |                                 | Note: PWMB_2B is not available on 64LQFP devices.                                                                                                                                                                                  |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name   | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                  |
|---------------|----------|---------|---------|--------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOE7</b> | 85       | 68      | 54      | Input/Output | Input                           | GPIO Port E7: After reset, the default state is GPIOE7.                                                                                                                                             |
| (PWMA_3A)     |          |         |         | Input/Output |                                 | PWM module A (NanoEdge), submodule 3, output A or input capture A                                                                                                                                   |
| (XB_IN5)      |          |         |         | Input        |                                 | Crossbar module input 5                                                                                                                                                                             |
| (PWMB_2A)     |          |         |         | Input/Output |                                 | PWM module B, submodule 2, output A or input capture A. Note: PWMB_2A is not available on 64LQFP devices.                                                                                           |
| <b>GPIOE8</b> | 72       | -       | -       | Input/Output | Input                           | GPIO Port E8: After reset, the default state is GPIOE8.                                                                                                                                             |
| (PWMB_2B)     |          |         |         | Input/Output |                                 | PWM module B, submodule 2, output B or input capture B                                                                                                                                              |
| (PWMA_FAULT0) |          |         |         | Input        |                                 | PWM module A fault input 0 is used for disabling selected PWM module A outputs in cases where fault conditions originate off-chip                                                                   |
| <b>GPIOE9</b> | 73       | -       | -       | Input/Output | Input                           | GPIO Port E9: After reset, the default state is GPIOE9.                                                                                                                                             |
| (PWMB_2A)     |          |         |         | Input/Output |                                 | PWM module B, submodule 2, output A or input capture A                                                                                                                                              |
| (PWMA_FAULT1) |          |         |         | Input        |                                 | PWM module A fault input 1 is used for disabling selected PWM module A outputs in cases where fault conditions originate off-chip                                                                   |
| <b>GPIOF0</b> | 55       | 44      | 36      | Input/Output | Input                           | GPIO Port F0: After reset, the default state is GPIOF0.                                                                                                                                             |
| (XB_IN6)      |          |         |         | Input        |                                 | Crossbar module input 6                                                                                                                                                                             |
| (TB2)         |          |         |         | Input/Output |                                 | Quad timer module B channel 2 input/output                                                                                                                                                          |
| (SCLK1)       |          |         |         | Input/Output |                                 | SPI1 serial clock — In master mode, SCLK1 pin is an output, clocking slaved listeners. In slave mode, SCLK1 pin is the data clock input. Note: SCLK1 is not available on 64LQFP and 48LQFP devices. |
| <b>GPIOF1</b> | 77       | 62      | 50      | Input/Output | Input                           | GPIO Port F1: After reset, the default state is GPIOF1.                                                                                                                                             |
| (CLKO1)       |          |         |         | Output       |                                 | Buffered clock output 1: the clock source is selected by clockout select (CLKOSEL) bits in the clock output select register (CLKOUT) of the SIM.                                                    |
| (XB_IN7)      |          |         |         | Input        |                                 | Crossbar module input 6                                                                                                                                                                             |
| (CMPD_O)      |          |         |         | Output       |                                 | Analog comparator D output                                                                                                                                                                          |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name   | 100 LQFP | 80 LQFP | 64 LQFP | Type                     | State During Reset <sup>1</sup> | Signal Description                                                                                                                             |
|---------------|----------|---------|---------|--------------------------|---------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOF2</b> | 60       | 49      | 39      | Input/Output             | Input                           | GPIO Port F2: After reset, the default state is GPIOF2.                                                                                        |
| (SCL1)        |          |         |         | Input/ Open-drain Output |                                 | I <sup>2</sup> C1 serial clock                                                                                                                 |
| (XB_OUT6)     |          |         |         | Output                   |                                 | Crossbar module output 6                                                                                                                       |
| <b>GPIOF3</b> | 61       | 50      | 40      | Input/Output             | Input                           | GPIO Port F3: After reset, the default state is GPIOF3.                                                                                        |
| (SDA1)        |          |         |         | Input/ Open-drain Output |                                 | I <sup>2</sup> C1 serial data line                                                                                                             |
| (XB_OUT7)     |          |         |         | Output                   |                                 | Crossbar module output 7                                                                                                                       |
| <b>GPIOF4</b> | 62       | 51      | 41      | Input/Output             | Input                           | GPIO Port F4: After reset, the default state is GPIOF4.                                                                                        |
| (TXD1)        |          |         |         | Output                   |                                 | SCI1 transmit data output or transmit/ receive in single wire operation                                                                        |
| (XB_OUT8)     |          |         |         | Output                   |                                 | Crossbar module output 8                                                                                                                       |
| <b>GPIOF5</b> | 63       | 52      | 42      | Input/Output             | Input                           | GPIO Port F5: After reset, the default state is GPIOF5.                                                                                        |
| (RXD1)        |          |         |         | Input                    |                                 | SCI1 receive data input                                                                                                                        |
| (XB_OUT9)     |          |         |         | Output                   |                                 | Crossbar module output 9                                                                                                                       |
| <b>GPIOF6</b> | 94       | 74      | 58      | Input/Output             | Input                           | GPIO Port F6: After reset, the default state is GPIOF6.                                                                                        |
| (TB2)         |          |         |         | Input/Output             |                                 | Quad timer module B Channel 2 input/ output                                                                                                    |
| (PWMA_3X)     |          |         |         | Input/Output             |                                 | PWM module A, submodule 3, output X or input capture X                                                                                         |
| (PWMB_3X)     |          |         |         | Input/Output             |                                 | PWM module B, submodule 3, output X or input capture X. Note: PWMB_3X is not available on 64LQFP devices.                                      |
| (XB_IN2)      |          |         |         | Input                    |                                 | Crossbar module input 2                                                                                                                        |
| <b>GPIOF7</b> | 95       | 75      | 59      | Input/Output             | Input                           | GPIO Port F7: After reset, the default state is GPIOF7.                                                                                        |
| (TB3)         |          |         |         | Input/Output             |                                 | Quad timer module B Channel 3 input/ output                                                                                                    |
| (CMPC_O)      |          |         |         | Output                   |                                 | Analog comparator C output                                                                                                                     |
| (SS1_B)       |          |         |         | Input/Output             |                                 | In slave mode, SS1_B indicates to the SPI1 module that the current transfer is to be received. Note: SS1_B is not available on 64LQFP devices. |
| (XB_IN3)      |          |         |         | Input                    |                                 | Crossbar module input 3                                                                                                                        |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name    | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                |
|----------------|----------|---------|---------|--------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOF8</b>  | 6        | 6       | 6       | Input/Output | Input                           | GPIO Port F8: After reset, the default state is GPIOF8.                                                                           |
| (RXD0)         |          |         |         | Input        |                                 | SCI0 receive data input                                                                                                           |
| (TB1)          |          |         |         | Input/Output |                                 | Quad timer module B channel 1 input/output                                                                                        |
| (CMPD_O)       |          |         |         | Output       |                                 | Analog comparator D output                                                                                                        |
| <b>GPIOF9</b>  | 57       | 46      | -       | Input/Output | Input                           | GPIO Port F9: After reset, the default state is GPIOF9.                                                                           |
| (RXD2)         |          |         |         | Input        |                                 | SCI2 receive data input                                                                                                           |
| (PWMA_FAULT7)  |          |         |         | Input        |                                 | PWM module A fault input 7 is used for disabling selected PWM module A outputs in cases where fault conditions originate off-chip |
| (PWMB_FAULT7)  |          |         |         | Input        |                                 | PWM module B fault input 7 is used for disabling selected PWM module B outputs in cases where fault conditions originate off-chip |
| (XB_OUT11)     |          |         |         | Output       |                                 | Crossbar module output 11                                                                                                         |
| <b>GPIOF10</b> | 56       | 45      | -       | Input/Output | Input                           | GPIO Port F10: After reset, the default state is GPIOF10.                                                                         |
| (TXD2)         |          |         |         | Input/Output |                                 | SCI2 transmit data output or transmit/receive in single-wire operation                                                            |
| (PWMA_FAULT6)  |          |         |         | Input        |                                 | PWM module A fault input 6 is used for disabling selected PWM module A outputs in cases where fault conditions originate off-chip |
| (PWMB_FAULT6)  |          |         |         | Input        |                                 | PWM module B fault input 6 is used for disabling selected PWM module B outputs in cases where fault conditions originate off-chip |
| (XB_OUT10)     |          |         |         | Output       |                                 | Crossbar module output 10                                                                                                         |
| <b>GPIOF11</b> | 45       | -       | -       | Input/Output | Input                           | GPIO Port F11: After reset, the default state is GPIOF11.                                                                         |
| (TXD0)         |          |         |         | Output       |                                 | SCI0 transmit data output or transmit/receive in single-wire operation                                                            |
| (XB_IN11)      |          |         |         | Input        |                                 | Crossbar module input 11                                                                                                          |

Table continues on the next page...

Table 2. Signal descriptions (continued)

| Signal Name    | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                                                                                                                 |
|----------------|----------|---------|---------|--------------|---------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOF12</b> | 89       | -       | -       | Input/Output | Input                           | GPIO Port F12: After reset, the default state is GPIOF12.                                                                                                                                                                          |
| (MISO1)        |          |         |         | Input/Output |                                 | Master in/slave out for SPI1 —In master mode, MISO1 pin is the data input. In slave mode, MISO1 pin is the data output. The MISO line of a slave device is placed in the high-impedance state if the slave device is not selected. |
| (PWMB_FAULT2)  |          |         |         | Input        |                                 | PWM module B fault input 2 is used for disabling selected PWM module B outputs in cases where fault conditions originate off-chip                                                                                                  |
| <b>GPIOF13</b> | 90       | -       | -       | Input/Output | Input                           | GPIO Port F13: After reset, the default state is GPIOF13.                                                                                                                                                                          |
| (MOSI1)        |          |         |         |              |                                 |                                                                                                                                                                                                                                    |
| (PWMB_FAULT1)  |          |         |         | Input        |                                 | PWM module B fault input 1 is used for disabling selected PWM module B outputs in cases where fault conditions originate off-chip                                                                                                  |
| <b>GPIOF14</b> | 91       | -       | -       | Input/Output | Input                           | GPIO Port F14: After reset, the default state is GPIOF14.                                                                                                                                                                          |
| (SCLK1)        |          |         |         | Input/Output |                                 | SPI1 serial clock — In master mode, SCLK1 pin is an output, clocking slaved listeners. In slave mode, SCLK1 pin is the data clock input. Note: SCLK1 is not available on 48LQFP and 64LQFP devices.                                |
| (PWMB_FAULT0)  |          |         |         | Input        |                                 | PWM module B fault input 0 is used for disabling selected PWM module B outputs in cases where fault conditions originate off-chip                                                                                                  |
| <b>GPIOF15</b> | 46       | -       | -       | Input/Output | Input                           | GPIO Port F15: After reset, the default state is GPIOF15.                                                                                                                                                                          |
| (RXD0)         |          |         |         | Input        |                                 | SCI0 receive data input                                                                                                                                                                                                            |
| (XB_IN10)      |          |         |         | Input        |                                 | Crossbar module input 10                                                                                                                                                                                                           |
| <b>GPIOG0</b>  | 78       | 63      | -       | Input/Output | Input                           | GPIO Port G0: After reset, the default state is GPIOG0.                                                                                                                                                                            |
| (PWMB_1B)      |          |         |         | Input/Output |                                 | PWM module B, submodule 1, output B or input capture B                                                                                                                                                                             |
| (XB_OUT6)      |          |         |         | Output       |                                 | Crossbar module output 6                                                                                                                                                                                                           |
| <b>GPIOG1</b>  | 79       | 64      | -       | Input/Output | Input                           | GPIO Port G1: After reset, the default state is GPIOG1.                                                                                                                                                                            |
| (PWMB_1A)      |          |         |         | Input/Output |                                 | PWM module B, submodule 1, output A or input capture A                                                                                                                                                                             |
| (XB_OUT7)      |          |         |         | Output       |                                 | Crossbar module output 7                                                                                                                                                                                                           |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name   | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                |
|---------------|----------|---------|---------|--------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOG2</b> | 70       | 57      | -       | Input/Output | Input                           | GPIO Port G2: After reset, the default state is GPIOG2.                                                                           |
| (PWMB_0B)     |          |         |         | Input/Output |                                 | PWM module B, submodule 0, output B or input capture B                                                                            |
| (XB_OUT4)     |          |         |         | Output       |                                 | Crossbar module output 4                                                                                                          |
| <b>GPIOG3</b> | 71       | 58      | -       | Input/Output | Input                           | GPIO Port G3: After reset, the default state is GPIOG3.                                                                           |
| (PWMB_0A)     |          |         |         | Input/Output |                                 | PWM module B, submodule 0, output A or input capture A                                                                            |
| (XB_OUT5)     |          |         |         | Output       |                                 | Crossbar module output 5                                                                                                          |
| <b>GPIOG4</b> | 80       | -       | -       | Input/Output | Input                           | GPIO Port G4: After reset, the default state is GPIOG4.                                                                           |
| (PWMB_3B)     |          |         |         | Input/Output |                                 | PWM module B, submodule 3, output B or input capture B                                                                            |
| (PWMA_FAULT2) |          |         |         | Input        |                                 | PWM module A fault input 2 is used for disabling selected PWM module A outputs in cases where fault conditions originate off-chip |
| <b>GPIOG5</b> | 81       | -       | -       | Input/Output | Input                           | GPIO Port G5: After reset, the default state is GPIOG5.                                                                           |
| (PWMB_3A)     |          |         |         | Input/Output |                                 | PWM module B, submodule 3, output A or input capture A                                                                            |
| (PWMA_FAULT3) |          |         |         | Input        |                                 | PWM module A fault input 3 is used for disabling selected PWM module A outputs in cases where fault conditions originate off-chip |
| <b>GPIOG6</b> | 86       | 69      | -       | Input/Output | Input                           | GPIO Port G6: After reset, the default state is GPIOG6.                                                                           |
| (PWMA_FAULT4) |          |         |         | Input        |                                 | PWM module A fault input 4 is used for disabling selected PWM module A outputs in cases where fault conditions originate off-chip |
| (PWMB_FAULT4) |          |         |         | Input        |                                 | PWM module B fault input 4 is used for disabling selected PWM module B outputs in cases where fault conditions originate off-chip |
| (TB2)         |          |         |         | Input/Output |                                 | Quad timer module B channel 2 input/output                                                                                        |
| (XB_OUT8)     |          |         |         | Output       |                                 | Crossbar module output 8                                                                                                          |
|               |          |         |         |              |                                 |                                                                                                                                   |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name    | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                |
|----------------|----------|---------|---------|--------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOG7</b>  | 92       | 72      | -       | Input/Output | Input                           | GPIO Port G7: After reset, the default state is GPIOG7.                                                                           |
| (PWMA_FAULT5)  |          |         |         | Input        |                                 | PWM module A fault input 5 is used for disabling selected PWM module A outputs in cases where fault conditions originate off-chip |
| (PWMB_FAULT5)  |          |         |         | Input        |                                 | PWM module B fault input 5 is used for disabling selected PWM module B outputs in cases where fault conditions originate off-chip |
| (XB_OUT9)      |          |         |         | Output       |                                 | Crossbar module output 9                                                                                                          |
| <b>GPIOG8</b>  | 64       | -       | -       | Input/Output | Input                           | GPIO Port G8: After reset, the default state is GPIOG8.                                                                           |
| (PWMB_0X)      |          |         |         | Input/Output |                                 | PWM module B, submodule 0, output X or input capture X                                                                            |
| (PWMA_0X)      |          |         |         | Input/Output |                                 | PWM module A, submodule 0, output X or input capture X                                                                            |
| (TA2)          |          |         |         | Input/Output |                                 | Quad timer module A channel 2 input/output                                                                                        |
| (XB_OUT10)     |          |         |         | Output       |                                 | Crossbar module output 10                                                                                                         |
| <b>GPIOG9</b>  | 65       | -       | -       | Input/Output | Input                           | GPIO Port G9: After reset, the default state is GPIOG9.                                                                           |
| (PWMB_1X)      |          |         |         | Input/Output |                                 | PWM module B, submodule 1, output X or input capture X                                                                            |
| (PWMA_1X)      |          |         |         | Input/Output |                                 | PWM module A, submodule 1, output X or input capture X                                                                            |
| (TA3)          |          |         |         | Input/Output |                                 | Quad timer module A channel 3 input/output                                                                                        |
| (XB_OUT11)     |          |         |         | Output       |                                 | Crossbar module output 11                                                                                                         |
| <b>GPIOG10</b> | 51       | -       | -       | Input/Output | Input                           | GPIO Port G10: After reset, the default state is GPIOG10.                                                                         |
| (PWMB_2X)      |          |         |         | Input/Output |                                 | PWM module B, submodule 2, output X or input capture X                                                                            |
| (PWMA_2X)      |          |         |         | Input/Output |                                 | PWM module A, submodule 2, output X or input capture X                                                                            |
| (XB_IN8)       |          |         |         | Input        |                                 | Crossbar module input 8                                                                                                           |
| (SS2_B)        |          |         |         | Input/Output |                                 | In slave mode, SS2_B indicates to the SPI2 module that the current transfer is to be received.                                    |

Table continues on the next page...

**Table 2. Signal descriptions (continued)**

| Signal Name    | 100 LQFP | 80 LQFP | 64 LQFP | Type         | State During Reset <sup>1</sup> | Signal Description                                                                                                                               |
|----------------|----------|---------|---------|--------------|---------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>GPIOG11</b> | 48       | 38      | -       | Input/Output | Input                           | GPIO Port G11: After reset, the default state is GPIOG11.                                                                                        |
| (TB3)          |          |         |         | Input/Output |                                 | Quad timer module B channel 3 input/output                                                                                                       |
| (CLKO0)        |          |         |         | Output       |                                 | Buffered clock output 0: the clock source is selected by clockout select (CLKOSEL) bits in the clock output select register (CLKOUT) of the SIM. |
| (MOSI1)        |          |         |         | Input/Output |                                 | Master out/slave in for SPI1— In master mode, MOSI1 pin is the data output. In slave mode, MOSI1 pin is the data input.                          |

- For all GPIO except GPIOD0 - GPIOD4, input only after reset (internal pullup and pull-down are disabled).
- If CLKIN is selected as the device's external clock input, then both the GPS\_C0 bit (in GPS1) and the EXT\_SEL bit (in the OCCS oscillator control register (OSCTL)) must be set. Also, the crystal oscillator should be powered down.

### 3 Signal groups

The input and output signals of the MC56F84xxx are organized into functional groups, as listed in [Table 3](#). Note that some package sizes may not be available for your specific product. See [MC56F844xx/5xx/7xx product family](#).

**Table 3. Functional Group Pin Allocations**

| Functional Group                                                   | Number of Pins |         |         |          |
|--------------------------------------------------------------------|----------------|---------|---------|----------|
|                                                                    | 48 LQFP        | 64 LQFP | 80 LQFP | 100 LQFP |
| Power Inputs ( $V_{DD}$ , $V_{DDA}$ ), Power Outputs ( $V_{CAP}$ ) | 5              | 6       | 7       | 8        |
| Ground ( $V_{SS}$ , $V_{SSA}$ )                                    | 4              | 4       | 5       | 6        |
| Reset                                                              | 1              | 1       | 1       | 1        |
| eFlexPWM with NanoEdge ports, not including fault pins             | 6              | 8       | 8       | 8        |
| eFlexPWM without NanoEdge ports, not including fault pins          | 0              | 1       | 8       | 16       |
| Queued Serial Peripheral Interface (QSPI) ports                    | 4              | 4       | 8       | 15       |
| Queued Serial Communications Interface (QSCI) ports                | 6              | 9       | 9       | 15       |
| Inter-Integrated Circuit (I <sup>2</sup> C) interface ports        | 4              | 6       | 6       | 6        |
| 12-bit Analog-to-Digital Converter (Cyclic ADC) inputs             | 10             | 16      | 16      | 16       |
| 16-bit Analog-to-Digital Converter (SAR ADC) inputs                | 2              | 8       | 10      | 16       |
| Analog Comparator inputs/outputs                                   | 10/4           | 13/6    | 13/6    | 16/6     |
| 12-bit Digital-to-Analog output                                    | 1              | 1       | 1       | 1        |
| Quad Timer Module (TMR) ports                                      | 6              | 9       | 11      | 13       |
| Controller Area Network (FlexCAN)                                  | 2              | 2       | 2       | 2        |
| Inter-Module Crossbar inputs/outputs                               | 12/2           | 16/6    | 19/17   | 25/19    |

Table continues on the next page...

**Table 3. Functional Group Pin Allocations  
(continued)**

| Functional Group                          | Number of Pins |         |         |          |
|-------------------------------------------|----------------|---------|---------|----------|
|                                           | 48 LQFP        | 64 LQFP | 80 LQFP | 100 LQFP |
| Clock inputs/outputs                      | 2/2            | 2/2     | 2/3     | 2/3      |
| JTAG / Enhanced On-Chip Emulation (EOnCE) | 4              | 4       | 4       | 4        |

## 4 Ordering parts

### 4.1 Determining valid orderable parts

Valid orderable part numbers are provided on the web. To determine the orderable part numbers for this device, go to [freescale.com](http://freescale.com) and perform a part number search for the following device numbers: MC56F84

## 5 Part identification

### 5.1 Description

Part numbers for the chip have fields that identify the specific part. You can use the values of these fields to determine the specific part you have received.

### 5.2 Format

Part numbers for this device have the following format: Q 56F8 4 C F P T PP N

### 5.3 Fields

This table lists the possible values for each field in the part number (not all combinations are valid):

| Field | Description          | Values                                                                                                                     |
|-------|----------------------|----------------------------------------------------------------------------------------------------------------------------|
| Q     | Qualification status | <ul style="list-style-type: none"> <li>MC = Fully qualified, general market flow</li> <li>PC = Prequalification</li> </ul> |

*Table continues on the next page...*

## Terminology and guidelines

| Field | Description                                                             | Values                                                                                                                                            |
|-------|-------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|
| 56F8  | DSC family with flash memory and DSP56800/<br>DSP56800E/DSP56800EX core | <ul style="list-style-type: none"> <li>• 56F8</li> </ul>                                                                                          |
| 4     | DSC subfamily                                                           | <ul style="list-style-type: none"> <li>• 4</li> </ul>                                                                                             |
| C     | Maximum CPU frequency (MHz)                                             | <ul style="list-style-type: none"> <li>• 4 = 60 MHz</li> <li>• 5 = 80 MHz</li> <li>• 7 = 100 MHz</li> </ul>                                       |
| F     | Primary program flash memory size                                       | <ul style="list-style-type: none"> <li>• 4 = 64 KB</li> <li>• 5 = 96 KB</li> <li>• 6 = 128 KB</li> <li>• 8 = 256 KB</li> </ul>                    |
| P     | Pin count                                                               | <ul style="list-style-type: none"> <li>• 0 and 1 = 48</li> <li>• 2 and 3 = 64</li> <li>• 4, 5, and 6 = 80</li> <li>• 7, 8, and 9 = 100</li> </ul> |
| T     | Temperature range (°C)                                                  | <ul style="list-style-type: none"> <li>• V = -40 to 105</li> </ul>                                                                                |
| PP    | Package identifier                                                      | <ul style="list-style-type: none"> <li>• LF = 48LQFP</li> <li>• LH = 64LQFP</li> <li>• LK = 80LQFP</li> <li>• LL = 100LQFP</li> </ul>             |
| N     | Packaging type                                                          | <ul style="list-style-type: none"> <li>• R = Tape and reel</li> <li>• (Blank) = Trays</li> </ul>                                                  |

## 5.4 Example

This is an example part number: MC56F84789VLL

## 6 Terminology and guidelines

### 6.1 Definition: Operating requirement

An *operating requirement* is a specified value or range of values for a technical characteristic that you must guarantee during operation to avoid incorrect operation and possibly decreasing the useful life of the chip.

#### 6.1.1 Example

This is an example of an operating requirement:

| Symbol   | Description               | Min. | Max. | Unit |
|----------|---------------------------|------|------|------|
| $V_{DD}$ | 1.0 V core supply voltage | 0.9  | 1.1  | V    |

## 6.2 Definition: Operating behavior

An *operating behavior* is a specified value or range of values for a technical characteristic that are guaranteed during operation if you meet the operating requirements and any other specified conditions.

### 6.2.1 Example

This is an example of an operating behavior:

| Symbol   | Description                              | Min. | Max. | Unit    |
|----------|------------------------------------------|------|------|---------|
| $I_{WP}$ | Digital I/O weak pullup/pulldown current | 10   | 130  | $\mu A$ |

## 6.3 Definition: Attribute

An *attribute* is a specified value or range of values for a technical characteristic that are guaranteed, regardless of whether you meet the operating requirements.

### 6.3.1 Example

This is an example of an attribute:

| Symbol | Description                     | Min. | Max. | Unit |
|--------|---------------------------------|------|------|------|
| CIN_D  | Input capacitance: digital pins | —    | 7    | pF   |

## 6.4 Definition: Rating

A *rating* is a minimum or maximum value of a technical characteristic that, if exceeded, may cause permanent chip failure:

## Terminology and guidelines

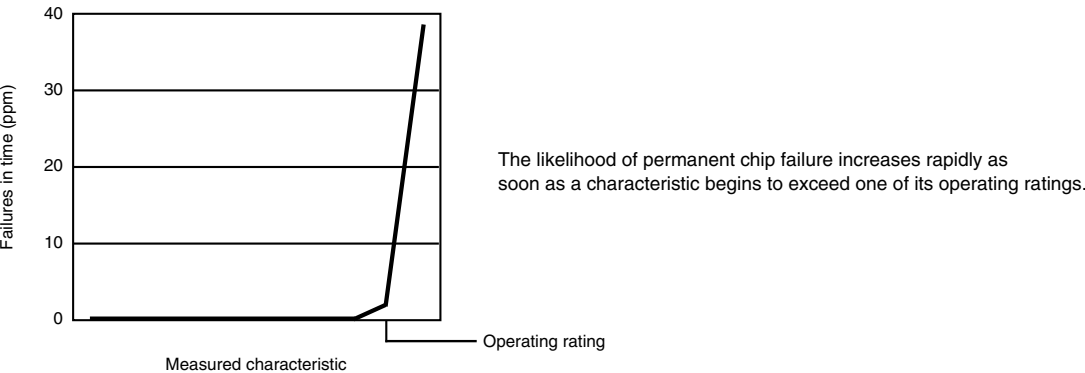
- *Operating ratings* apply during operation of the chip.
- *Handling ratings* apply when the chip is not powered.

### 6.4.1 Example

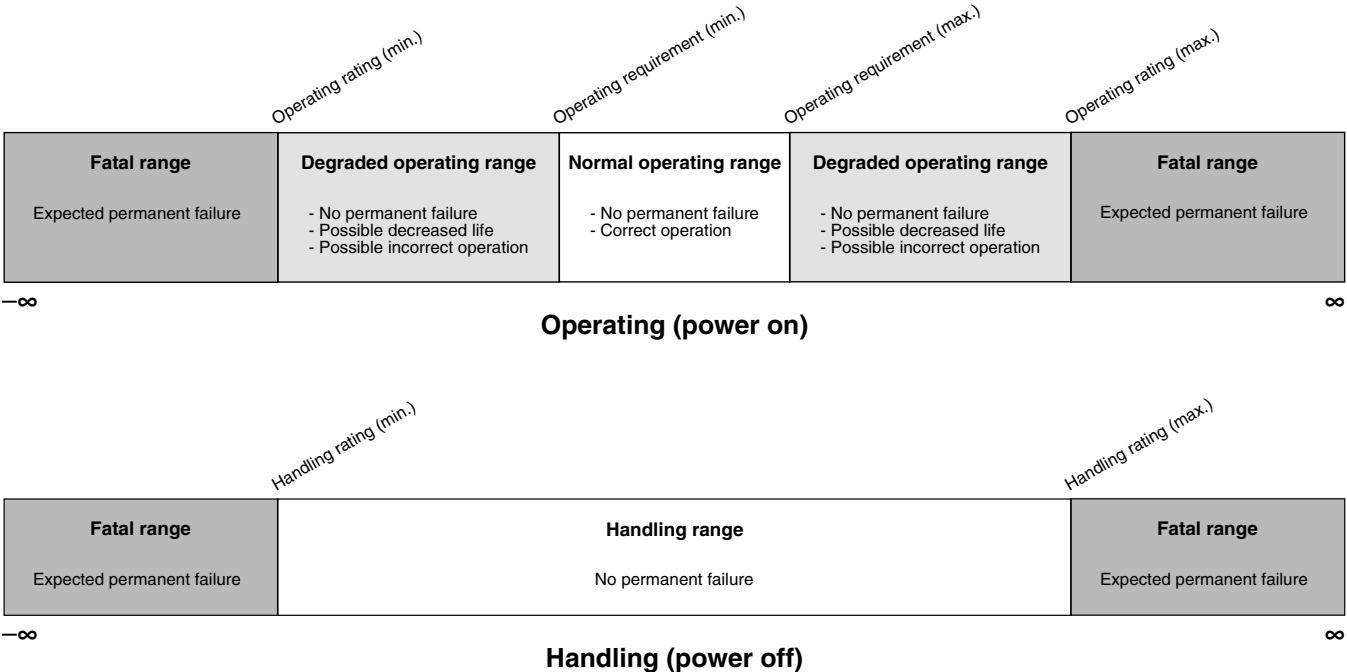
This is an example of an operating rating:

| Symbol   | Description               | Min. | Max. | Unit |
|----------|---------------------------|------|------|------|
| $V_{DD}$ | 1.0 V core supply voltage | -0.3 | 1.2  | V    |

### 6.5 Result of exceeding a rating



## 6.6 Relationship between ratings and operating requirements



## 6.7 Guidelines for ratings and operating requirements

Follow these guidelines for ratings and operating requirements:

- Never exceed any of the chip's ratings.
- During normal operation, don't exceed any of the chip's operating requirements.
- If you must exceed an operating requirement at times other than during normal operation (for example, during power sequencing), limit the duration as much as possible.

## 6.8 Definition: Typical value

A *typical value* is a specified value for a technical characteristic that:

- Lies within the range of values specified by the operating behavior
- Given the typical manufacturing process, is representative of that characteristic during operation when you meet the typical-value conditions or other specified conditions

Typical values are provided as design guidelines and are neither tested nor guaranteed.

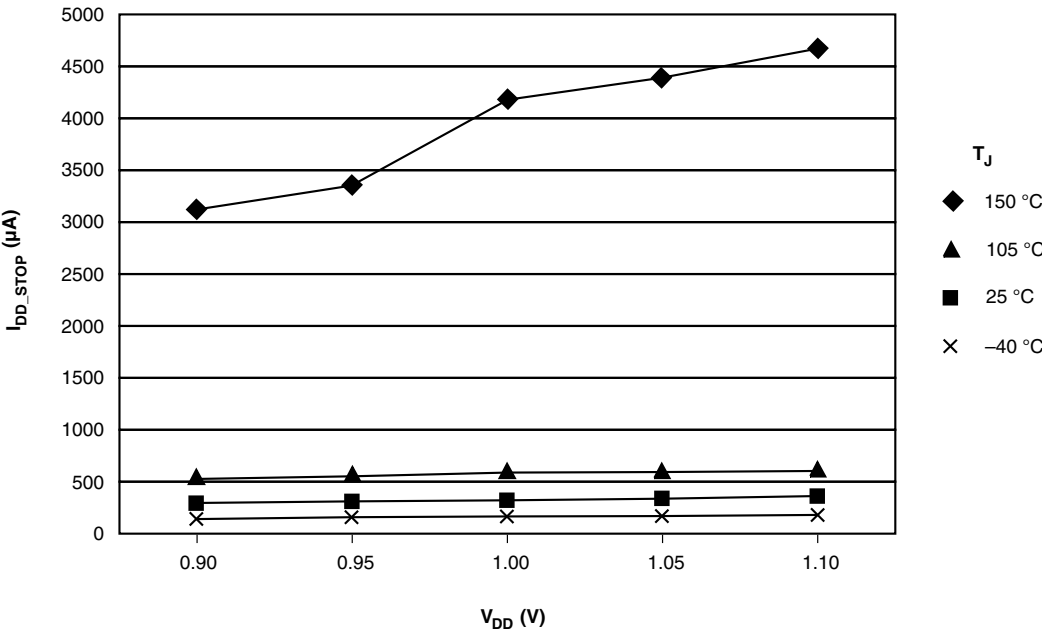
### 6.8.1 Example 1

This is an example of an operating behavior that includes a typical value:

| Symbol   | Description                              | Min. | Typ. | Max. | Unit    |
|----------|------------------------------------------|------|------|------|---------|
| $I_{WP}$ | Digital I/O weak pullup/pulldown current | 10   | 70   | 130  | $\mu A$ |

### 6.8.2 Example 2

This is an example of a chart that shows typical values for various voltage and temperature conditions:



## 6.9 Typical value conditions

Typical values assume you meet the following conditions (or other conditions as specified):

| Symbol   | Description          | Value | Unit        |
|----------|----------------------|-------|-------------|
| $T_A$    | Ambient temperature  | 25    | $^{\circ}C$ |
| $V_{DD}$ | 3.3 V supply voltage | 3.3   | V           |

## 7 Ratings

### 7.1 Thermal handling ratings

| Symbol           | Description                   | Min. | Max. | Unit | Notes |
|------------------|-------------------------------|------|------|------|-------|
| T <sub>STG</sub> | Storage temperature           | –55  | 150  | °C   | 1     |
| T <sub>SDR</sub> | Solder temperature, lead-free | —    | 260  | °C   | 2     |

1. Determined according to JEDEC Standard JESD22-A103, *High Temperature Storage Life*.
2. Determined according to IPC/JEDEC Standard J-STD-020, *Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices*.

### 7.2 Moisture handling ratings

| Symbol | Description                | Min. | Max. | Unit | Notes |
|--------|----------------------------|------|------|------|-------|
| MSL    | Moisture sensitivity level | —    | 3    | —    | 1     |

1. Determined according to IPC/JEDEC Standard J-STD-020, *Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices*.

### 7.3 ESD handling ratings

Although damage from electrostatic discharge (ESD) is much less common on these devices than on early CMOS circuits, use normal handling precautions to avoid exposure to static discharge. Qualification tests are performed to ensure that these devices can withstand exposure to reasonable levels of static without suffering any permanent damage.

All ESD testing is in conformity with AEC-Q100 Stress Test Qualification. During the device qualification ESD stresses were performed for the human body model (HBM), the machine model (MM), and the charge device model (CDM).

All latch-up testing is in conformity with AEC-Q100 Stress Test Qualification.

A device is defined as a failure if after exposure to ESD pulses, the device no longer meets the device specification. Complete DC parametric and functional testing is performed as per the applicable device specification at room temperature followed by hot temperature, unless specified otherwise in the device specification.

**Table 4. ESD/Latch-up Protection**

| Characteristic <sup>1</sup>                      | Min   | Max   | Unit |
|--------------------------------------------------|-------|-------|------|
| ESD for Human Body Model (HBM)                   | -2000 | +2000 | V    |
| ESD for Machine Model (MM)                       | -200  | +200  | V    |
| ESD for Charge Device Model (CDM)                | -500  | +500  | V    |
| Latch-up current at TA= 85°C (I <sub>LAT</sub> ) | -100  | +100  | mA   |

1. Parameter is achieved by design characterization on a small sample size from typical devices under typical conditions unless otherwise noted.

## 7.4 Voltage and current operating ratings

Absolute maximum ratings are stress ratings only, and functional operation at the maxima is not guaranteed. Stress beyond the limits specified in [Table 5](#) may affect device reliability or cause permanent damage to the device.

**Table 5. Absolute Maximum Ratings (V<sub>SS</sub> = 0 V, V<sub>SSA</sub> = 0 V)**

| Characteristic                                                                           | Symbol                   | Notes <sup>1</sup> | Min  | Max     | Unit |
|------------------------------------------------------------------------------------------|--------------------------|--------------------|------|---------|------|
| Supply Voltage Range                                                                     | V <sub>DD</sub>          |                    | -0.3 | 4.0     | V    |
| Analog Supply Voltage Range                                                              | V <sub>DDA</sub>         |                    | -0.3 | 4.0     | V    |
| ADC High Voltage Reference                                                               | V <sub>REFHx</sub>       |                    | -0.3 | 4.0     | V    |
| Voltage difference V <sub>DD</sub> to V <sub>DDA</sub>                                   | ΔV <sub>DD</sub>         |                    | -0.3 | 0.3     | V    |
| Voltage difference V <sub>SS</sub> to V <sub>SSA</sub>                                   | ΔV <sub>SS</sub>         |                    | -0.3 | 0.3     | V    |
| Digital Input Voltage Range                                                              | V <sub>IN</sub>          | Pin Group 1        | -0.3 | 5.5     | V    |
| RESET Input Voltage Range                                                                | V <sub>IN_RESET</sub>    | Pin Group 2        | -0.3 | 4.0     | V    |
| Oscillator Input Voltage Range                                                           | V <sub>OSC</sub>         | Pin Group 4        | -0.4 | 4.0     | V    |
| Analog Input Voltage Range                                                               | V <sub>INA</sub>         | Pin Group 3        | -0.3 | 4.0     | V    |
| Input clamp current, per pin (V <sub>IN</sub> < V <sub>SS</sub> - 0.3 V) <sup>2, 3</sup> | V <sub>IC</sub>          |                    | —    | -5.0    | mA   |
| Output clamp current, per pin <sup>4</sup>                                               | V <sub>OC</sub>          |                    | —    | ±20.0   | mA   |
| Contiguous pin DC injection current—regional limit sum of 16 contiguous pins             | I <sub>ICont</sub>       |                    | -25  | 25      | mA   |
| Output Voltage Range (normal push-pull mode)                                             | V <sub>OUT</sub>         | Pin Group 1, 2     | -0.3 | 4.0     | V    |
| Output Voltage Range (open drain mode)                                                   | V <sub>OUTOD</sub>       | Pin Group 1        | -0.3 | 5.5     | V    |
| RESET Output Voltage Range                                                               | V <sub>OUTOD_RESET</sub> | Pin Group 2        | -0.3 | 4.0     | V    |
| DAC Output Voltage Range                                                                 | V <sub>OUT_DAC</sub>     | Pin Group 5        | -0.3 | 4.0     | V    |
| Ambient Temperature Industrial                                                           | T <sub>A</sub>           |                    | -40  | 105/105 | °C   |
| Junction Temperature                                                                     | T <sub>j</sub>           |                    | -40  | 125     | °C   |
| Storage Temperature Range (Extended Industrial)                                          | T <sub>STG</sub>         |                    | -55  | 150     | °C   |

### 1. Default Mode

- Pin Group 1: GPIO, TDI, TDO, TMS, TCK
- Pin Group 2: RESET

- Pin Group 3: ADC and Comparator Analog Inputs
  - Pin Group 4: XTAL, EXTAL
  - Pin Group 5: DAC analog output
2. Continuous clamp current
  3. All 5 volt tolerant digital I/O pins are internally clamped to  $V_{SS}$  through a ESD protection diode. There is no diode connection to  $V_{DD}$ . If  $V_{IN}$  greater than  $VDIO\_MIN (= V_{SS}-0.3\text{ V})$  is observed, then there is no need to provide current limiting resistors at the pads. If this limit cannot be observed, then a current limiting resistor is required.
  4. I/O is configured as push-pull mode.

## 8 General

### 8.1 General characteristics

The device is fabricated in high-density, low-power CMOS with 5 V–tolerant TTL-compatible digital inputs, except for the  $\overline{RESET}$  pin which is 3.3V only. The term “5 V–tolerant” refers to the capability of an I/O pin, built on a 3.3 V–compatible process technology, to withstand a voltage up to 5.5 V without damaging the device.

5 V–tolerant I/O is desirable because many systems have a mixture of devices designed for 3.3 V and 5 V power supplies. In such systems, a bus may carry both 3.3 V– and 5 V–compatible I/O voltage levels (a standard 3.3 V I/O is designed to receive a maximum voltage of  $3.3\text{ V} \pm 10\%$  during normal operation without causing damage). This 5 V–tolerant capability therefore offers the power savings of 3.3 V I/O levels combined with the ability to receive 5 V levels without damage.

Absolute maximum ratings in [Table 5](#) are stress ratings only, and functional operation at the maximum is not guaranteed. Stress beyond these ratings may affect device reliability or cause permanent damage to the device.

Unless otherwise stated, all specifications within this chapter apply over the temperature range of  $-40^{\circ}\text{C}$  to  $105^{\circ}\text{C}$  ambient temperature over the following supply ranges:

$V_{SS}=V_{SSA}=0\text{V}$ ,  $V_{DD}=V_{DDA}=3.0\text{V}$  to  $3.6\text{V}$ ,  $CL \leq 50\text{ pF}$ ,  $f_{OP}=100\text{MHz}$ .

#### CAUTION

This device contains protective circuitry to guard against damage due to high static voltage or electrical fields. However, normal precautions are advised to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate voltage level.

## 8.2 AC electrical characteristics

Tests are conducted using the input levels specified in Table 8. Unless otherwise specified, propagation delays are measured from the 50% to the 50% point, and rise and fall times are measured between the 10% and 90% points, as shown in Figure 3.

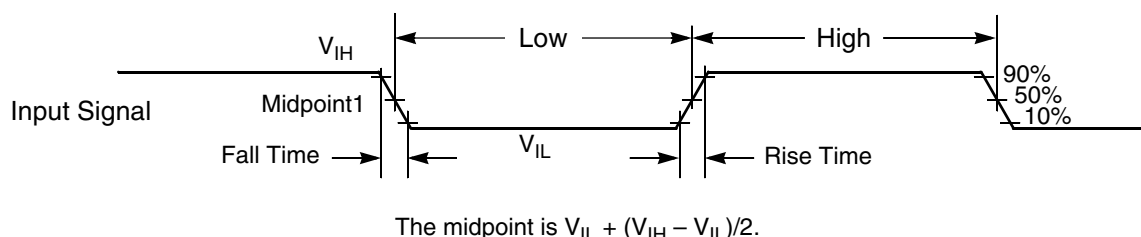


**Figure 3. Input signal measurement references**

Figure 4 shows the definitions of the following signal states:

- Active state, when a bus or signal is driven, and enters a low impedance state
- Tri-stated, when a bus or signal is placed in a high impedance state
- Data Valid state, when a signal level has reached  $V_{OL}$  or  $V_{OH}$
- Data Invalid state, when a signal level is in transition between  $V_{OL}$  and  $V_{OH}$

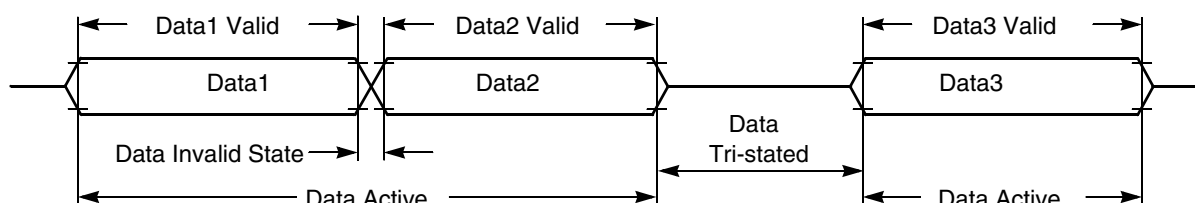


**Figure 4. Signal states**

## 8.3 Nonswitching electrical specifications

### 8.3.1 Voltage and current operating requirements

This section includes information about recommended operating conditions.

#### NOTE

Recommended  $V_{DD}$  ramp rate is between 1 ms and 200 ms.

**Table 6. Recommended Operating Conditions ( $V_{REFLx}=0V$ ,  $V_{SSA}=0V$ ,  $V_{SS}=0V$ )**

| Characteristic              | Symbol               | Notes <sup>1</sup> | Min | Typ | Max | Unit |
|-----------------------------|----------------------|--------------------|-----|-----|-----|------|
| Supply voltage <sup>2</sup> | $V_{DD}$ , $V_{DDA}$ |                    | 2.7 | 3.3 | 3.6 | V    |

Table continues on the next page...

**Table 6. Recommended Operating Conditions ( $V_{REFLx}=0V$ ,  $V_{SSA}=0V$ ,  $V_{SS}=0V$ ) (continued)**

| Characteristic                                                                                                                               | Symbol                     | Notes <sup>1</sup>                 | Min                 | Typ | Max                  | Unit |
|----------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|------------------------------------|---------------------|-----|----------------------|------|
| ADC (Cyclic) Reference Voltage High                                                                                                          | $V_{REFHA}$<br>$V_{REFHB}$ |                                    | 3.0                 |     | $V_{DDA}$            | V    |
| ADC (SAR) Reference Voltage High                                                                                                             | $V_{REFHC}$                |                                    | 2.0                 |     | $V_{DDA}$            | V    |
| Voltage difference $V_{DD}$ to $V_{DDA}$                                                                                                     | $\Delta V_{DD}$            |                                    | -0.1                | 0   | 0.1                  | V    |
| Voltage difference $V_{SS}$ to $V_{SSA}$                                                                                                     | $\Delta V_{SS}$            |                                    | -0.1                | 0   | 0.1                  | V    |
| Input Voltage High (digital inputs)                                                                                                          | $V_{IH}$                   | Pin Group 1                        | $0.7 \times V_{DD}$ |     | 5.5                  | V    |
| RESET Voltage High                                                                                                                           | $V_{IH\_RESET}$            | Pin Group 2                        | $0.7 \times V_{DD}$ | —   | $V_{DD}$             | V    |
| Input Voltage Low (digital inputs)                                                                                                           | $V_{IL}$                   | Pin Groups 1, 2                    |                     |     | $0.35 \times V_{DD}$ | V    |
| Oscillator Input Voltage High<br>XTAL driven by an external clock source                                                                     | $V_{IHOSC}$                | Pin Group 4                        | 2.0                 |     | $V_{DD} + 0.3$       | V    |
| Oscillator Input Voltage Low                                                                                                                 | $V_{ILOSC}$                | Pin Group 4                        | -0.3                |     | 0.8                  | V    |
| Output Source Current High (at $V_{OH}$ min.) <sup>3, 4</sup><br>• Programmed for low drive strength<br>• Programmed for high drive strength | $I_{OH}$                   | Pin Group 1<br>Pin Group 1         | —<br>—              |     | -2<br>-9             | mA   |
| Output Source Current Low (at $V_{OL}$ max.) <sup>3, 4</sup><br>• Programmed for low drive strength<br>• Programmed for high drive strength  | $I_{OL}$                   | Pin Groups 1, 2<br>Pin Groups 1, 2 | —<br>—              |     | 2<br>9               | mA   |

**1. Default Mode**

- Pin Group 1: GPIO, TDI, TDO, TMS, TCK
- Pin Group 2: RESET
- Pin Group 3: ADC and Comparator Analog Inputs
- Pin Group 4: XTAL, EXTAL
- Pin Group 5: DAC analog output

2. ADC (Cyclic) specifications are not guaranteed when  $V_{DDA}$  is below 3.0 V.

3. Total IO sink current and total IO source current are limited to 75 mA each

4. Contiguous pin DC injection current of regional limit—including sum of negative injection currents or sum of positive injection currents of 16 contiguous pins—is 25 mA.

### 8.3.2 LVD and POR operating requirements

**Table 7. PMC Low-Voltage Detection (LVD) and Power-On Reset (POR) Parameters**

| Characteristic                   | Symbol | Min | Typ  | Max | Unit |
|----------------------------------|--------|-----|------|-----|------|
| POR Assert Voltage <sup>1</sup>  | POR    |     | 2.0  |     | V    |
| POR Release Voltage <sup>2</sup> | POR    |     | 2.7  |     | V    |
| LVI_2p7 Threshold Voltage        |        |     | 2.73 |     | V    |
| LVI_2p2 Threshold Voltage        |        |     | 2.23 |     | V    |

1. During 3.3-volt  $V_{DD}$  power supply ramp down

2. During 3.3-volt  $V_{DD}$  power supply ramp up (gated by LVI\_2p7)

### 8.3.3 Voltage and current operating behaviors

The following table provides information about power supply requirements and I/O pin characteristics.

**Table 8. DC Electrical Characteristics at Recommended Operating Conditions**

| Characteristic                                            | Symbol          | Notes <sup>1</sup> | Min                        | Typ | Max                        | Unit       | Test Conditions                                                |
|-----------------------------------------------------------|-----------------|--------------------|----------------------------|-----|----------------------------|------------|----------------------------------------------------------------|
| Output Voltage High                                       | $V_{OH}$        | Pin Group 1        | $V_{DD} - 0.5$             | —   | —                          | V          | $I_{OH} = I_{OHmax}$                                           |
| Output Voltage Low                                        | $V_{OL}$        | Pin Groups 1, 2    | —                          | —   | 0.5                        | V          | $I_{OL} = I_{OLmax}$                                           |
| Digital Input Current High<br>pull-up enabled or disabled | $I_{IH}$        | Pin Group 1        | —                          | 0   | +/- 2.5                    | $\mu A$    | $V_{IN} = 2.4 \text{ V to } 5.5 \text{ V}$                     |
|                                                           |                 | Pin Group 2        |                            |     |                            |            | $V_{IN} = 2.4 \text{ V to } V_{DD}$                            |
| Comparator Input Current High                             | $I_{IHC}$       | Pin Group 3        | —                          | 0   | +/- 2                      | $\mu A$    | $V_{IN} = V_{DDA}$                                             |
| Oscillator Input Current High                             | $I_{IHOSC}$     | Pin Group 3        | —                          | 0   | +/- 2                      | $\mu A$    | $V_{IN} = V_{DDA}$                                             |
| Internal Pull-Up Resistance                               | $R_{Pull-Up}$   |                    | 20                         | —   | 50                         | k $\Omega$ | —                                                              |
| Internal Pull-Down Resistance                             | $R_{Pull-Down}$ |                    | 20                         | —   | 50                         | k $\Omega$ | —                                                              |
| Comparator Input Current Low                              | $I_{ILC}$       | Pin Group 3        | —                          | 0   | +/- 2                      | $\mu A$    | $V_{IN} = 0V$                                                  |
| Oscillator Input Current Low                              | $I_{ILOSC}$     | Pin Group 3        | —                          | 0   | +/- 2                      | $\mu A$    | $V_{IN} = 0V$                                                  |
| DAC Output Voltage Range                                  | $V_{DAC}$       | Pin Group 5        | Typically $V_{SSA} + 40mV$ | —   | Typically $V_{DDA} - 40mV$ | V          | $R_{LD} = 3 \text{ k}\Omega \parallel C_{LD} = 400 \text{ pF}$ |
| Output Current <sup>1</sup><br>High Impedance State       | $I_{OZ}$        | Pin Groups 1, 2    | —                          | 0   | +/- 1                      | $\mu A$    | —                                                              |
| Schmitt Trigger Input Hysteresis                          | $V_{HYS}$       | Pin Groups 1, 2    | $0.06 \times V_{DD}$       | —   | —                          | V          | —                                                              |

#### 1. Default Mode

- Pin Group 1: GPIO, TDI, TDO, TMS, TCK
- Pin Group 2: RESET
- Pin Group 3: ADC and Comparator Analog Inputs
- Pin Group 4: XTAL, EXTAL
- Pin Group 5: DAC

### 8.3.4 Power mode operating behaviors

Parameters listed are guaranteed by design.

## NOTE

To filter noise on the RESETB pin, install a capacitor (up to 0.1 uF) on it.

**Table 9. Reset, stop, wait, and interrupt timing**

| Characteristic                                                              | Symbol    | Typical Min                       | Typical Max | Unit | See Figure |
|-----------------------------------------------------------------------------|-----------|-----------------------------------|-------------|------|------------|
| Minimum RESET Assertion Duration                                            | $t_{RA}$  | 16 <sup>1</sup>                   | —           | ns   | —          |
| RESET deassertion to First Address Fetch                                    | $t_{RDA}$ | $865 \times T_{OSC} + 8 \times T$ | —           | ns   | —          |
| Delay from Interrupt Assertion to Fetch of first instruction (exiting Stop) | $t_{IF}$  | 361.3                             | 570.9       | ns   | —          |

1. If the RESET pin filter is enabled by setting the RST\_FLT bit in the SIM\_CTRL register to 1, the minimum pulse assertion must be greater than 21 ns.

## NOTE

In the Table 9, T = system clock cycle and  $T_{OSC}$  = oscillator clock cycle. For an operating frequency of 100MHz, T=10ns.  
At 4MHz (used coming out of reset and stop modes), T=250ns.

**Table 10. Power-On-Reset mode transition times**

| Symbol    | Description                                                                                                                                      | Min   | Max   | Unit | Notes |
|-----------|--------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------|------|-------|
| $T_{POR}$ | After a POR event, the amount of delay from when VDD reaches 2.7V to when the first instruction executes (over the operating temperature range). | 199   | 225   | us   |       |
|           | LPS mode to LPRUN mode                                                                                                                           | 240   | 551   | us   | 4     |
|           | VLPS mode to VLPRUN mode                                                                                                                         | 1424  | 1500  | us   | 5     |
|           | STOP mode to RUN mode                                                                                                                            | 6.79  | 7.29  | us   | 3     |
|           | WAIT mode to RUN mode                                                                                                                            | 0.570 | 0.620 | us   | 2     |
|           | VLPWAIT mode to VLPRUN mode                                                                                                                      | 1413  | 1500  | us   | 5     |
|           | LPWAIT mode to LPRUN mode                                                                                                                        | 237.2 | 554   | us   | 4     |

1. Normal boot (FTFL\_OPT[LPBOOT]=1)
2. Clock configuration: CPU clock = 100 MHz, bus clock = 100 MHz, flash clock = 25 MHz
3. Clock configuration: CPU clock = 4 MHz, system clock source is 8 MHz IRC
4. CPU Clock = 200 kHz and 8 Mhz IRC in standby mode
5. Clock configuration: Using 64 kHz external clock source, CPU Clock = 32 kHz

## 8.3.5 Power consumption operating behaviors

**Table 11. Current Consumption**

| Mode            | Maximum Frequency | Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                               | Typical at 3.3 V, 25°C       |                  | Maximum at 3.6 V, 105°C      |                  |
|-----------------|-------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------|------------------|------------------------------|------------------|
|                 |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | I <sub>DD</sub> <sup>1</sup> | I <sub>DDA</sub> | I <sub>DD</sub> <sup>1</sup> | I <sub>DDA</sub> |
| RUN             | 100 MHz           | <ul style="list-style-type: none"> <li>100 MHz Device Clock</li> <li>Regulators are in full regulation</li> <li>Relaxation Oscillator on</li> <li>PLL powered on</li> <li>Continuous MAC instructions with fetches from Program Flash</li> <li>All peripheral modules enabled.</li> <li>TMRs and SCIs using 1X Clock</li> <li>NanoEdge within PWMA using 1X clock</li> <li>ADC/DAC powered on and clocked at 5 MHz<sup>2</sup></li> <li>Comparator powered on</li> </ul> | 63.7 mA                      | 16.7 mA          | 101 mA                       | 32 mA            |
| WAIT            | 100 MHz           | <ul style="list-style-type: none"> <li>100 MHz Device Clock</li> <li>Regulators are in full regulation</li> <li>Relaxation Oscillator on</li> <li>PLL powered on</li> <li>Processor Core in WAIT state</li> <li>All Peripheral modules enabled.</li> <li>TMRs and SCIs using 1X Clock</li> <li>NanoEdge within PWMA using 2X clock</li> <li>ADC/DAC/Comparator powered off</li> </ul>                                                                                    | 43.5 mA                      | 13.58 µA         | 80 mA                        | 47.55 µA         |
| STOP            | 4 MHz             | <ul style="list-style-type: none"> <li>4 MHz Device Clock</li> <li>Regulators are in full regulation</li> <li>Relaxation Oscillator on</li> <li>PLL powered off</li> <li>Processor Core in STOP state</li> <li>All peripheral module and core clocks are off</li> <li>ADC/DAC/Comparator powered off</li> </ul>                                                                                                                                                          | 9.19 mA                      | 13.20 µA         | 30.14 mA                     | 45.00 µA         |
| LPRUN (LsRUN)   | 2 MHz             | <ul style="list-style-type: none"> <li>200 kHz Device Clock from Relaxation Oscillator (ROSC)</li> <li>ROSC in standby mode</li> <li>Regulators are in standby</li> <li>PLL disabled</li> <li>Repeat NOP instructions</li> <li>All peripheral modules enabled, except NanoEdge and cyclic ADCs<sup>3</sup></li> <li>Simple loop with running from platform instruction buffer</li> </ul>                                                                                 | 1.86 mA                      | 3.33 mA          | 16.69 mA                     | 5.37 mA          |
| LPWAIT (LsWAIT) | 2 MHz             | <ul style="list-style-type: none"> <li>200 kHz Device Clock from Relaxation Oscillator (ROSC)</li> <li>ROSC in standby mode</li> <li>Regulators are in standby</li> <li>PLL disabled</li> <li>All peripheral modules enabled, except NanoEdge and cyclic ADCs<sup>3</sup></li> <li>Processor core in wait mode</li> </ul>                                                                                                                                                | 1.83 mA                      | 2.67 mA          | 16.48 mA                     | 5.37 mA          |

*Table continues on the next page...*

**Table 11. Current Consumption (continued)**

| Mode            | Maximum Frequency | Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | Typical at 3.3 V, 25°C       |                  | Maximum at 3.6 V, 105°C      |                  |
|-----------------|-------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------|------------------|------------------------------|------------------|
|                 |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | I <sub>DD</sub> <sup>1</sup> | I <sub>DDA</sub> | I <sub>DD</sub> <sup>1</sup> | I <sub>DDA</sub> |
| LPSTOP (LsSTOP) | 2 MHz             | <ul style="list-style-type: none"> <li>200 kHz Device Clock from Relaxation Oscillator (ROSC)</li> <li>ROSC in standby mode</li> <li>Regulators are in standby</li> <li>PLL disabled</li> <li>Only PITs and COP enabled; other peripheral modules disabled and clocks gated off<sup>3</sup></li> <li>Processor core in stop mode</li> </ul>                                                                                                                                | 1.07 mA                      | 13.13 µA         | 15.76 mA                     | 45 µA            |
| VLPRUN          | 200 kHz           | <ul style="list-style-type: none"> <li>32 kHz Device Clock</li> <li>Clocked by a 32 kHz external clock source</li> <li>Oscillator in power down</li> <li>All ROSCs disabled</li> <li>Large regulator is in standby</li> <li>Small regulator is disabled</li> <li>PLL disabled</li> <li>Repeat NOP instructions</li> <li>All peripheral modules, except COP and EWM, disabled and clocks gated off</li> <li>Simple loop running from platform instruction buffer</li> </ul> | 0.57 mA                      | 13.04 µA         | 8.64 mA                      | 18.15 µA         |
| VLPWAIT         | 200 kHz           | <ul style="list-style-type: none"> <li>32 kHz Device Clock</li> <li>Clocked by a 32 kHz external clock source</li> <li>Oscillator in power down</li> <li>All ROSCs disabled</li> <li>Large regulator is in standby</li> <li>Small regulator is disabled</li> <li>PLL disabled</li> <li>All peripheral modules, except COP, disabled and clocks gated off</li> <li>Processor core in wait mode</li> </ul>                                                                   | 0.56 mA                      | 12.02 µA         | 8.53 mA                      | 16.50 µA         |
| VLPSTOP         | 200 kHz           | <ul style="list-style-type: none"> <li>32 kHz Device Clock</li> <li>Clocked by a 32 kHz external clock source</li> <li>Oscillator in power down</li> <li>All ROSCs disabled</li> <li>Large regulator is in standby</li> <li>Small regulator is disabled</li> <li>PLL disabled</li> <li>All peripheral modules, except COP, disabled and clocks gated off</li> <li>Processor core in stop mode</li> </ul>                                                                   | 0.56 mA                      | 10.58 µA         | 8.50 mA                      | 15.00 µA         |

1. No output switching, all ports configured as inputs, all inputs low, no DC loads
2. ADC power consumption at higher frequency can be found in [Table 28](#)
3. In all chip LP modes and flash memory VLP modes, the maximum frequency for flash memory operation is 250 kHz, because of the fixed frequency ratio of 1:4 between the CPU clock and the flash clock (when using a 2 MHz external input clock and the CPU is operating at 1 MHz).

### 8.3.6 Designing with radiated emissions in mind

To find application notes that provide guidance on designing your system to minimize interference from radiated emissions:

1. Go to [www.freescale.com](http://www.freescale.com).
2. Perform a keyword search for “EMC design.”

### 8.3.7 Capacitance attributes

Table 12. Capacitance attributes

| Description        | Symbol    | Min. | Typ. | Max. | Unit |
|--------------------|-----------|------|------|------|------|
| Input capacitance  | $C_{IN}$  | —    | 10   | —    | pF   |
| Output capacitance | $C_{OUT}$ | —    | 10   | —    | pF   |

## 8.4 Switching specifications

### 8.4.1 Device clock specifications

Table 13. Device clock specifications

| Symbol          | Description                                                                                                                                                     | Min.       | Max.       | Unit | Notes |
|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|------------|------|-------|
| Normal run mode |                                                                                                                                                                 |            |            |      |       |
| $f_{SYSCLK}$    | Device (system and core) clock frequency <ul style="list-style-type: none"> <li>• using relaxation oscillator</li> <li>• using external clock source</li> </ul> | 0.001<br>0 | 100<br>100 | MHz  |       |
| $f_{IPBUS}$     | IP bus clock                                                                                                                                                    | —          | 100        | MHz  |       |

### 8.4.2 General switching timing

Table 14. Switching timing

| Symbol | Description                                                                         | Min | Max  | Unit                      | Notes |
|--------|-------------------------------------------------------------------------------------|-----|------|---------------------------|-------|
|        | GPIO pin interrupt pulse width <sup>1</sup><br>Synchronous path                     | 1.5 |      | IP Bus<br>Clock<br>Cycles | 2     |
|        | Port rise and fall time (high drive strength), Slew disabled 2.7 ≤ $V_{DD}$ ≤ 3.6V. | 5.5 | 15.1 | ns                        | 3     |
|        | Port rise and fall time (high drive strength), Slew enabled 2.7 ≤ $V_{DD}$ ≤ 3.6V.  | 1.5 | 6.8  | ns                        | 3     |

Table continues on the next page...

**Table 14. Switching timing (continued)**

| Symbol | Description                                                                                  | Min | Max  | Unit | Notes |
|--------|----------------------------------------------------------------------------------------------|-----|------|------|-------|
|        | Port rise and fall time (low drive strength). Slew disabled . 2.7<br>$\leq V_{DD} \leq 3.6V$ | 8.2 | 17.8 | ns   | 4     |
|        | Port rise and fall time (low drive strength). Slew enabled . 2.7<br>$\leq V_{DD} \leq 3.6V$  | 3.2 | 9.2  | ns   | 4     |

1. Applies to a pin only when it is configured as GPIO and configured to cause an interrupt by appropriately programming GPIO<sub>n</sub>\_IPOLR and GPIO<sub>n</sub>\_IENR.
2. The greater synchronous and asynchronous timing must be met.
3. 75 pF load
4. 15 pF load

## 8.5 Thermal specifications

### 8.5.1 Thermal operating requirements

**Table 15. Thermal operating requirements**

| Symbol | Description                               | Min. | Max. | Unit |
|--------|-------------------------------------------|------|------|------|
| $T_J$  | Die junction temperature                  | −40  | 125  | °C   |
| $T_A$  | Ambient temperature (extended industrial) | −40  | 105  | °C   |

### 8.5.2 Thermal attributes

This section provides information about operating temperature range, power dissipation, and package thermal resistance. Power dissipation on I/O pins is usually small compared to the power dissipation in on-chip logic and voltage regulator circuits, and it is user-determined rather than being controlled by the MCU design. To account for  $P_{I/O}$  in power calculations, determine the difference between actual pin voltage and  $V_{SS}$  or  $V_{DD}$  and multiply by the pin current for each I/O pin. Except in cases of unusually high pin current (heavy loads), the difference between pin voltage and  $V_{SS}$  or  $V_{DD}$  is very small.

See [Thermal design considerations](#) for more detail on thermal design considerations.

| Board type        | Symbol          | Description                                                  | 64 LQFP | 80 LQFP | 100 LQFP | Unit | Notes |
|-------------------|-----------------|--------------------------------------------------------------|---------|---------|----------|------|-------|
| Single-layer (1s) | $R_{\theta JA}$ | Thermal resistance, junction to ambient (natural convection) | 64      | 55      | 62       | °C/W | 1, 2  |

Table continues on the next page...

## General

| Board type        | Symbol           | Description                                                                                     | 64 LQFP | 80 LQFP | 100 LQFP | Unit | Notes |
|-------------------|------------------|-------------------------------------------------------------------------------------------------|---------|---------|----------|------|-------|
| Four-layer (2s2p) | $R_{\theta JA}$  | Thermal resistance, junction to ambient (natural convection)                                    | 46      | 40      | 49       | °C/W | 1, 3  |
| Single-layer (1s) | $R_{\theta JMA}$ | Thermal resistance, junction to ambient (200 ft./min. air speed)                                | 52      | 44      | 52       | °C/W | 1,3   |
| Four-layer (2s2p) | $R_{\theta JMA}$ | Thermal resistance, junction to ambient (200 ft./min. air speed)                                | 39      | 34      | 43       | °C/W | 1,3   |
| —                 | $R_{\theta JB}$  | Thermal resistance, junction to board                                                           | 28      | 24      | 35       | °C/W | 4     |
| —                 | $R_{\theta JC}$  | Thermal resistance, junction to case                                                            | 15      | 12      | 17       | °C/W | 5     |
| —                 | $\Psi_{JT}$      | Thermal characterization parameter, junction to package top outside center (natural convection) | 3       | 3       | 3        | °C/W | 6     |

1. Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.
2. Determined according to JEDEC Standard JESD51-2, *Integrated Circuits Thermal Test Method Environmental Conditions—Natural Convection (Still Air)* with the single layer board horizontal. For the LQFP, the board meets the JESD51-3 specification.
3. Determined according to JEDEC Standard JESD51-6, *Integrated Circuits Thermal Test Method Environmental Conditions—Forced Convection (Moving Air)* with the board horizontal.
4. Determined according to JEDEC Standard JESD51-8, *Integrated Circuit Thermal Test Method Environmental Conditions—Junction-to-Board*. Board temperature is measured on the top surface of the board near the package.
5. Determined according to Method 1012.1 of MIL-STD 883, *Test Method Standard, Microcircuits*, with the cold plate temperature used for the case temperature. The value includes the thermal resistance of the interface material between the top of the package and the cold plate.
6. Determined according to JEDEC Standard JESD51-2, *Integrated Circuits Thermal Test Method Environmental Conditions—Natural Convection (Still Air)*.

# 9 Peripheral operating requirements and behaviors

## 9.1 Core modules

### 9.1.1 JTAG timing

Table 16. JTAG timing

| Characteristic             | Symbol   | Min | Max        | Unit | See Figure |
|----------------------------|----------|-----|------------|------|------------|
| TCK frequency of operation | $f_{OP}$ | DC  | SYS_CLK/16 | MHz  | Figure 5   |
| TCK clock pulse width      | $t_{PW}$ | 50  | —          | ns   | Figure 5   |
| TMS, TDI data set-up time  | $t_{DS}$ | 5   | —          | ns   | Figure 6   |
| TMS, TDI data hold time    | $t_{DH}$ | 5   | —          | ns   | Figure 6   |
| TCK low to TDO data valid  | $t_{DV}$ | —   | 30         | ns   | Figure 6   |
| TCK low to TDO tri-state   | $t_{TS}$ | —   | 30         | ns   | Figure 6   |

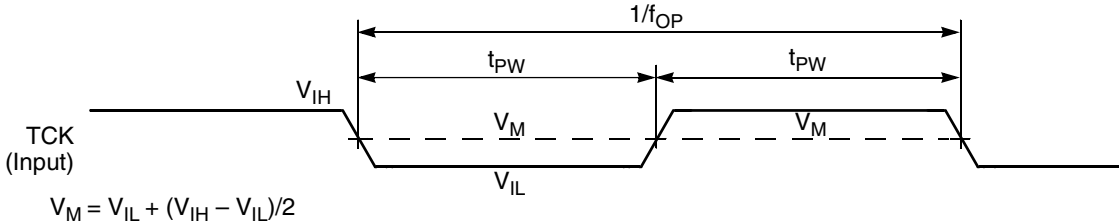


Figure 5. Test clock input timing diagram

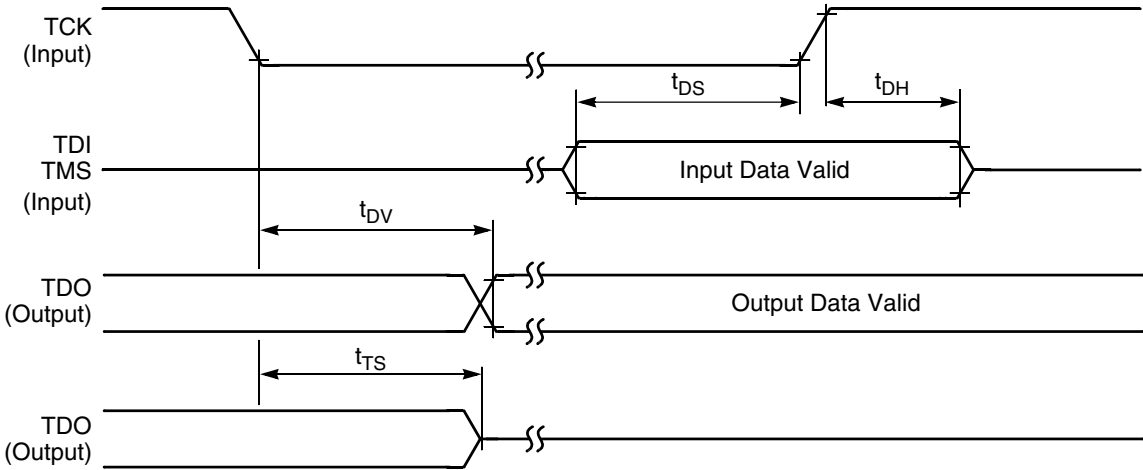


Figure 6. Test access port timing diagram

## 9.2 System modules

### 9.2.1 Voltage regulator specifications

The voltage regulator supplies approximately 1.2 V to the MC56F84xxx's core logic. For proper operations, the voltage regulator requires an external 2.2  $\mu\text{F}$  capacitor on each  $V_{\text{CAP}}$  pin. Ceramic and tantalum capacitors tend to provide better performance tolerances. The output voltage can be measured directly on the  $V_{\text{CAP}}$  pin. The specifications for this regulator are shown in [Table 17](#).

**Table 17. Regulator 1.2 V parameters**

| Characteristic                                                | Symbol           | Min | Typ  | Max | Unit    |
|---------------------------------------------------------------|------------------|-----|------|-----|---------|
| Output Voltage <sup>1</sup>                                   | $V_{\text{CAP}}$ | —   | 1.22 | —   | V       |
| Short Circuit Current <sup>2</sup>                            | $I_{\text{SS}}$  | —   | 600  | —   | mA      |
| Short Circuit Tolerance ( $V_{\text{CAP}}$ shorted to ground) | $T_{\text{RSC}}$ | —   | —    | 30  | Minutes |

1. Value is after trim

2. Guaranteed by design

**Table 18. Bandgap electrical specifications**

| Characteristic                 | Symbol           | Min | Typ  | Max | Unit |
|--------------------------------|------------------|-----|------|-----|------|
| Reference Voltage (after trim) | $V_{\text{REF}}$ | —   | 1.21 | —   | V    |

## 9.3 Clock modules

### 9.3.1 External clock operation timing

Parameters listed are guaranteed by design.

**Table 19. External clock operation timing requirements**

| Characteristic                                              | Symbol            | Min                 | Typ | Max                | Unit |
|-------------------------------------------------------------|-------------------|---------------------|-----|--------------------|------|
| Frequency of operation (external clock driver) <sup>1</sup> | $f_{\text{osc}}$  | —                   | —   | 50                 | MHz  |
| Clock pulse width <sup>2</sup>                              | $t_{\text{PW}}$   | 8                   |     |                    | ns   |
| External clock input rise time <sup>3</sup>                 | $t_{\text{rise}}$ | —                   | —   | 1                  | ns   |
| External clock input fall time <sup>4</sup>                 | $t_{\text{fall}}$ | —                   | —   | 1                  | ns   |
| Input high voltage overdrive by an external clock           | $V_{\text{ih}}$   | $0.85V_{\text{DD}}$ | —   | —                  | V    |
| Input low voltage overdrive by an external clock            | $V_{\text{il}}$   | —                   | —   | $0.3V_{\text{DD}}$ | V    |

1. See Figure 7 for detail on using the recommended connection of an external clock driver.
2. The chip may not function if the high or low pulse width is smaller than 6.25 ns.
3. External clock input rise time is measured from 10% to 90%.
4. External clock input fall time is measured from 90% to 10%.

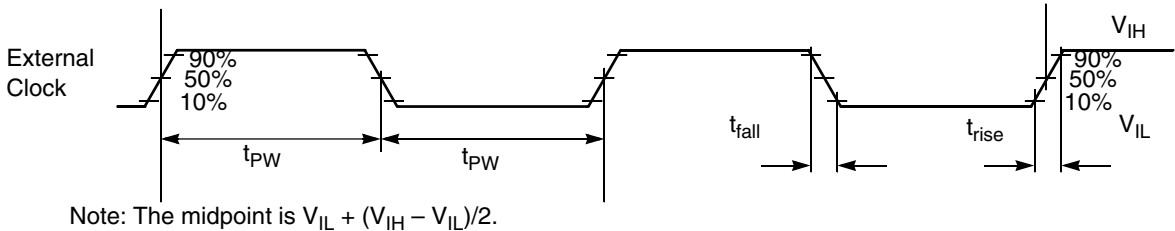


Figure 7. External clock timing

### 9.3.2 Phase-Locked Loop timing

Table 20. Phase-Locked Loop timing

| Characteristic                             | Symbol     | Min  | Typ | Max  | Unit    |
|--------------------------------------------|------------|------|-----|------|---------|
| PLL input reference frequency <sup>1</sup> | $f_{ref}$  | 8    | 8   | 16   | MHz     |
| PLL output frequency <sup>2</sup>          | $f_{op}$   | 240  | —   | 400  | MHz     |
| PLL lock time <sup>3</sup>                 | $t_{pils}$ | 35.5 |     | 73.2 | $\mu s$ |
| Allowed Duty Cycle of input reference      | $t_{dc}$   | 40   | 50  | 60   | %       |

1. An externally supplied reference clock should be as free as possible from any phase jitter for the PLL to work correctly. The PLL is optimized for 8 MHz input.
2. The frequency of the core system clock cannot exceed 100 MHz. If the NanoEdge PWM is available, the PLL output must be set to 400 MHz.
3. This is the time required *after the PLL is enabled* to ensure reliable operation.

### 9.3.3 External crystal or resonator requirement

Table 21. Crystal or resonator requirement

| Characteristic         | Symbol     | Min | Typ | Max | Unit |
|------------------------|------------|-----|-----|-----|------|
| Frequency of operation | $f_{XOSC}$ | 4   | 8   | 16  | MHz  |

## 9.3.4 Relaxation oscillator timing

**Table 22. Relaxation oscillator electrical specifications**

| Characteristic                       | Symbol | Min   | Typ     | Max   | Unit |
|--------------------------------------|--------|-------|---------|-------|------|
| 8 MHz Output Frequency <sup>1</sup>  |        | 7.84  | 8       | 8.16  | MHz  |
| RUN Mode                             |        | 7.76  | 8       | 8.24  |      |
| • 0°C to 105°C                       |        |       |         |       |      |
| • -40°C to 105°C                     |        | 266.8 | 402     | 554.3 | kHz  |
| Standby Mode (IRC trimmed @ 8 MHz)   |        |       |         |       |      |
| • -40°C to 105°C                     |        |       |         |       |      |
| 8 MHz Frequency Variation            |        |       |         |       |      |
| RUN Mode                             |        |       | +/- 1.5 | +/-2  | %    |
| Due to temperature                   |        |       | +/- 1.5 | +/-3  |      |
| • 0°C to 105°C                       |        |       |         |       |      |
| • -40°C to 105°C                     |        |       |         |       |      |
| 32 kHz Output Frequency <sup>2</sup> |        | 30.1  | 32      | 33.9  | kHz  |
| RUN Mode                             |        |       |         |       |      |
| • -40°C to 105°C                     |        |       |         |       |      |
| 32 kHz Output Frequency Variation    |        |       |         |       |      |
| RUN Mode                             |        |       | +/-2.5  | +/-4  | %    |
| Due to temperature                   |        |       |         |       |      |
| • -40°C to 105°C                     |        |       |         |       |      |
| Stabilization Time                   | tstab  |       | 0.12    | 0.4   | μs   |
| • 8 MHz output <sup>3</sup>          |        |       | 14.4    | 16.2  |      |
| • 32 kHz output <sup>4</sup>         |        |       |         |       |      |
| Output Duty Cycle                    |        | 48    | 50      | 52    | %    |

1. Frequency after application of 8 MHz trim
2. Frequency after application of 32 kHz trim
3. Standby to run mode transition
4. Power down to run mode transition

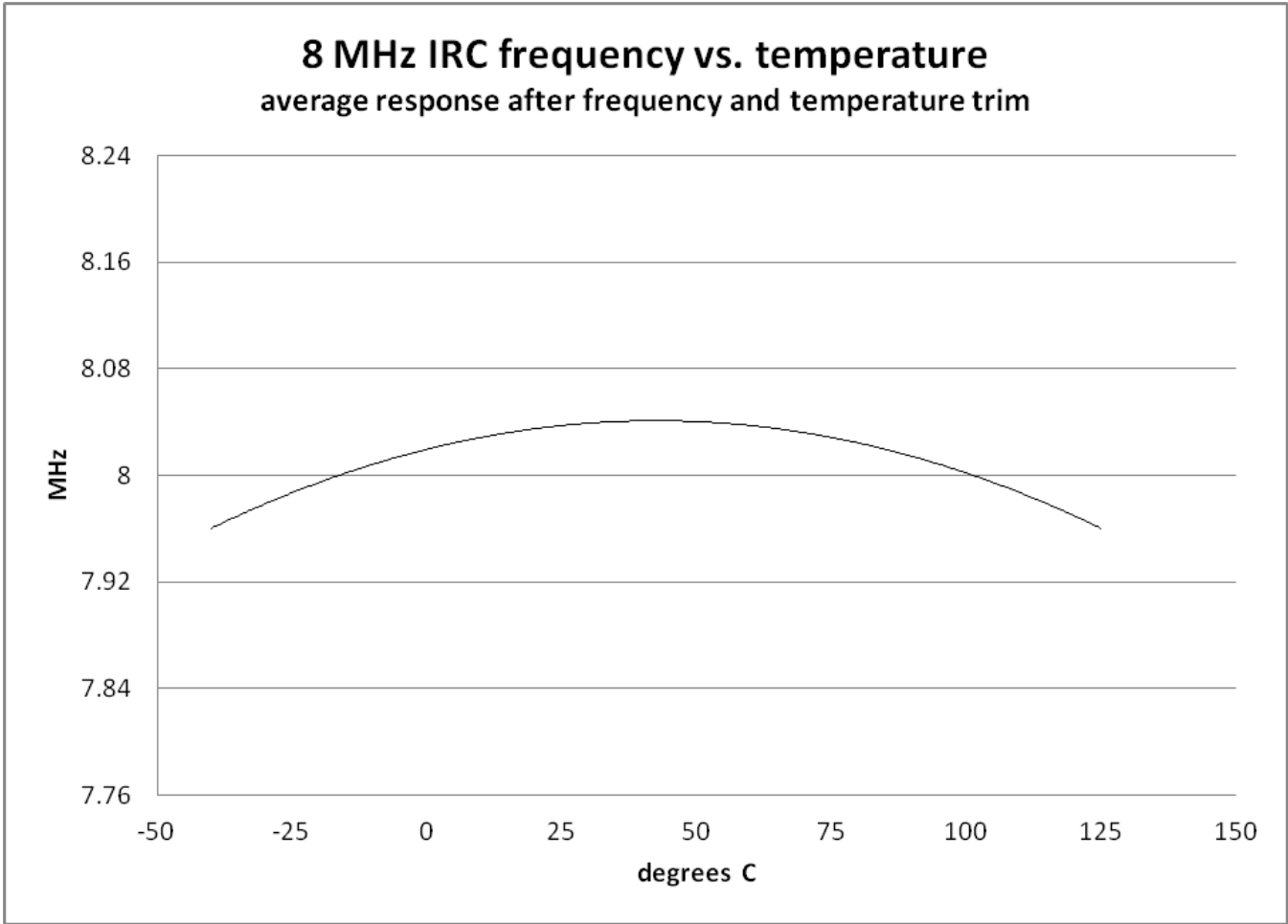


Figure 8. Relaxation oscillator temperature variation (typical) after trim (preliminary)

## 9.4 Memories and memory interfaces

### 9.4.1 Flash electrical specifications

This section describes the electrical characteristics of the flash memory module.

#### 9.4.1.1 Flash timing specifications — program and erase

The following specifications represent the amount of time the internal charge pumps are active and do not include command overhead.

Table 23. NVM program/erase timing specifications

| Symbol       | Description                        | Min. | Typ. | Max. | Unit    | Notes |
|--------------|------------------------------------|------|------|------|---------|-------|
| $t_{hvpgm4}$ | Longword Program high-voltage time | —    | 7.5  | 18   | $\mu s$ | —     |

Table continues on the next page...

**Table 23. NVM program/erase timing specifications (continued)**

| Symbol             | Description                              | Min. | Typ. | Max. | Unit | Notes |
|--------------------|------------------------------------------|------|------|------|------|-------|
| $t_{hversscr}$     | Sector Erase high-voltage time           | —    | 13   | 113  | ms   | 1     |
| $t_{hversblk32k}$  | Erase Block high-voltage time for 32 KB  | —    | 52   | 452  | ms   | 1     |
| $t_{hversblk256k}$ | Erase Block high-voltage time for 256 KB | —    | 104  | 904  | ms   | 1     |

1. Maximum time based on expectations at cycling end-of-life.

### 9.4.1.2 Flash timing specifications — commands

**Table 24. Flash command timing specifications**

| Symbol           | Description                                                    | Min. | Typ. | Max. | Unit | Notes |
|------------------|----------------------------------------------------------------|------|------|------|------|-------|
| $t_{rd1blk32k}$  | Read 1s Block execution time<br>• 32 KB data flash             | —    | —    | 0.5  | ms   | —     |
| $t_{rd1blk256k}$ | • 256 KB program flash                                         | —    | —    | 1.7  | ms   | —     |
| $t_{rd1sec1k}$   | Read 1s Section execution time (data flash sector)             | —    | —    | 60   | μs   | 1     |
| $t_{rd1sec2k}$   | Read 1s Section execution time (program flash sector)          | —    | —    | 60   | μs   | 1     |
| $t_{pgmchk}$     | Program Check execution time                                   | —    | —    | 45   | μs   | 1     |
| $t_{rdsrc}$      | Read Resource execution time                                   | —    | —    | 30   | μs   | 1     |
| $t_{pgm4}$       | Program Longword execution time                                | —    | 65   | 145  | μs   | —     |
| $t_{ersblk32k}$  | Erase Flash Block execution time<br>• 32 KB data flash         | —    | 55   | 465  | ms   | 2     |
| $t_{ersblk256k}$ | • 256 KB program flash                                         | —    | 122  | 985  | ms   | —     |
| $t_{ersscr}$     | Erase Flash Sector execution time                              | —    | 14   | 114  | ms   | 2     |
| $t_{pgmsec512p}$ | Program Section execution time<br>• 512 B program flash        | —    | 2.4  | —    | ms   | —     |
| $t_{pgmsec512d}$ | • 512 B data flash                                             | —    | 4.7  | —    | ms   | —     |
| $t_{pgmsec1kp}$  | • 1 KB program flash                                           | —    | 4.7  | —    | ms   | —     |
| $t_{pgmsec1kd}$  | • 1 KB data flash                                              | —    | 9.3  | —    | ms   | —     |
| $t_{rd1all}$     | Read 1s All Blocks execution time                              | —    | —    | 1.8  | ms   | —     |
| $t_{rdonce}$     | Read Once execution time                                       | —    | —    | 25   | μs   | 1     |
| $t_{pgmonce}$    | Program Once execution time                                    | —    | 65   | —    | μs   | —     |
| $t_{ersall}$     | Erase All Blocks execution time                                | —    | 175  | 1500 | ms   | 2     |
| $t_{vfykey}$     | Verify Backdoor Access Key execution time                      | —    | —    | 30   | μs   | 1     |
| $t_{pgmpart32k}$ | Program Partition for EEPROM execution time<br>• 32 KB FlexNVM | —    | 70   | —    | ms   | —     |

Table continues on the next page...

**Table 24. Flash command timing specifications (continued)**

| Symbol                                         | Description                                              | Min. | Typ. | Max. | Unit          | Notes |
|------------------------------------------------|----------------------------------------------------------|------|------|------|---------------|-------|
| $t_{\text{setramff}}$                          | Set FlexRAM Function execution time:                     | —    | 50   | —    | $\mu\text{s}$ | —     |
| $t_{\text{setram8k}}$                          | • Control Code 0xFF                                      | —    | 0.3  | 0.5  | ms            | —     |
| $t_{\text{setram32k}}$                         | • 8 KB EEPROM backup                                     | —    | 0.7  | 1.0  | ms            | —     |
|                                                | • 32 KB EEPROM backup                                    |      |      |      |               |       |
| Byte-write to FlexRAM for EEPROM operation     |                                                          |      |      |      |               |       |
| $t_{\text{eewr8bers}}$                         | Byte-write to erased FlexRAM location execution time     | —    | 175  | 260  | $\mu\text{s}$ | 3     |
| $t_{\text{eewr8b8k}}$                          | Byte-write to FlexRAM execution time:                    | —    | 340  | 1700 | $\mu\text{s}$ | —     |
| $t_{\text{eewr8b16k}}$                         | • 8 KB EEPROM backup                                     | —    | 385  | 1800 | $\mu\text{s}$ | —     |
| $t_{\text{eewr8b32k}}$                         | • 16 KB EEPROM backup                                    | —    | 475  | 2000 | $\mu\text{s}$ | —     |
|                                                | • 32 KB EEPROM backup                                    |      |      |      |               |       |
| Word-write to FlexRAM for EEPROM operation     |                                                          |      |      |      |               |       |
| $t_{\text{eewr16bers}}$                        | Word-write to erased FlexRAM location execution time     | —    | 175  | 260  | $\mu\text{s}$ | —     |
| $t_{\text{eewr16b8k}}$                         | Word-write to FlexRAM execution time:                    | —    | 340  | 1700 | $\mu\text{s}$ | —     |
| $t_{\text{eewr16b16k}}$                        | • 8 KB EEPROM backup                                     | —    | 385  | 1800 | $\mu\text{s}$ | —     |
| $t_{\text{eewr16b32k}}$                        | • 16 KB EEPROM backup                                    | —    | 475  | 2000 | $\mu\text{s}$ | —     |
|                                                | • 32 KB EEPROM backup                                    |      |      |      |               |       |
| Longword-write to FlexRAM for EEPROM operation |                                                          |      |      |      |               |       |
| $t_{\text{eewr32bers}}$                        | Longword-write to erased FlexRAM location execution time | —    | 360  | 540  | $\mu\text{s}$ | —     |
| $t_{\text{eewr32b8k}}$                         | Longword-write to FlexRAM execution time:                | —    | 545  | 1950 | $\mu\text{s}$ | —     |
| $t_{\text{eewr32b16k}}$                        | • 8 KB EEPROM backup                                     | —    | 630  | 2050 | $\mu\text{s}$ | —     |
| $t_{\text{eewr32b32k}}$                        | • 16 KB EEPROM backup                                    | —    | 810  | 2250 | $\mu\text{s}$ | —     |
|                                                | • 32 KB EEPROM backup                                    |      |      |      |               |       |

1. Assumes 25 MHz flash clock frequency.
2. Maximum times for erase parameters based on expectations at cycling end-of-life.
3. For byte-writes to an erased FlexRAM location, the aligned word containing the byte must be erased.

### 9.4.1.3 Flash high voltage current behaviors

**Table 25. Flash high voltage current behaviors**

| Symbol               | Description                                                           | Min. | Typ. | Max. | Unit |
|----------------------|-----------------------------------------------------------------------|------|------|------|------|
| $I_{\text{DD\_PGM}}$ | Average current adder during high voltage flash programming operation | —    | 2.5  | 6.0  | mA   |
| $I_{\text{DD\_ERS}}$ | Average current adder during high voltage flash erase operation       | —    | 1.5  | 4.0  | mA   |

## 9.4.1.4 Reliability specifications

**Table 26. NVM reliability specifications**

| Symbol                   | Description                                  | Min.   | Typ. <sup>1</sup> | Max. | Unit   | Notes |
|--------------------------|----------------------------------------------|--------|-------------------|------|--------|-------|
| Program Flash            |                                              |        |                   |      |        |       |
| $t_{\text{nvmretp10k}}$  | Data retention after up to 10 K cycles       | 5      | 50                | —    | years  | —     |
| $t_{\text{nvmretp1k}}$   | Data retention after up to 1 K cycles        | 20     | 100               | —    | years  | —     |
| $n_{\text{nvmcycp}}$     | Cycling endurance                            | 10 K   | 50 K              | —    | cycles | 2     |
| Data Flash               |                                              |        |                   |      |        |       |
| $t_{\text{nvmretd10k}}$  | Data retention after up to 10 K cycles       | 5      | 50                | —    | years  | —     |
| $t_{\text{nvmretd1k}}$   | Data retention after up to 1 K cycles        | 20     | 100               | —    | years  | —     |
| $n_{\text{nvmcycd}}$     | Cycling endurance                            | 10 K   | 50 K              | —    | cycles | 2     |
| FlexRAM as EEPROM        |                                              |        |                   |      |        |       |
| $t_{\text{nvmretee100}}$ | Data retention up to 100% of write endurance | 5      | 50                | —    | years  | —     |
| $t_{\text{nvmretee10}}$  | Data retention up to 10% of write endurance  | 20     | 100               | —    | years  | —     |
|                          | Write endurance                              |        |                   |      |        | 3     |
| $n_{\text{nvmwree16}}$   | • EEPROM backup to FlexRAM ratio = 16        | 35 K   | 175 K             | —    | writes |       |
| $n_{\text{nvmwree128}}$  | • EEPROM backup to FlexRAM ratio = 128       | 315 K  | 1.6 M             | —    | writes |       |
| $n_{\text{nvmwree512}}$  | • EEPROM backup to FlexRAM ratio = 512       | 1.27 M | 6.4 M             | —    | writes |       |
| $n_{\text{nvmwree4k}}$   | • EEPROM backup to FlexRAM ratio = 4096      | 10 M   | 50 M              | —    | writes |       |
| $n_{\text{nvmwree8k}}$   | • EEPROM backup to FlexRAM ratio = 8192      | 20 M   | 100 M             | —    | writes |       |

1. Typical data retention values are based on measured response accelerated at high temperature and derated to a constant 25 °C use profile. Engineering Bulletin EB618 does not apply to this technology. Typical endurance defined in Engineering Bulletin EB619.
2. Cycling endurance represents number of program/erase cycles at  $-40\text{ °C} \leq T_j \leq 125\text{ °C}$ .
3. Write endurance represents the number of writes to each FlexRAM location at  $-40\text{ °C} \leq T_j \leq 125\text{ °C}$  influenced by the cycling endurance of the FlexNVM (same value as data flash) and the allocated EEPROM backup. Minimum and typical values assume all byte-writes to FlexRAM.

## 9.5 Analog

### 9.5.1 12-bit cyclic Analog-to-Digital Converter (ADC) parameters

**Table 27. 12-bit ADC electrical specifications**

| Characteristic                          | Symbol              | Min               | Typ | Max               | Unit |
|-----------------------------------------|---------------------|-------------------|-----|-------------------|------|
| <b>Recommended Operating Conditions</b> |                     |                   |     |                   |      |
| Supply Voltage <sup>1</sup>             | $V_{\text{DDA}}$    | 2.7               | 3.3 | 3.6               | V    |
| Vrefh Supply Voltage <sup>2</sup>       | $V_{\text{refhx}}$  | 3.0               |     | $V_{\text{DDA}}$  | V    |
| ADC Conversion Clock <sup>3</sup>       | $f_{\text{ADCCLK}}$ | 0.6               |     | 20                | MHz  |
| Conversion Range                        | $R_{\text{AD}}$     | $V_{\text{REFL}}$ |     | $V_{\text{REFH}}$ | V    |

Table continues on the next page...

**Table 27. 12-bit ADC electrical specifications (continued)**

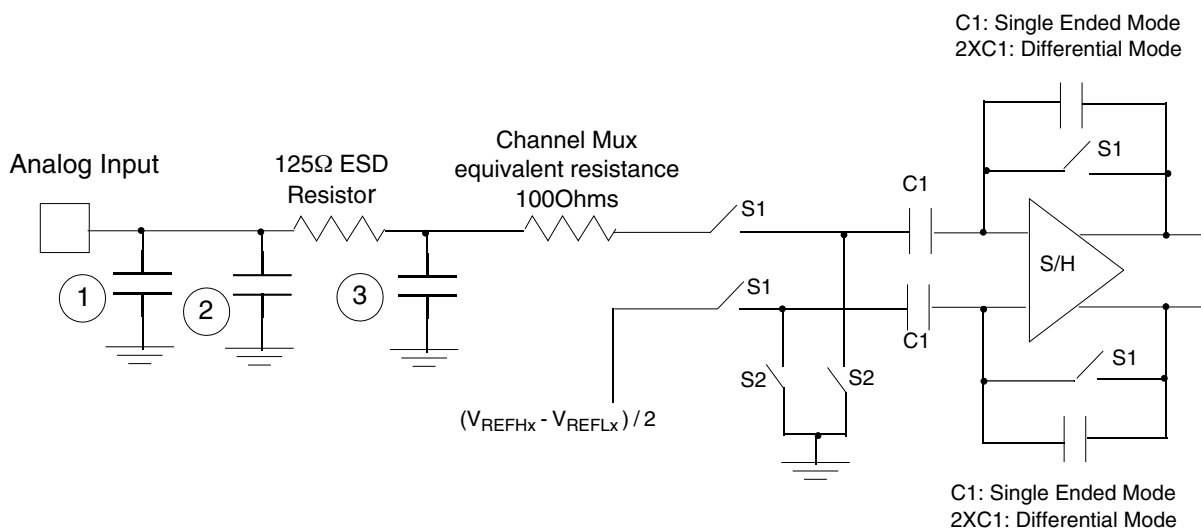
| Characteristic                                                                                                                                                                                                                                                       | Symbol                | Min               | Typ            | Max               | Unit             |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|-------------------|----------------|-------------------|------------------|
| Input Voltage Range                                                                                                                                                                                                                                                  | V <sub>ADIN</sub>     | V <sub>REFL</sub> |                | V <sub>REFH</sub> | V                |
| External Reference                                                                                                                                                                                                                                                   |                       | V <sub>SSA</sub>  |                | V <sub>DDA</sub>  |                  |
| Internal Reference                                                                                                                                                                                                                                                   |                       |                   |                |                   |                  |
| Timing and Power                                                                                                                                                                                                                                                     |                       |                   |                |                   |                  |
| Conversion Time                                                                                                                                                                                                                                                      | t <sub>ADC</sub>      |                   | 6              |                   | ADC Clock Cycles |
| Sample Time                                                                                                                                                                                                                                                          | t <sub>ADS</sub>      | 1                 |                | 5                 | ADC Clock Cycles |
| ADC Power-Up Time (from adc_pdn)                                                                                                                                                                                                                                     | t <sub>ADPU</sub>     |                   | 13             |                   | ADC Clock Cycles |
| ADC RUN Current (per ADC block) <ul style="list-style-type: none"><li>at 600 kHz ADC Clock, LP mode</li><li>≤ 8.33 MHz ADC Clock, 00 mode</li><li>≤ 12.5 MHz ADC Clock, 01 mode</li><li>≤ 16.67 MHz ADC Clock, 10 mode</li><li>≤ 20 MHz ADC Clock, 11 mode</li></ul> | I <sub>ADRUN</sub>    |                   | 1              |                   | mA               |
|                                                                                                                                                                                                                                                                      |                       |                   | 5.7            |                   |                  |
|                                                                                                                                                                                                                                                                      |                       |                   | 10.5           |                   |                  |
|                                                                                                                                                                                                                                                                      |                       |                   | 17.7           |                   |                  |
|                                                                                                                                                                                                                                                                      |                       |                   | 22.6           |                   |                  |
|                                                                                                                                                                                                                                                                      |                       |                   |                |                   |                  |
| ADC Powerdown Current (adc_pdn enabled)                                                                                                                                                                                                                              | I <sub>ADPWRDWN</sub> |                   | 0.02           |                   | μA               |
| V <sub>REFH</sub> Current                                                                                                                                                                                                                                            | I <sub>VREFH</sub>    |                   | 0.001          |                   | μA               |
| Accuracy (DC or Absolute)                                                                                                                                                                                                                                            |                       |                   |                |                   |                  |
| Integral non-Linearity <sup>4</sup>                                                                                                                                                                                                                                  | I <sub>NL</sub>       |                   | +/- 3          | +/- 5             | LSB <sup>5</sup> |
| Differential non-Linearity <sup>4</sup>                                                                                                                                                                                                                              | DNL                   |                   | +/- 0.6        | +/- 0.9           | LSB <sup>5</sup> |
| Monotonicity                                                                                                                                                                                                                                                         |                       |                   |                |                   |                  |
| Offset <sup>6</sup> <ul style="list-style-type: none"><li>1x gain mode</li><li>2x gain mode</li><li>4x gain mode</li></ul>                                                                                                                                           | V <sub>OFFSET</sub>   |                   |                | +/- 17            | LSB <sup>4</sup> |
|                                                                                                                                                                                                                                                                      |                       |                   |                | +/- 20            |                  |
|                                                                                                                                                                                                                                                                      |                       |                   |                | +/- 25            |                  |
|                                                                                                                                                                                                                                                                      |                       |                   |                |                   |                  |
| Gain Error (normalized)                                                                                                                                                                                                                                              | E <sub>GAIN</sub>     |                   | 0.994 to 1.004 | 0.990 to 1.010    |                  |
| AC Specifications <sup>7</sup>                                                                                                                                                                                                                                       |                       |                   |                |                   |                  |
| Signal to Noise Ratio                                                                                                                                                                                                                                                | SNR                   |                   | 59             |                   | dB               |
| Total Harmonic Distortion                                                                                                                                                                                                                                            | THD                   |                   | 64             |                   | dB               |
| Spurious Free Dynamic Range                                                                                                                                                                                                                                          | SFDR                  |                   | 65             |                   | dB               |
| Signal to Noise plus Distortion                                                                                                                                                                                                                                      | SINAD                 |                   | 59             |                   | dB               |
| Effective Number of Bits                                                                                                                                                                                                                                             | ENOB                  |                   | 9.5            |                   | bits             |
| ADC Inputs                                                                                                                                                                                                                                                           |                       |                   |                |                   |                  |
| Input Leakage Current                                                                                                                                                                                                                                                | I <sub>IN</sub>       |                   | 0              | +/-2              | μA               |
| Input Injection Current <sup>8</sup>                                                                                                                                                                                                                                 | I <sub>INJ</sub>      |                   |                | +/-3              | mA               |
| Input Capacitance                                                                                                                                                                                                                                                    | C <sub>ADI</sub>      |                   | -              |                   | pF               |
| Sampling Capacitor                                                                                                                                                                                                                                                   |                       |                   | -              |                   |                  |
| • 1x mode                                                                                                                                                                                                                                                            |                       |                   | 1.4            |                   |                  |
| • 2x mode                                                                                                                                                                                                                                                            |                       |                   | 2.8            |                   |                  |
| • 4x mode                                                                                                                                                                                                                                                            |                       |                   | 5.6            |                   |                  |

1. If the ADC's reference is from  $V_{DDA}$ : When  $V_{DDA}$  is below 3.0 V, then the ADC functions, but the ADC specifications are not guaranteed.
2. When the input is at the  $V_{refl}$  level, then the resulting output will be all zeros (hex 000), plus any error contribution due to offset and gain error. When the input is at the  $V_{refh}$  level, then the output will be all ones (hex FFF), minus any error contribution due to offset and gain error.
3. ADC clock duty cycle min/max is 45/55%
4.  $I_{NL}$  measured from  $V_{IN} = V_{REFL}$  to  $V_{IN} = V_{REFH}$
5. LSB = Least Significant Bit = 0.806 mV at 3.3 V  $V_{DDA}$ , x1 Gain Setting
6. Offset over the conversion range of 0025 to 4080, with internal/external reference.
7. Measured when converting a 1 kHz input Full Scale sine wave.
8. The current that can be *injected into* or *sourced from* an unselected ADC input, without affecting the performance of the ADC.

## 9.5.1.1 Equivalent circuit for ADC inputs

The following figure shows the ADC input circuit during sample and hold. S1 and S2 are always opened/closed at non-overlapping phases, and both S1 and S2 operate at the ADC clock frequency. The following equation gives equivalent input impedance when the input is selected.

$$\frac{1}{(\text{ADC ClockRate}) \times 1.4 \times 10^{-12}} + 100\text{ohm} + 125\text{ohm}$$



1. Parasitic capacitance due to package, pin-to-pin and pin-to-package base coupling = 1.8pF
2. Parasitic capacitance due to the chip bond pad, ESD protection devices and signal routing = 2.04pF
3. 8 pF noise damping capacitor
4. Sampling capacitor at the sample and hold circuit. Capacitor C1 (4.8pF) is normally disconnected from the input, and is only connected to the input at sampling time.
5. S1 and S2 switch phases are non-overlapping and operate at the ADC clock frequency

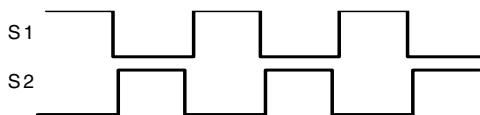


Figure 9. Equivalent circuit for A/D loading

## 9.5.2 16-bit SAR ADC electrical specifications

### 9.5.2.1 16-bit ADC operating conditions

Table 28. 16-bit ADC operating conditions

| Symbol           | Description                         | Conditions                                                                                                      | Min.      | Typ. <sup>1</sup> | Max.      | Unit       | Notes |
|------------------|-------------------------------------|-----------------------------------------------------------------------------------------------------------------|-----------|-------------------|-----------|------------|-------|
| $V_{DDA}$        | Supply voltage                      | Absolute                                                                                                        | 2.7       | —                 | 3.6       | V          | —     |
| $\Delta V_{DDA}$ | Supply voltage                      | Delta to $V_{DD}$ ( $V_{DD} - V_{DDA}$ )                                                                        | -100      | 0                 | +100      | mV         | 2     |
| $\Delta V_{SSA}$ | Ground voltage                      | Delta to $V_{SS}$ ( $V_{SS} - V_{SSA}$ )                                                                        | -100      | 0                 | +100      | mV         | 2     |
| $V_{REFH}$       | ADC reference voltage high          | Absolute                                                                                                        | $V_{DDA}$ | $V_{DDA}$         | $V_{DDA}$ | V          | 3     |
| $V_{REFL}$       | ADC reference voltage low           | Absolute                                                                                                        | $V_{SSA}$ | $V_{SSA}$         | $V_{SSA}$ | V          | 4     |
| $V_{ADIN}$       | Input voltage                       |                                                                                                                 | $V_{SSA}$ | —                 | $V_{DDA}$ | V          | —     |
| $C_{ADIN}$       | Input capacitance                   | <ul style="list-style-type: none"> <li>16-bit mode</li> <li>8-bit / 10-bit / 12-bit modes</li> </ul>            | —         | 8                 | 10        | pF         | —     |
| $R_{ADIN}$       | Input series resistance             |                                                                                                                 | —         | 2                 | 5         | k $\Omega$ | —     |
| $R_{AS}$         | Analog source resistance (external) | 12-bit modes<br>$f_{ADCK} < 4$ MHz                                                                              | —         | —                 | 5         | k $\Omega$ | 5     |
| $f_{ADCK}$       | ADC conversion clock frequency      | $\leq 12$ -bit mode                                                                                             | 1.0       | —                 | 18.0      | MHz        | 6     |
| $f_{ADCK}$       | ADC conversion clock frequency      | 16-bit mode                                                                                                     | 2.0       | —                 | 12.0      | MHz        | 6     |
| $C_{rate}$       | ADC conversion rate                 | $\leq 12$ -bit modes<br>No ADC hardware averaging<br>Continuous conversions enabled, subsequent conversion time | 20.000    | —                 | 818.330   | Ksps       | 7     |
| $C_{rate}$       | ADC conversion rate                 | 16-bit mode<br>No ADC hardware averaging<br>Continuous conversions enabled, subsequent conversion time          | 37.037    | —                 | 461.467   | Ksps       | 7     |

1. Typical values assume  $V_{DDA} = 3.0$  V, Temp = 25 °C,  $f_{ADCK} = 1.0$  MHz, unless otherwise stated. Typical values are for reference only, and are not tested in production.
2. DC potential difference.

## System modules

3.  $V_{REFH}$  is internally tied to  $V_{DDA}$ .
4.  $V_{REFL}$  is internally tied to  $V_{SSA}$ .
5. This resistance is external to MCU. To achieve the best results, the analog source resistance must be kept as low as possible. The results in this data sheet were derived from a system that had  $< 8 \Omega$  analog source resistance. The  $R_{AS}/C_{AS}$  time constant should be kept to  $< 1$  ns.
6. To use the maximum ADC conversion clock frequency, CFG2[ADHSC] must be set and CFG1[ADLPC] must be clear.
7. For guidelines and examples of conversion rate calculation, download the [ADC calculator tool](#).

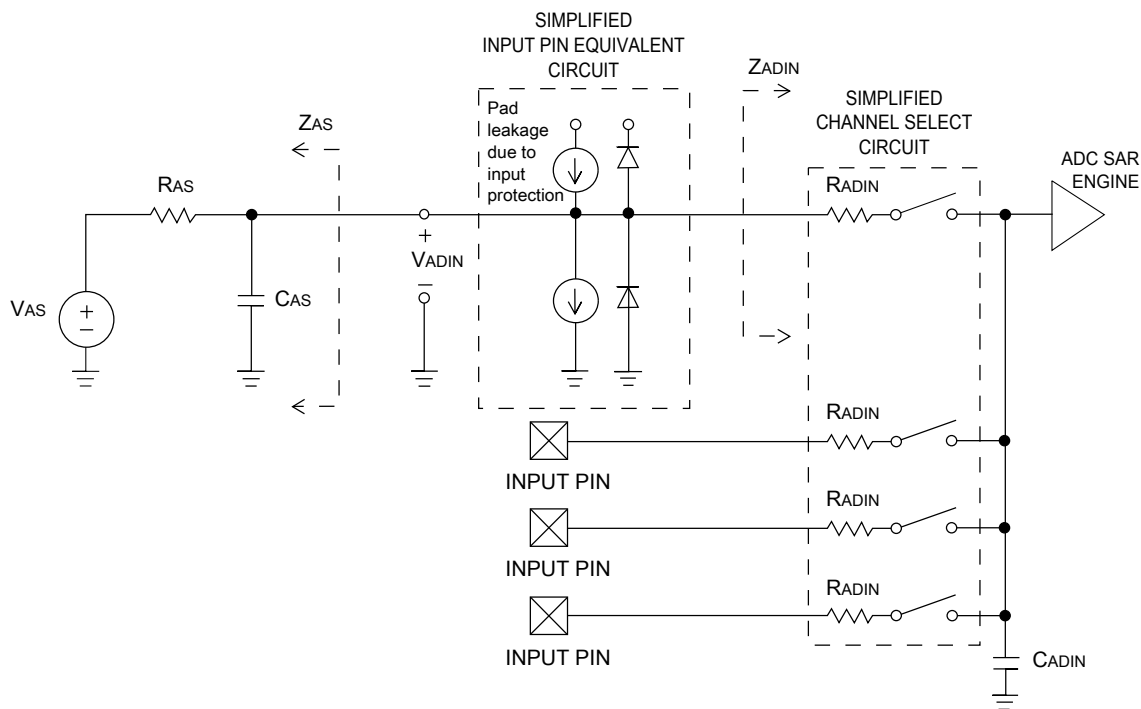


Figure 10. ADC input impedance equivalency diagram

### 9.5.2.2 16-bit ADC electrical characteristics

Table 29. 16-bit ADC characteristics ( $V_{REFH} = V_{DDA}$ ,  $V_{REFL} = V_{SSA}$ )

| Symbol               | Description                   | Conditions <sup>1</sup>                                                                                          | Min.        | Typ. <sup>2</sup>        | Max.                  | Unit             | Notes                                     |
|----------------------|-------------------------------|------------------------------------------------------------------------------------------------------------------|-------------|--------------------------|-----------------------|------------------|-------------------------------------------|
| I <sub>DDA_ADC</sub> | Supply current                |                                                                                                                  |             | —                        | 1.7                   | mA               | 3                                         |
| f <sub>ADACK</sub>   | ADC asynchronous clock source | • ADLPC=1, ADHSC=0                                                                                               | 1.2         | 2.4                      | 3.9                   | MHz              | t <sub>ADACK</sub> = 1/f <sub>ADACK</sub> |
|                      |                               | • ADLPC=1, ADHSC=1                                                                                               | 3.0         | 4.0                      | 7.3                   | MHz              |                                           |
|                      |                               | • ADLPC=0, ADHSC=0                                                                                               | 2.4         | 5.2                      | 6.1                   | MHz              |                                           |
|                      |                               | • ADLPC=0, ADHSC=1                                                                                               | 4.4         | 6.2                      | 9.5                   | MHz              |                                           |
|                      | Sample Time                   | See Reference Manual chapter for sample times                                                                    |             |                          |                       |                  |                                           |
| TUE                  | Total unadjusted error        | <ul style="list-style-type: none"><li>• 12-bit modes</li><li>• &lt;12-bit modes</li></ul>                        | —<br>—      | ±4<br>±1.4               | ±6.8<br>±2.1          | LSB <sup>4</sup> | 5                                         |
| DNL                  | Differential non-linearity    | <ul style="list-style-type: none"><li>• 16-bit modes</li><li>• 12-bit modes</li><li>• &lt;12-bit modes</li></ul> | —<br>—<br>— | -1 to +4<br>±0.7<br>±0.2 | —<br>—<br>-0.3 to 0.5 | LSB <sup>4</sup> | 5                                         |

Table continues on the next page...

**Table 29. 16-bit ADC characteristics ( $V_{REFH} = V_{DDA}$ ,  $V_{REFL} = V_{SSA}$ ) (continued)**

| Symbol              | Description                     | Conditions <sup>1</sup>                                                                                                                                                                           | Min.                              | Typ. <sup>2</sup> | Max.   | Unit             | Notes                                                                                              |
|---------------------|---------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------|-------------------|--------|------------------|----------------------------------------------------------------------------------------------------|
| INL                 | Integral non-linearity          | <ul style="list-style-type: none"> <li>16-bit modes</li> <li>12-bit modes</li> <li>&lt;12-bit modes</li> </ul>                                                                                    | —                                 | ±7.0              | —      | LSB <sup>4</sup> | 5                                                                                                  |
| E <sub>FS</sub>     | Full-scale error                | <ul style="list-style-type: none"> <li>12-bit modes</li> <li>&lt;12-bit modes</li> </ul>                                                                                                          | —                                 | -4                | -5.4   | LSB <sup>4</sup> | V <sub>ADIN</sub> = V <sub>DDA</sub><br>5                                                          |
| E <sub>Q</sub>      | Quantization error              | <ul style="list-style-type: none"> <li>16-bit modes</li> <li>12-bit modes</li> </ul>                                                                                                              | —                                 | -1 to 0           | —      | LSB <sup>4</sup> |                                                                                                    |
| ENOB                | Effective number of bits        | 16-bit single-ended mode <ul style="list-style-type: none"> <li>Avg=32</li> <li>Avg=4</li> </ul> 12-bit single-ended mode <ul style="list-style-type: none"> <li>Avg=32</li> <li>Avg=1</li> </ul> | 12.2<br>11.4                      | 13.9<br>13.1      | —<br>— | bits<br>bits     | 6                                                                                                  |
| SINAD               | Signal-to-noise plus distortion | See ENOB                                                                                                                                                                                          | 6.02 × ENOB + 1.76                |                   |        | dB               |                                                                                                    |
| THD                 | Total harmonic distortion       | 16-bit single-ended mode <ul style="list-style-type: none"> <li>Avg=32</li> </ul> 12-bit single-ended mode <ul style="list-style-type: none"> <li>Avg=32</li> </ul>                               | —                                 | -85               | —      | dB               | 7                                                                                                  |
| SFDR                | Spurious free dynamic range     | 16-bit single-ended mode <ul style="list-style-type: none"> <li>Avg=32</li> </ul> 12-bit single-ended mode <ul style="list-style-type: none"> <li>Avg=32</li> </ul>                               | 78                                | 90                | —      | dB               | 7                                                                                                  |
| E <sub>IL</sub>     | Input leakage error             |                                                                                                                                                                                                   | I <sub>in</sub> × R <sub>AS</sub> |                   |        | mV               | I <sub>in</sub> = leakage current<br>(refer to the device's voltage and current operating ratings) |
|                     | Temp sensor slope               | -40°C to 105°C                                                                                                                                                                                    | —                                 | 1.715             | —      | mV/°C            |                                                                                                    |
| V <sub>TEMP25</sub> | Temp sensor voltage             | 25°C                                                                                                                                                                                              | —                                 | 722               | —      | mV               | 8                                                                                                  |

1. All accuracy numbers assume the ADC is calibrated with  $V_{REFH} = V_{DDA}$

## System modules

- Typical values assume  $V_{DDA} = 3.0\text{ V}$ ,  $\text{Temp} = 25^\circ\text{C}$ ,  $f_{\text{ADCK}} = 2.0\text{ MHz}$ , unless otherwise stated. Typical values are for reference only, and are not tested in production.
- The ADC supply current depends on the ADC conversion clock speed, conversion rate and the ADLPC bit (low power). For lowest power operations: the ADLPC bit should be set, the HSC bit should be clear, with 1MHz ADC conversion clock speed.
- $1\text{ LSB} = (V_{\text{REFH}} - V_{\text{REFL}})/2^N$
- ADC conversion clock  $< 16\text{ MHz}$ , Max hardware averaging ( $\text{AVGE} = \%1$ ,  $\text{AVGS} = \%11$ )
- Input data is 100 Hz sine wave. ADC conversion clock  $< 12\text{ MHz}$ . When running 12-bit Cyclic ADC and 12-bit DAC, some degradation of ENOB (of 16-bit SAR ADC) may occur.
- Input data is 1 kHz sine wave. ADC conversion clock  $< 12\text{ MHz}$ .
- System Clock = 4 MHz, ADC Clock = 2 MHz, AVG = Max, Long Sampling = Max

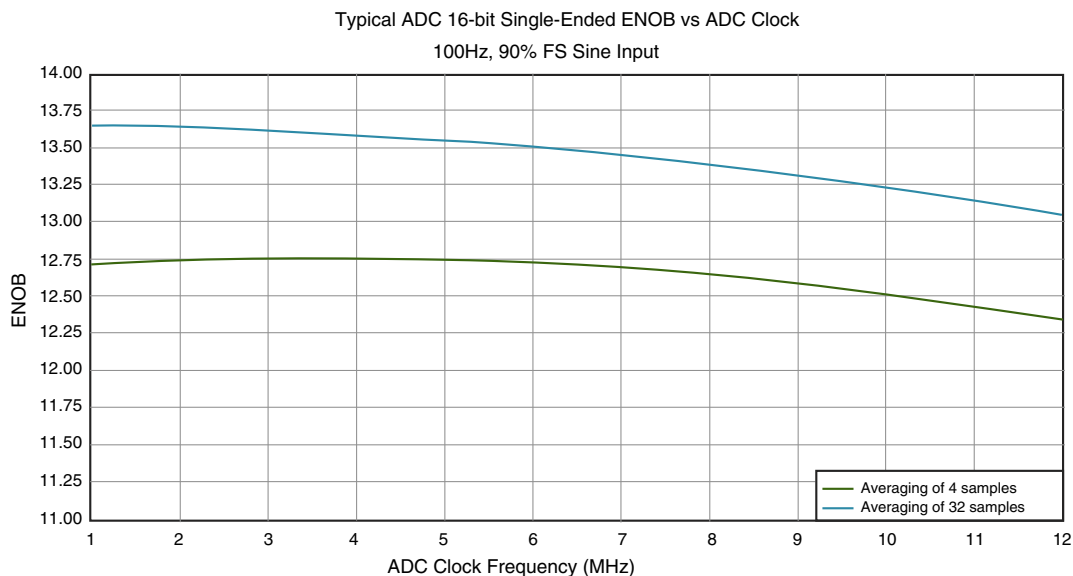


Figure 11. Typical ENOB vs. ADC\_CLK for 16-bit single-ended mode

## 9.5.3 12-bit Digital-to-Analog Converter (DAC) parameters

Table 30. DAC parameters

| Parameter                           | Conditions/Comments                                             | Symbol            | Min | Typ   | Max   | Unit             |
|-------------------------------------|-----------------------------------------------------------------|-------------------|-----|-------|-------|------------------|
| <b>DC Specifications</b>            |                                                                 |                   |     |       |       |                  |
| Resolution                          |                                                                 |                   | 12  | 12    | 12    | bits             |
| Settling time <sup>1</sup>          | At output load<br>RLD = 3 kΩ<br>CLD = 400 pF                    |                   | —   | 1     |       | μs               |
| Power-up time                       | Time from release of PWRDWN signal until DACOUT signal is valid | $t_{\text{DAPU}}$ | —   | —     | 11    | μs               |
| <b>Accuracy</b>                     |                                                                 |                   |     |       |       |                  |
| Integral non-linearity <sup>2</sup> | Range of input digital words:<br>410 to 3891 (\$19A - \$F33)    | INL               | —   | +/- 3 | +/- 4 | LSB <sup>3</sup> |

Table continues on the next page...

**Table 30. DAC parameters (continued)**

| Parameter                               | Conditions/Comments                                         | Symbol              | Min                       | Typ     | Max                       | Unit             |
|-----------------------------------------|-------------------------------------------------------------|---------------------|---------------------------|---------|---------------------------|------------------|
| Differential non-linearity <sup>2</sup> | Range of input digital words: 410 to 3891 (\$19A - \$F33)   | DNL                 | —                         | +/- 0.8 | +/- 0.9                   | LSB <sup>3</sup> |
| Monotonicity                            | > 6 sigma monotonicity,<br>< 3.4 ppm non-monotonicity       |                     | guaranteed                |         |                           | —                |
| Offset error <sup>2</sup>               | Range of input digital words: 410 to 3891 (\$19A - \$F33)   | V <sub>OFFSET</sub> | —                         | +/- 25  | +/- 43                    | mV               |
| Gain error <sup>2</sup>                 | Range of input digital words: 410 to 3891 (\$19A - \$F33)   | E <sub>GAIN</sub>   | —                         | +/- 0.5 | +/- 1.5                   | %                |
| <b>DAC Output</b>                       |                                                             |                     |                           |         |                           |                  |
| Output voltage range                    | Within 40 mV of either V <sub>SSA</sub> or V <sub>DDA</sub> | V <sub>OUT</sub>    | V <sub>SSA</sub> + 0.04 V | —       | V <sub>DDA</sub> - 0.04 V | V                |
| <b>AC Specifications</b>                |                                                             |                     |                           |         |                           |                  |
| Signal-to-noise ratio                   |                                                             | SNR                 | —                         | 85      | —                         | dB               |
| Spurious free dynamic range             |                                                             | SFDR                | —                         | -72     | —                         | dB               |
| Effective number of bits                |                                                             | ENOB                | —                         | 11      | —                         | bits             |

1. Settling time is swing range from V<sub>SSA</sub> to V<sub>DDA</sub>
2. No guaranteed specification within 5% of V<sub>DDA</sub> or V<sub>SSA</sub>
3. LSB = 0.806 mV

## 9.5.4 CMP and 6-bit DAC electrical specifications

**Table 31. Comparator and 6-bit DAC electrical specifications**

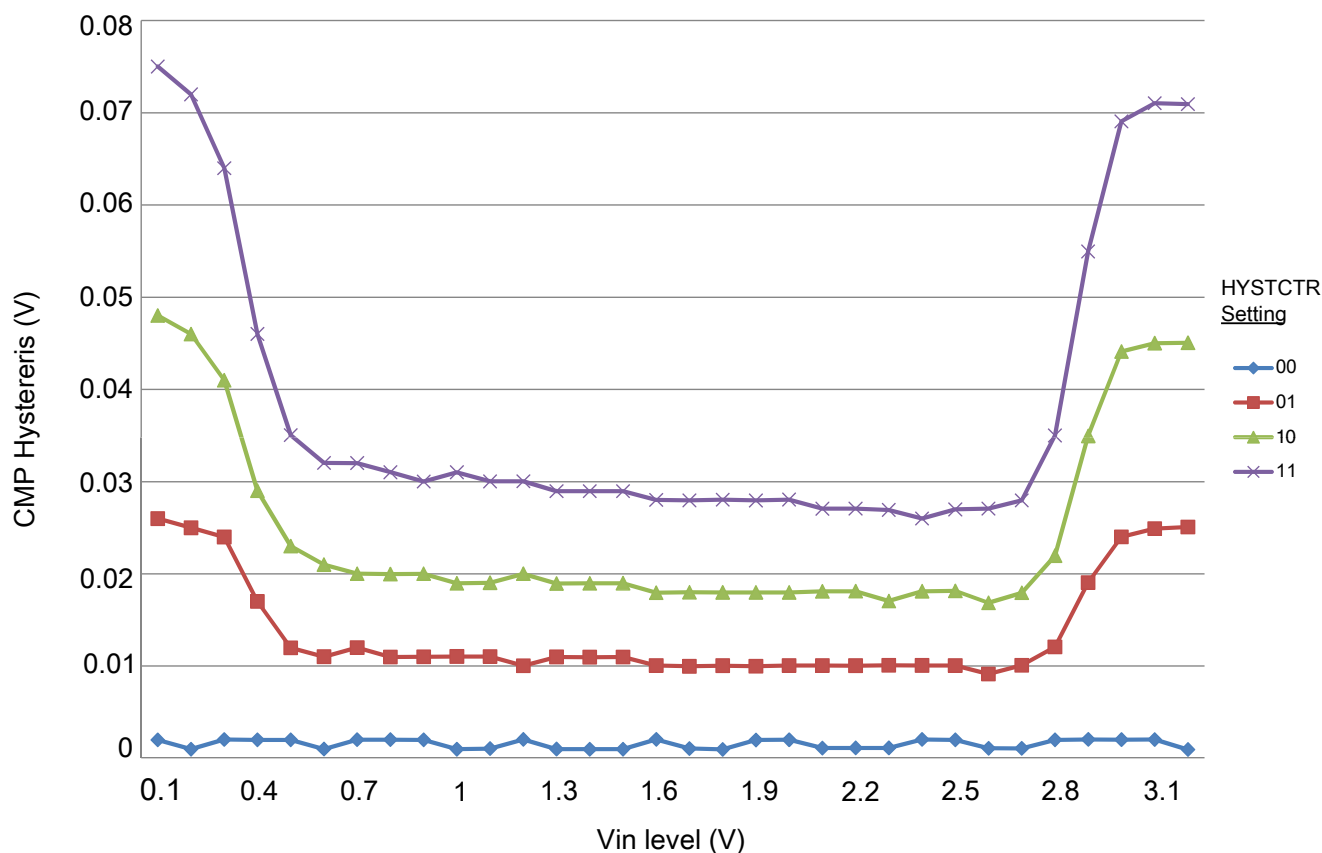
| Symbol             | Description                                                                                                                                                                                            | Min.                  | Typ. | Max.            | Unit |
|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|------|-----------------|------|
| V <sub>DD</sub>    | Supply voltage                                                                                                                                                                                         | 2.7                   | —    | 3.6             | V    |
| I <sub>DDHS</sub>  | Supply current, high-speed mode (EN=1, PMODE=1)                                                                                                                                                        | —                     | —    | 200             | μA   |
| I <sub>DDL</sub>   | Supply current, low-speed mode (EN=1, PMODE=0)                                                                                                                                                         | —                     | —    | 20              | μA   |
| V <sub>AIN</sub>   | Analog input voltage                                                                                                                                                                                   | V <sub>SS</sub> - 0.3 | —    | V <sub>DD</sub> | V    |
| V <sub>AIO</sub>   | Analog input offset voltage                                                                                                                                                                            | —                     | —    | 20              | mV   |
| V <sub>H</sub>     | Analog comparator hysteresis <sup>1</sup> <ul style="list-style-type: none"> <li>• CR0[HYSTCTR] = 00</li> <li>• CR0[HYSTCTR] = 01</li> <li>• CR0[HYSTCTR] = 10</li> <li>• CR0[HYSTCTR] = 11</li> </ul> | —                     | 5    | 13              | mV   |
|                    |                                                                                                                                                                                                        | —                     | 10   | 48              | mV   |
|                    |                                                                                                                                                                                                        | —                     | 20   | 105             | mV   |
|                    |                                                                                                                                                                                                        | —                     | 30   | 148             | mV   |
| V <sub>CMPOH</sub> | Output high                                                                                                                                                                                            | V <sub>DD</sub> - 0.5 | —    | —               | V    |
| V <sub>CMPOI</sub> | Output low                                                                                                                                                                                             | —                     | —    | 0.5             | V    |
| t <sub>DHS</sub>   | Propagation delay, high-speed mode (EN=1, PMODE=1) <sup>2</sup>                                                                                                                                        |                       | 50   |                 | ns   |

Table continues on the next page...

**Table 31. Comparator and 6-bit DAC electrical specifications (continued)**

| Symbol      | Description                                                                                                                                                            | Min.      | Typ. | Max.     | Unit             |
|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|------|----------|------------------|
| $t_{DLS}$   | Propagation delay, low-speed mode (EN=1, PMODE=0)                                                                                                                      |           | 250  |          | ns               |
|             | Analog comparator initialization delay <sup>3</sup>                                                                                                                    | —         | —    | 40       | $\mu$ s          |
| $I_{DAC6b}$ | 6-bit DAC current adder (enabled)                                                                                                                                      | —         | 7    | —        | $\mu$ A          |
|             | 6-bit DAC reference inputs: Vin1, Vin2<br>There are two reference input options selectable (via VRSEL control bit). The reference options must fall within this range. | $V_{DDA}$ | —    | $V_{DD}$ | V                |
| INL         | 6-bit DAC integral non-linearity                                                                                                                                       | −0.5      | —    | 0.5      | LSB <sup>4</sup> |
| DNL         | 6-bit DAC differential non-linearity                                                                                                                                   | −0.3      | —    | 0.3      | LSB              |

1. Typical hysteresis is measured with input voltage range limited to 0.6 to  $V_{DD}-0.6$ V.
2. Signal swing is 100 mV
3. Comparator initialization delay is defined as the time between software writes (to DACEN, VRSEL, PSEL, MSEL, VOSEL), to change the control inputs and for the comparator output to settle to a stable level.
4. 1 LSB =  $V_{reference}/64$


**Figure 12. Typical hysteresis vs. Vin level ( $V_{DD} = 3.3$  V, PMODE = 0)**

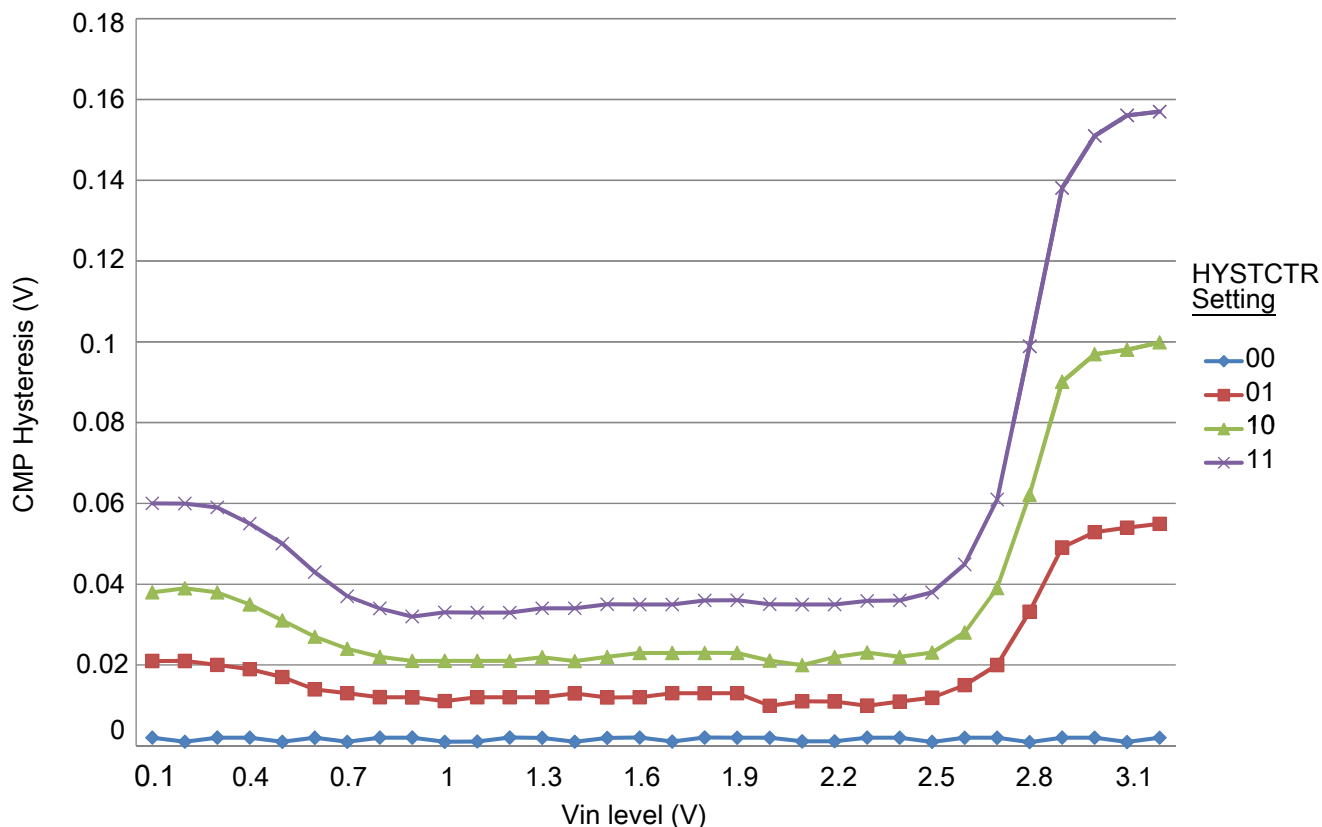


**Figure 13. Typical hysteresis vs. Vin level ( $V_{DD} = 3.3\text{ V}$ ,  $P\text{MODE} = 1$ )**

## 9.6 PWMs and timers

### 9.6.1 Enhanced NanoEdge PWM characteristics

**Table 32. NanoEdge PWM timing parameters**

| Characteristic                                             | Symbol   | Min | Typ | Max | Unit          |
|------------------------------------------------------------|----------|-----|-----|-----|---------------|
| PWM clock frequency                                        |          |     | 100 |     | MHz           |
| NanoEdge Placement (NEP) Step Size <sup>1, 2</sup>         | pwmp     |     | 312 |     | ps            |
| Delay for fault input activating to PWM output deactivated |          | 1   |     |     | ns            |
| Power-up Time <sup>3</sup>                                 | $t_{pu}$ |     | 25  |     | $\mu\text{s}$ |

1. Reference IPbus clock of 100 MHz in NanoEdge Placement mode.
2. Temperature and voltage variations do not affect NanoEdge Placement step size.
3. Powerdown to NanoEdge mode transition.

## 9.6.2 Quad Timer timing

Parameters listed are guaranteed by design.

**Table 33. Timer timing**

| Characteristic               | Symbol      | Min <sup>1</sup> | Max | Unit | See Figure                |
|------------------------------|-------------|------------------|-----|------|---------------------------|
| Timer input period           | $P_{IN}$    | $2T + 6$         | —   | ns   | <a href="#">Figure 14</a> |
| Timer input high/low period  | $P_{INHL}$  | $1T + 3$         | —   | ns   | <a href="#">Figure 14</a> |
| Timer output period          | $P_{OUT}$   | 20               | —   | ns   | <a href="#">Figure 14</a> |
| Timer output high/low period | $P_{OUTHL}$ | 10               | —   | ns   | <a href="#">Figure 14</a> |

1.  $T$  = clock cycle. For 100 MHz operation,  $T = 10$  ns.

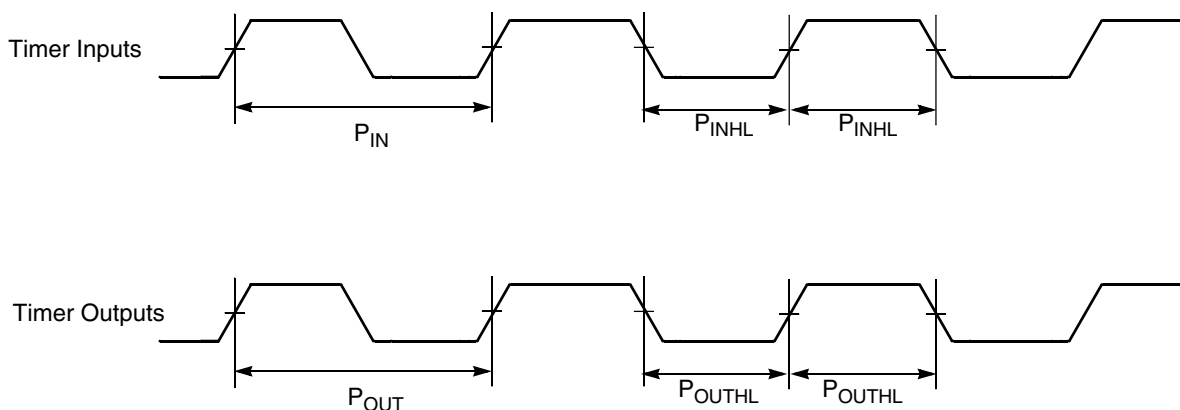


**Figure 14. Timer timing**

## 9.7 Communication interfaces

### 9.7.1 Queued Serial Peripheral Interface (SPI) timing

Parameters listed are guaranteed by design.

**Table 34. SPI timing**

| Characteristic | Symbol | Min | Max | Unit | See Figure                |
|----------------|--------|-----|-----|------|---------------------------|
| Cycle time     | $t_C$  | 35  | —   | ns   | <a href="#">Figure 15</a> |
| Master         |        | 35  | —   | ns   | <a href="#">Figure 16</a> |
| Slave          |        |     |     |      | <a href="#">Figure 17</a> |
|                |        |     |     |      | <a href="#">Figure 18</a> |

*Table continues on the next page...*

**Table 34. SPI timing (continued)**

| Characteristic                                              | Symbol    | Min  | Max | Unit | See Figure |
|-------------------------------------------------------------|-----------|------|-----|------|------------|
| Enable lead time                                            | $t_{ELD}$ | —    | —   | ns   | Figure 18  |
| Master                                                      |           | 17.5 | —   | ns   |            |
| Slave                                                       |           |      |     |      |            |
| Enable lag time                                             | $t_{ELG}$ | —    | —   | ns   | Figure 18  |
| Master                                                      |           | 17.5 | —   | ns   |            |
| Slave                                                       |           |      |     |      |            |
| Clock (SCK) high time                                       | $t_{CH}$  | 16.6 | —   | ns   | Figure 15  |
| Master                                                      |           | 16.6 | —   | ns   | Figure 16  |
| Slave                                                       |           |      |     |      | Figure 17  |
|                                                             |           |      |     |      | Figure 18  |
| Clock (SCK) low time                                        | $t_{CL}$  | 16.6 | —   | ns   | Figure 18  |
| Master                                                      |           | 16.6 | —   | ns   |            |
| Slave                                                       |           |      |     |      |            |
| Data set-up time required for inputs                        | $t_{DS}$  | 16.5 | —   | ns   | Figure 15  |
| Master                                                      |           | 1    | —   | ns   | Figure 16  |
| Slave                                                       |           |      |     |      | Figure 17  |
|                                                             |           |      |     |      | Figure 18  |
| Data hold time required for inputs                          | $t_{DH}$  | 1    | —   | ns   | Figure 15  |
| Master                                                      |           | 3    | —   | ns   | Figure 16  |
| Slave                                                       |           |      |     |      | Figure 17  |
|                                                             |           |      |     |      | Figure 18  |
| Access time (time to data active from high-impedance state) | $t_A$     | 5    | —   | ns   | Figure 18  |
| Slave                                                       |           |      |     |      |            |
| Disable time (hold time to high-impedance state)            | $t_D$     | 5    | —   | ns   | Figure 18  |
| Slave                                                       |           |      |     |      |            |
| Data valid for outputs                                      | $t_{DV}$  | —    | 5   | ns   | Figure 15  |
| Master                                                      |           | —    | 15  | ns   | Figure 16  |
| Slave (after enable edge)                                   |           |      |     |      | Figure 17  |
|                                                             |           |      |     |      | Figure 18  |
| Data invalid                                                | $t_{DI}$  | 0    | —   | ns   | Figure 15  |
| Master                                                      |           | 0    | —   | ns   | Figure 16  |
| Slave                                                       |           |      |     |      | Figure 17  |
|                                                             |           |      |     |      | Figure 18  |

Table continues on the next page...

**Table 34. SPI timing (continued)**

| Characteristic | Symbol | Min | Max | Unit | See Figure |
|----------------|--------|-----|-----|------|------------|
| Rise time      | $t_R$  | —   | 1   | ns   | Figure 15  |
| Master         |        | —   | 1   | ns   | Figure 16  |
| Slave          |        |     |     |      | Figure 17  |
| Fall time      | $t_F$  | —   | 1   | ns   | Figure 18  |
| Master         |        | —   | 1   | ns   | Figure 15  |
| Slave          |        |     |     |      | Figure 16  |
|                |        |     |     |      | Figure 17  |
|                |        |     |     |      | Figure 18  |

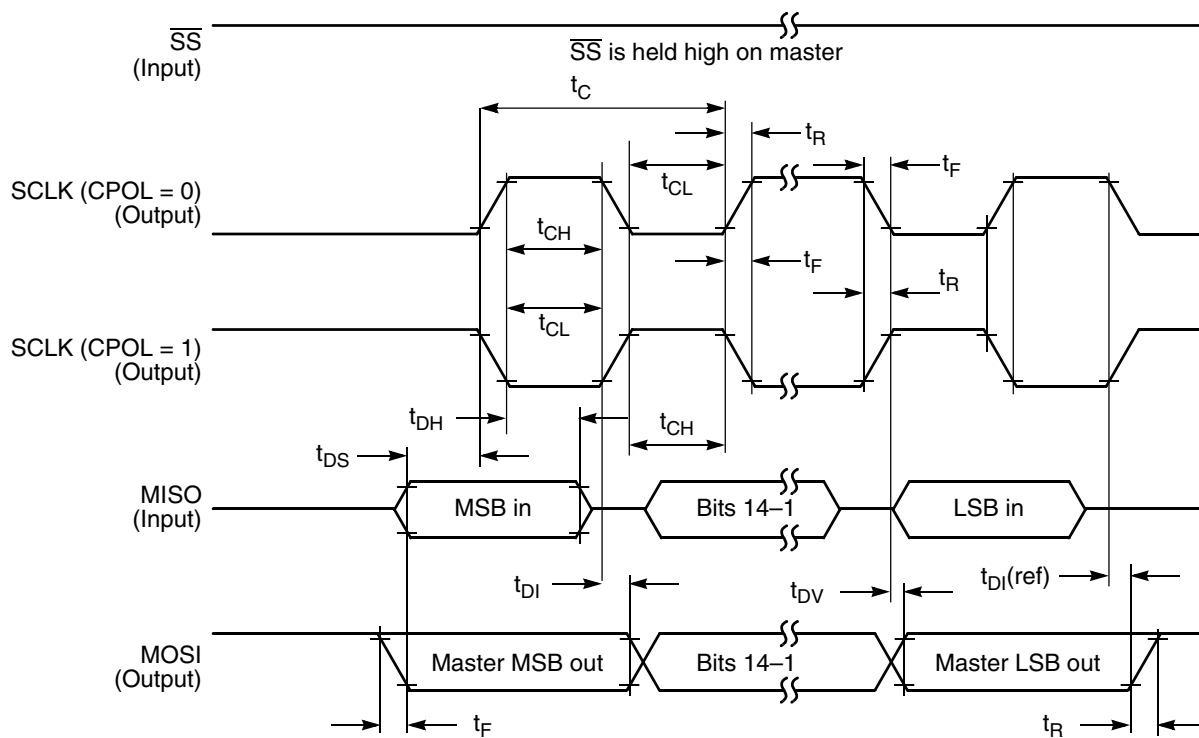


**Figure 15. SPI master timing (CPHA = 0)**

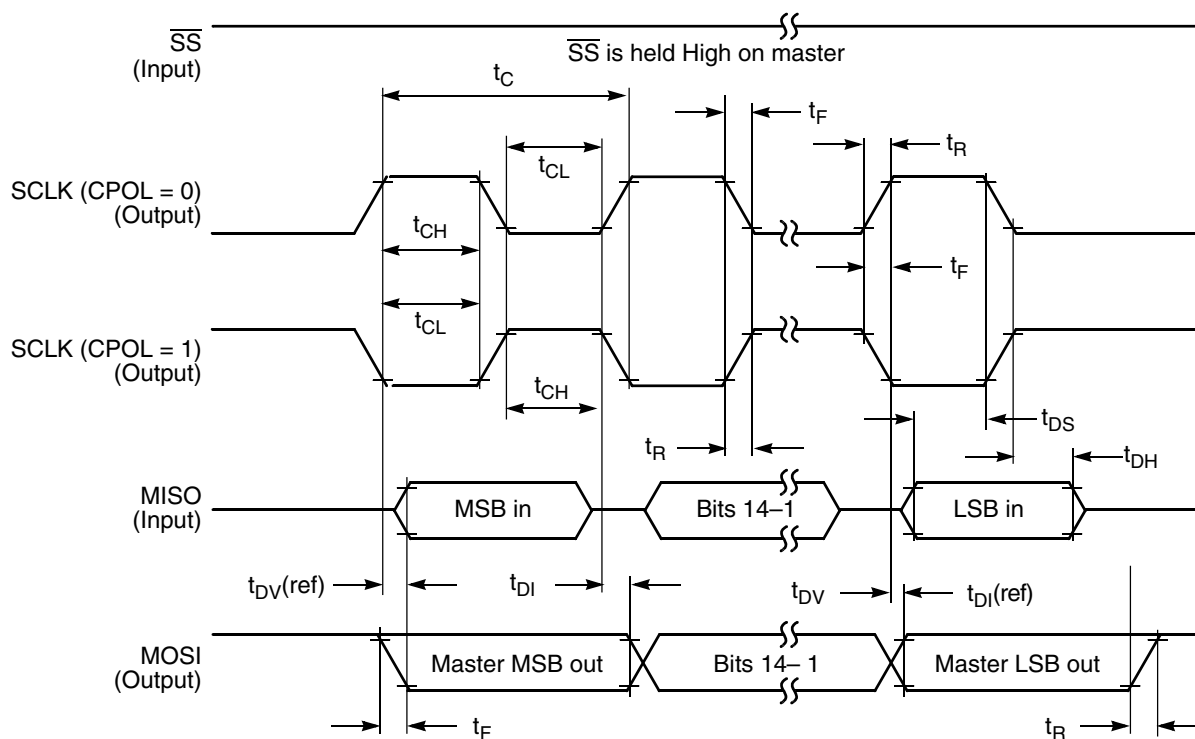


**Figure 16. SPI master timing (CPHA = 1)**

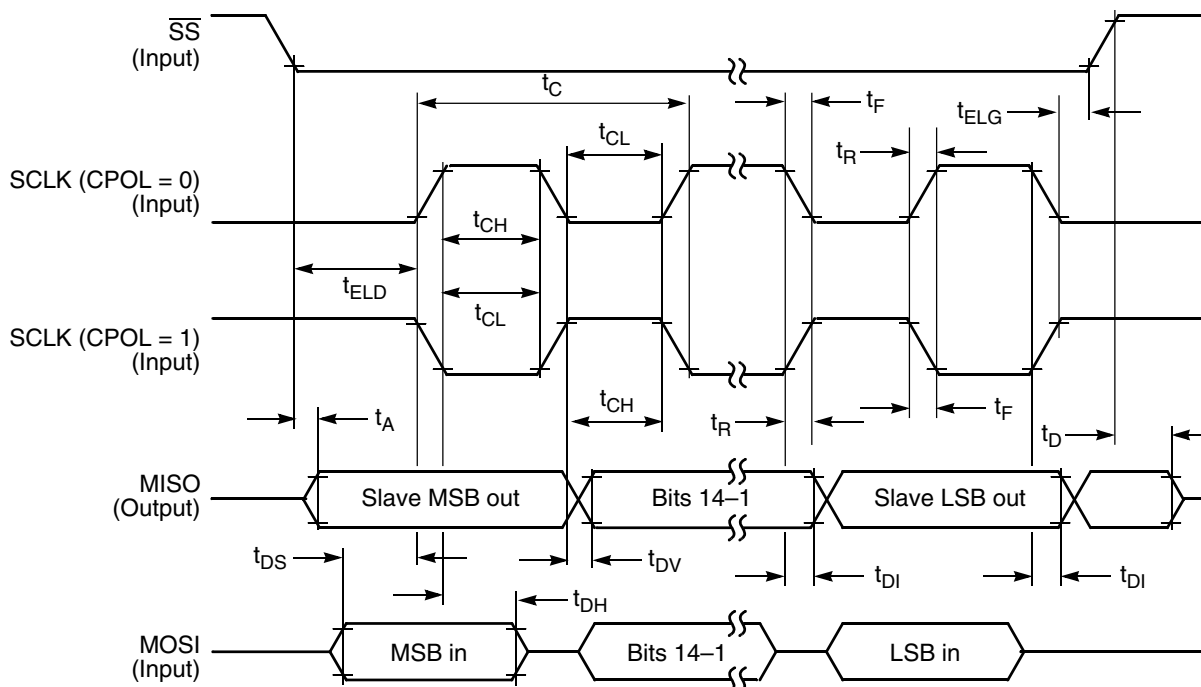


**Figure 17. SPI slave timing (CPHA = 0)**

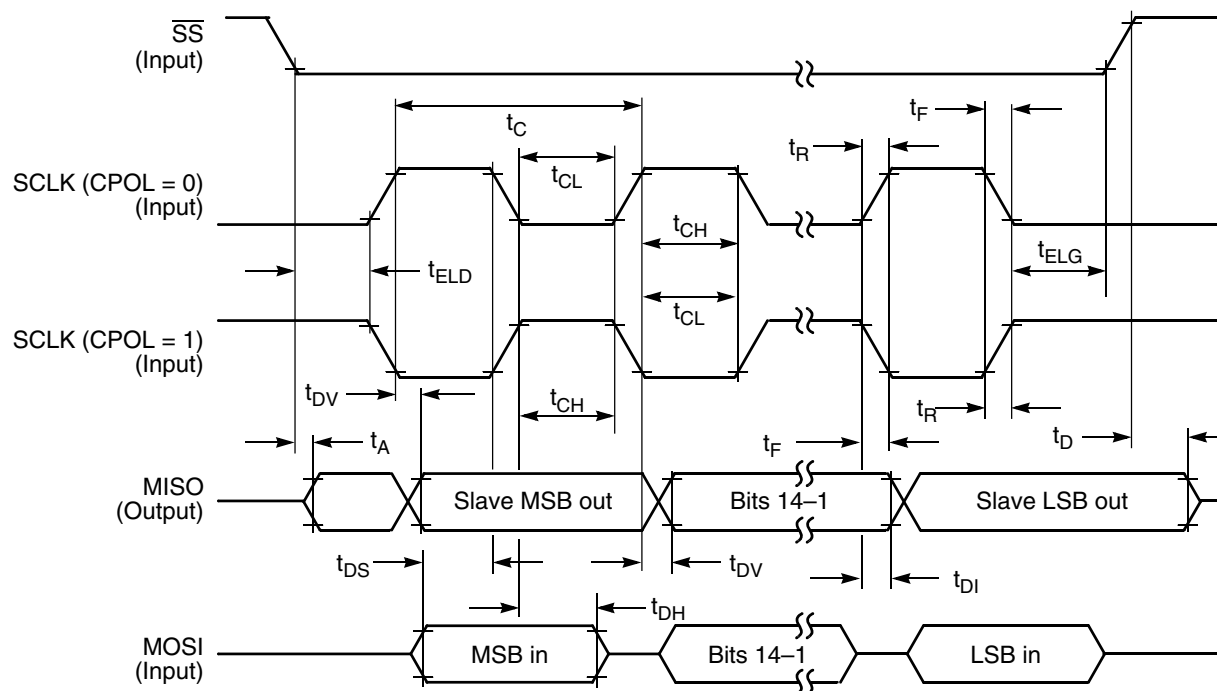


Figure 18. SPI slave timing (CPHA = 1)

## 9.7.2 Queued Serial Communication Interface (SCI) timing

Parameters listed are guaranteed by design.

Table 35. SCI timing

| Characteristic                                                                        | Symbol                   | Min      | Max                    | Unit                    | See Figure |
|---------------------------------------------------------------------------------------|--------------------------|----------|------------------------|-------------------------|------------|
| Baud rate <sup>1</sup>                                                                | BR                       | —        | (f <sub>MAX</sub> /16) | Mbit/s                  | —          |
| RXD pulse width                                                                       | RXD <sub>PW</sub>        | 0.965/BR | 1.04/BR                | ns                      | Figure 19  |
| TXD pulse width                                                                       | TXD <sub>PW</sub>        | 0.965/BR | 1.04/BR                | ns                      | Figure 20  |
| LIN Slave Mode                                                                        |                          |          |                        |                         |            |
| Deviation of slave node clock from nominal clock rate before synchronization          | F <sub>TOL_UNSYNCH</sub> | -14      | 14                     | %                       | —          |
| Deviation of slave node clock relative to the master node clock after synchronization | F <sub>TOL_SYNCH</sub>   | -2       | 2                      | %                       | —          |
| Minimum break character length                                                        | T <sub>BREAK</sub>       | 13       | —                      | Master node bit periods | —          |
|                                                                                       |                          | 11       | —                      | Slave node bit periods  | —          |

1. f<sub>MAX</sub> is the frequency of operation of the SCI clock in MHz, which can be selected as the bus clock (max.200 MHz depending on part number) or 2x bus clock (max. 200 MHz) for the devices.

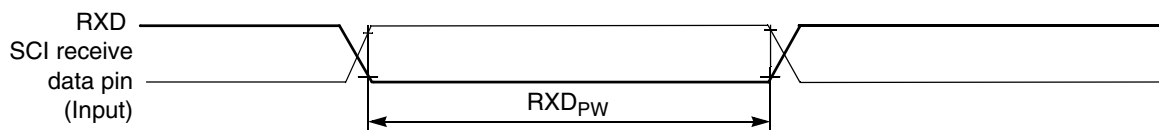


Figure 19. RXD pulse width

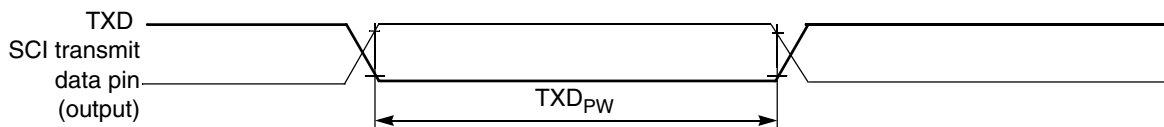


Figure 20. TXD pulse width

### 9.7.3 Freescale's Scalable Controller Area Network (FlexCAN)

Table 36. FlexCAN Timing Parameters

| Characteristic                     | Symbol              | Min | Max | Unit |
|------------------------------------|---------------------|-----|-----|------|
| Baud Rate                          | BR <sub>CAN</sub>   | —   | 1   | Mbps |
| CAN Wakeup dominant pulse filtered | T <sub>WAKEUP</sub> | —   | 2   | μs   |
| CAN Wakeup dominant pulse pass     | T <sub>WAKEUP</sub> | 5   | —   | μs   |

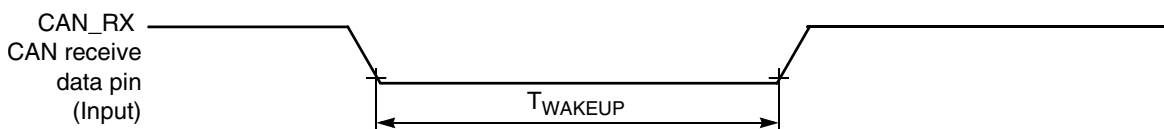


Figure 21. Bus Wake-up Detection

### 9.7.4 Inter-Integrated Circuit Interface (I<sup>2</sup>C) timing

Table 37. I<sup>2</sup>C timing

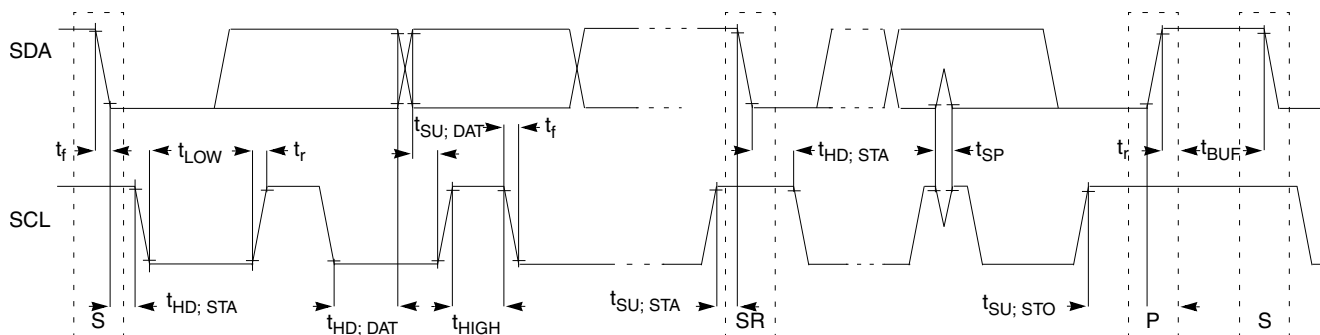
| Characteristic                                                                               | Symbol                | Standard Mode    |                   | Fast Mode                           |                  | Unit |
|----------------------------------------------------------------------------------------------|-----------------------|------------------|-------------------|-------------------------------------|------------------|------|
|                                                                                              |                       | Minimum          | Maximum           | Minimum                             | Maximum          |      |
| SCL Clock Frequency                                                                          | f <sub>SCL</sub>      | 0                | 100               | 0                                   | 400              | kHz  |
| Hold time (repeated) START condition. After this period, the first clock pulse is generated. | t <sub>HD</sub> ; STA | 4                | —                 | 0.6                                 | —                | μs   |
| LOW period of the SCL clock                                                                  | t <sub>LOW</sub>      | 4.7              | —                 | 1.3                                 | —                | μs   |
| HIGH period of the SCL clock                                                                 | t <sub>HIGH</sub>     | 4                | —                 | 0.6                                 | —                | μs   |
| Set-up time for a repeated START condition                                                   | t <sub>SU</sub> ; STA | 4.7              | —                 | 0.6                                 | —                | μs   |
| Data hold time for I <sup>2</sup> C bus devices                                              | t <sub>HD</sub> ; DAT | 0 <sup>1</sup>   | 3.45 <sup>2</sup> | 0 <sup>3</sup>                      | 0.9 <sup>1</sup> | μs   |
| Data set-up time                                                                             | t <sub>SU</sub> ; DAT | 250 <sup>4</sup> | —                 | 100 <sup>2, 5</sup>                 | —                | ns   |
| Rise time of SDA and SCL signals                                                             | t <sub>r</sub>        | —                | 1000              | 20 + 0.1C <sub>b</sub> <sup>6</sup> | 300              | ns   |

Table continues on the next page...

**Table 37. I<sup>2</sup>C timing (continued)**

| Characteristic                                                    | Symbol        | Standard Mode |         | Fast Mode       |         | Unit |
|-------------------------------------------------------------------|---------------|---------------|---------|-----------------|---------|------|
|                                                                   |               | Minimum       | Maximum | Minimum         | Maximum |      |
| Fall time of SDA and SCL signals                                  | $t_f$         | —             | 300     | $20 + 0.1C_b^5$ | 300     | ns   |
| Set-up time for STOP condition                                    | $t_{SU; STO}$ | 4             | —       | 0.6             | —       | μs   |
| Bus free time between STOP and START condition                    | $t_{BUF}$     | 4.7           | —       | 1.3             | —       | μs   |
| Pulse width of spikes that must be suppressed by the input filter | $t_{SP}$      | N/A           | N/A     | 0               | 50      | ns   |

1. The master mode I<sup>2</sup>C deasserts ACK of an address byte simultaneously with the falling edge of SCL. If no slaves acknowledge this address byte, then a negative hold time can result, depending on the edge rates of the SDA and SCL lines.
2. The maximum t<sub>HD; DAT</sub> must be met only if the device does not stretch the LOW period (t<sub>LOW</sub>) of the SCL signal.
3. Input signal Slew = 10 ns and Output Load = 50 pF
4. Set-up time in slave-transmitter mode is 1 IPBus clock period, if the TX FIFO is empty.
5. A Fast mode I<sup>2</sup>C bus device can be used in a Standard mode I<sup>2</sup>C bus system, but the requirement  $t_{SU; DAT} \geq 250$  ns must then be met. This is automatically the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, then it must output the next data bit to the SDA line  $t_{max} + t_{SU; DAT} = 1000 + 250 = 1250$  ns (according to the Standard mode I<sup>2</sup>C bus specification) before the SCL line is released.
6.  $C_b$  = total capacitance of the one bus line in pF.


**Figure 22. Timing definition for fast and standard mode devices on the I<sup>2</sup>C bus**

## 10 Design Considerations

### 10.1 Thermal design considerations

An estimate of the chip junction temperature (T<sub>J</sub>) can be obtained from the equation:

$$T_J = T_A + (R_{\Theta JA} \times P_D)$$

Where,

T<sub>A</sub> = Ambient temperature for the package (°C)

R<sub>ΘJA</sub> = Junction-to-ambient thermal resistance (°C/W)

$P_D$  = Power dissipation in the package (W)

The junction-to-ambient thermal resistance is an industry-standard value that provides a quick and easy estimation of thermal performance. Unfortunately, there are two values in common usage: the value determined on a single-layer board and the value obtained on a board with two planes. For packages such as the PBGA, these values can be different by a factor of two. Which  $T_J$  value is closer to the application depends on the power dissipated by other components on the board.

- The  $T_J$  value obtained on a single layer board is appropriate for a tightly packed printed circuit board.
- The  $T_J$  value obtained on a board with the internal planes is usually appropriate if the board has low-power dissipation and if the components are well separated.

When a heat sink is used, the thermal resistance is expressed as the sum of a junction-to-case thermal resistance and a case-to-ambient thermal resistance:

$$R_{\theta JA} = R_{\theta JC} + R_{\theta CA}$$

Where,

$R_{\theta JA}$  = Package junction-to-ambient thermal resistance ( $^{\circ}\text{C}/\text{W}$ )

$R_{\theta JC}$  = Package junction-to-case thermal resistance ( $^{\circ}\text{C}/\text{W}$ )

$R_{\theta CA}$  = Package case-to-ambient thermal resistance ( $^{\circ}\text{C}/\text{W}$ )

$R_{\theta JC}$  is device related and cannot be adjusted. You control the thermal environment to change the case to ambient thermal resistance,  $R_{\theta CA}$ . For instance, you can change the size of the heat sink, the air flow around the device, the interface material, the mounting arrangement on printed circuit board, or change the thermal dissipation on the printed circuit board surrounding the device.

**To determine the junction temperature of the device in the application when heat sinks are not used**, the thermal characterization parameter ( $\Psi_{JT}$ ) can be used to determine the junction temperature with a measurement of the temperature at the top center of the package case using the following equation:

$$T_J = T_T + (\Psi_{JT} \times P_D)$$

Where,

$T_T$  = Thermocouple temperature on top of package ( $^{\circ}\text{C}/\text{W}$ )

$\Psi_{JT}$  = thermal characterization parameter ( $^{\circ}\text{C}/\text{W}$ )

$P_D$  = Power dissipation in package (W)

The thermal characterization parameter is measured per JESD51–2 specification using a 40-gauge type T thermocouple epoxied to the top center of the package case. The thermocouple should be positioned so that the thermocouple junction rests on the package. A small amount of epoxy is placed over the thermocouple junction and over about 1 mm of wire extending from the junction. The thermocouple wire is placed flat against the package case to avoid measurement errors caused by cooling effects of the thermocouple wire.

**To determine the junction temperature of the device in the application when heat sinks are used**, the junction temperature is determined from a thermocouple inserted at the interface between the case of the package and the interface material. A clearance slot or hole is normally required in the heat sink. Minimizing the size of the clearance is important to minimize the change in thermal performance caused by removing part of the thermal interface to the heat sink. Because of the experimental difficulties with this technique, many engineers measure the heat sink temperature and then back-calculate the case temperature using a separate measurement of the thermal resistance of the interface. From this case temperature, the junction temperature is determined from the junction-to-case thermal resistance.

## 10.2 Electrical design considerations

### CAUTION

This device contains protective circuitry to guard against damage due to high static voltage or electrical fields. However, take normal precautions to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate voltage level.

Use the following list of considerations to assure correct operation of the device:

- Provide a low-impedance path from the board power supply to each  $V_{DD}$  pin on the device and from the board ground to each  $V_{SS}$  (GND) pin.
- The minimum bypass requirement is to place 0.01–0.1  $\mu\text{F}$  capacitors positioned as near as possible to the package supply pins. The recommended bypass configuration is to place one bypass capacitor on each of the  $V_{DD}/V_{SS}$  pairs, including  $V_{DDA}/V_{SSA}$ . Ceramic and tantalum capacitors tend to provide better tolerances.
- Ensure that capacitor leads and associated printed circuit traces that connect to the chip  $V_{DD}$  and  $V_{SS}$  (GND) pins are as short as possible.
- Bypass the  $V_{DD}$  and  $V_{SS}$  with approximately 100  $\mu\text{F}$ , plus the number of 0.1  $\mu\text{F}$  ceramic capacitors.
- PCB trace lengths should be minimal for high-frequency signals.

- Consider all device loads as well as parasitic capacitance due to PCB traces when calculating capacitance. This is especially critical in systems with higher capacitive loads that could create higher transient currents in the  $V_{DD}$  and  $V_{SS}$  circuits.
- Take special care to minimize noise levels on the  $V_{REF}$ ,  $V_{DDA}$ , and  $V_{SSA}$  pins.
- Using separate power planes for  $V_{DD}$  and  $V_{DDA}$  and separate ground planes for  $V_{SS}$  and  $V_{SSA}$  are recommended. Connect the separate analog and digital power and ground planes as near as possible to power supply outputs. If an analog circuit and digital circuit are powered by the same power supply, then connect a small inductor or ferrite bead in serial with  $V_{DDA}$ . Traces of  $V_{SS}$  and  $V_{SSA}$  should be shorted together.
- Physically separate analog components from noisy digital components by ground planes. Do not place an analog trace in parallel with digital traces. Place an analog ground trace around an analog signal trace to isolate it from digital traces.
- Because the flash memory is programmed through the JTAG/EOnCE port, SPI, SCI, or I<sup>2</sup>C, the designer should provide an interface to this port if in-circuit flash programming is desired.
- If desired, connect an external RC circuit to the  $\overline{RESET}$  pin. The resistor value should be in the range of 4.7 k $\Omega$ –10 k $\Omega$ ; the capacitor value should be in the range of 0.22  $\mu$ F–4.7  $\mu$ F.
- Configuring the  $\overline{RESET}$  pin to GPIO output in normal operation in a high-noise environment may help to improve the performance of noise transient immunity.
- Add a 2.2 k $\Omega$  external pullup on the TMS pin of the JTAG port to keep EOnCE in a restate during normal operation if JTAG converter is not present.
- During reset and after reset but before I/O initialization, all I/O pins are at tri-state.
- To eliminate PCB trace impedance effect, each ADC input should have a no less than 33 pF 10 $\Omega$  RC filter.

# 11 Obtaining package dimensions

Package dimensions are provided in package drawings.

To find a package drawing, go to [freescale.com](http://freescale.com) and perform a keyword search for the drawing's document number:

| Drawing for package | Document number to be used |
|---------------------|----------------------------|
| 64-pin LQFP         | 98ASS23234W                |
| 80-pin LQFP         | 98ASS23174W                |
| 100-pin LQFP        | 98ASS23308W                |

## 12 Pinout

### 12.1 Signal Multiplexing and Pin Assignments

This section shows the signals available on each package pin and the locations of these pins on the devices supported by this document. The SIM's GPS registers are responsible for selecting which ALT functionality is available on most pins.

#### NOTE

The RESETB pin is a 3.3 V pin only.

#### NOTE

If the GPIOC1 pin is used as GPIO, the XOSC should be powered down.

#### NOTE

PWMB signals—including PWMB\_2A, PWMB\_2B, and PWMB\_3X—are not available on the 64 LQFP package.

| 100 LQFP | 80 LQFP | 64 LQFP | Pin Name | Default | ALT0               | ALT1   | ALT2    | ALT3      |
|----------|---------|---------|----------|---------|--------------------|--------|---------|-----------|
| 1        | 1       | 1       | TCK      | TCK     | GPIOD2             |        |         |           |
| 2        | 2       | 2       | RESETB   | RESETB  | GPIOD4             |        |         |           |
| 3        | 3       | 3       | GPIOC0   | GPIOC0  | EXTAL              | CLKIN0 |         |           |
| 4        | 4       | 4       | GPIOC1   | GPIOC1  | XTAL               |        |         |           |
| 5        | 5       | 5       | GPIOC2   | GPIOC2  | TXD0               | TB0    | XB_IN2  | CLK00     |
| 6        | 6       | 6       | GPIOF8   | GPIOF8  | RXD0               | TB1    | CMPD_O  |           |
| 7        | —       | —       | VDD      | VDD     |                    |        |         |           |
| 8        | —       | —       | VSS      | VSS     |                    |        |         |           |
| 9        | 7       | —       | GPIOD6   | GPIOD6  | TXD2               | XB_IN4 | XB_OUT8 |           |
| 10       | 8       | —       | GPIOD5   | GPIOD5  | RXD2               | XB_IN5 | XB_OUT9 |           |
| 11       | 9       | 7       | GPIOC3   | GPIOC3  | TA0                | CMPA_O | RXD0    | CLKIN1    |
| 12       | 10      | 8       | GPIOC4   | GPIOC4  | TA1                | CMPB_O | XB_IN8  | EWM_OUT_B |
| 13       | —       | —       | GPIOA10  | GPIOA10 | ANC18&CMPD_IN3     |        |         |           |
| 14       | —       | —       | GPIOA9   | GPIOA9  | ANC17&CMPD_IN2     |        |         |           |
| 15       | 11      | —       | VSS      | VSS     |                    |        |         |           |
| 16       | 12      | —       | VCAP     | VCAP    |                    |        |         |           |
| 17       | 13      | 9       | GPIOA7   | GPIOA7  | ANA7&ANC11         |        |         |           |
| 18       | —       | —       | GPIOA8   | GPIOA8  | ANC16&CMPD_IN1     |        |         |           |
| 19       | 14      | 10      | GPIOA6   | GPIOA6  | ANA6&ANC10         |        |         |           |
| 20       | 15      | 11      | GPIOA5   | GPIOA5  | ANA5&ANC9          |        |         |           |
| 21       | 16      | 12      | GPIOA4   | GPIOA4  | ANA4&ANC8&CMPD_IN0 |        |         |           |

| 100<br>LQFP | 80<br>LQFP | 64<br>LQFP | Pin Name | Default | ALT0                 | ALT1        | ALT2        | ALT3     |
|-------------|------------|------------|----------|---------|----------------------|-------------|-------------|----------|
| 22          | 17         | 13         | GPIOA0   | GPIOA0  | ANA0&CMPA_IN3        | CMPC_O      |             |          |
| 23          | 18         | 14         | GPIOA1   | GPIOA1  | ANA1&CMPA_IN0        |             |             |          |
| 24          | 19         | 15         | GPIOA2   | GPIOA2  | ANA2&VREFHA&CMPA_IN1 |             |             |          |
| 25          | 20         | 16         | GPIOA3   | GPIOA3  | ANA3&VREFLA&CMPA_IN2 |             |             |          |
| 26          | 21         | 17         | GPIOB7   | GPIOB7  | ANB7&ANC15&CMPB_IN2  |             |             |          |
| 27          | 22         | 18         | GPIOC5   | GPIOC5  | DACO                 | XB_IN7      |             |          |
| 28          | 23         | 19         | GPIOB6   | GPIOB6  | ANB6&ANC14&CMPB_IN1  |             |             |          |
| 29          | 24         | 20         | GPIOB5   | GPIOB5  | ANB5&ANC13&CMPC_IN2  |             |             |          |
| 30          | 25         | 21         | GPIOB4   | GPIOB4  | ANB4&ANC12&CMPC_IN1  |             |             |          |
| 31          | 26         | 22         | VDDA     | VDDA    |                      |             |             |          |
| 32          | 27         | 23         | VSSA     | VSSA    |                      |             |             |          |
| 33          | 28         | 24         | GPIOB0   | GPIOB0  | ANB0&CMPB_IN3        |             |             |          |
| 34          | 29         | 25         | GPIOB1   | GPIOB1  | ANB1&CMPB_IN0        |             |             |          |
| 35          | 30         | 26         | VCAP     | VCAP    |                      |             |             |          |
| 36          | 31         | 27         | GPIOB2   | GPIOB2  | ANB2&VREFHB&CMPC_IN3 |             |             |          |
| 37          | 32         | —          | GPIOA11  | GPIOA11 | ANC19&VREFHC         |             |             |          |
| 38          | 33         | —          | GPIOB8   | GPIOB8  | ANC20&VREFLC         |             |             |          |
| 39          | —          | —          | GPIOB9   | GPIOB9  | ANC21                | XB_IN9      | MISO2       |          |
| 40          | —          | —          | GPIOB10  | GPIOB10 | ANC22                | XB_IN8      | MOSI2       |          |
| 41          | —          | —          | GPIOB11  | GPIOB11 | ANC23                | XB_IN7      | SCLK2       |          |
| 42          | 34         | 28         | GPIOB3   | GPIOB3  | ANB3&VREFLB&CMPC_IN0 |             |             |          |
| 43          | 35         | 29         | VDD      | VDD     |                      |             |             |          |
| 44          | 36         | 30         | VSS      | VSS     |                      |             |             |          |
| 45          | —          | —          | GPIOF11  | GPIOF11 | TXD0                 | XB_IN11     |             |          |
| 46          | —          | —          | GPIOF15  | GPIOF15 | RXD0                 | XB_IN10     |             |          |
| 47          | 37         | —          | PIOD7    | PIOD7   | XB_OUT11             | XB_IN7      | MISO1       |          |
| 48          | 38         | —          | PIOG11   | PIOG11  | TB3                  | CLKO0       | MOSI1       |          |
| 49          | 39         | 31         | PIOC6    | PIOC6   | TA2                  | XB_IN3      | CMP_REF     |          |
| 50          | 40         | 32         | PIOC7    | PIOC7   | SS0_B                | TXD0        |             |          |
| 51          | —          | —          | PIOG10   | PIOG10  | PWMB_2X              | PWMA_2X     | XB_IN8      | SS2_B    |
| 52          | 41         | 33         | PIOC8    | PIOC8   | MISO0                | RXD0        | XB_IN9      |          |
| 53          | 42         | 34         | PIOC9    | PIOC9   | SCLK0                | XB_IN4      |             |          |
| 54          | 43         | 35         | PIOC10   | PIOC10  | MOSI0                | XB_IN5      | MISO0       |          |
| 55          | 44         | 36         | PIOF0    | PIOF0   | XB_IN6               | TB2         | SCLK1       |          |
| 56          | 45         | —          | PIOF10   | PIOF10  | TXD2                 | PWMA_FAULT6 | PWMB_FAULT6 | XB_OUT10 |
| 57          | 46         | —          | PIOF9    | PIOF9   | RXD2                 | PWMA_FAULT7 | PWMB_FAULT7 | XB_OUT11 |
| 58          | 47         | 37         | PIOC11   | PIOC11  | CANTX                | SCL1        | TXD1        |          |
| 59          | 48         | 38         | PIOC12   | PIOC12  | CANRX                | SDA1        | RXD1        |          |

## Pinout

| 100<br>LQFP | 80<br>LQFP | 64<br>LQFP | Pin Name | Default | ALT0        | ALT1        | ALT2      | ALT3     |
|-------------|------------|------------|----------|---------|-------------|-------------|-----------|----------|
| 60          | 49         | 39         | GPIOF2   | GPIOF2  | SCL1        | XB_OUT6     |           |          |
| 61          | 50         | 40         | GPIOF3   | GPIOF3  | SDA1        | XB_OUT7     |           |          |
| 62          | 51         | 41         | GPIOF4   | GPIOF4  | TXD1        | XB_OUT8     |           |          |
| 63          | 52         | 42         | GPIOF5   | GPIOF5  | RXD1        | XB_OUT9     |           |          |
| 64          | —          | —          | GPIOG8   | GPIOG8  | PWMB_0X     | PWMA_0X     | TA2       | XB_OUT10 |
| 65          | —          | —          | GPIOG9   | GPIOG9  | PWMB_1X     | PWMA_1X     | TA3       | XB_OUT11 |
| 66          | 53         | 43         | VSS      | VSS     |             |             |           |          |
| 67          | 54         | 44         | VDD      | VDD     |             |             |           |          |
| 68          | 55         | 45         | GPIOE0   | GPIOE0  | PWMA_0B     |             |           |          |
| 69          | 56         | 46         | GPIOE1   | GPIOE1  | PWMA_0A     |             |           |          |
| 70          | 57         | —          | GPIOG2   | GPIOG2  | PWMB_0B     | XB_OUT4     |           |          |
| 71          | 58         | —          | GPIOG3   | GPIOG3  | PWMB_0A     | XB_OUT5     |           |          |
| 72          | —          | —          | GPIOE8   | GPIOE8  | PWMB_2B     | PWMA_FAULT0 |           |          |
| 73          | —          | —          | GPIOE9   | GPIOE9  | PWMB_2A     | PWMA_FAULT1 |           |          |
| 74          | 59         | 47         | GPIOE2   | GPIOE2  | PWMA_1B     |             |           |          |
| 75          | 60         | 48         | GPIOE3   | GPIOE3  | PWMA_1A     |             |           |          |
| 76          | 61         | 49         | GPIOC13  | GPIOC13 | TA3         | XB_IN6      | EWM_OUT_B |          |
| 77          | 62         | 50         | GPIOF1   | GPIOF1  | CLKO1       | XB_IN7      | CMPC_O    |          |
| 78          | 63         | —          | GPIOG0   | GPIOG0  | PWMB_1B     | XB_OUT6     |           |          |
| 79          | 64         | —          | GPIOG1   | GPIOG1  | PWMB_1A     | XB_OUT7     |           |          |
| 80          | —          | —          | GPIOG4   | GPIOG4  | PWMB_3B     | PWMA_FAULT2 |           |          |
| 81          | —          | —          | GPIOG5   | GPIOG5  | PWMB_3A     | PWMA_FAULT3 |           |          |
| 82          | 65         | 51         | GPIOE4   | GPIOE4  | PWMA_2B     | XB_IN2      |           |          |
| 83          | 66         | 52         | GPIOE5   | GPIOE5  | PWMA_2A     | XB_IN3      |           |          |
| 84          | 67         | 53         | GPIOE6   | GPIOE6  | PWMA_3B     | XB_IN4      | PWMB_2B   |          |
| 85          | 68         | 54         | GPIOE7   | GPIOE7  | PWMA_3A     | XB_IN5      | PWMB_2A   |          |
| 86          | 69         | —          | GPIOG6   | GPIOG6  | PWMA_FAULT4 | PWMB_FAULT4 | TB2       | XB_OUT8  |
| 87          | 70         | 55         | GPIOC14  | GPIOC14 | SDA0        | XB_OUT4     |           |          |
| 88          | 71         | 56         | GPIOC15  | GPIOC15 | SCL0        | XB_OUT5     |           |          |
| 89          | —          | —          | GPIOF12  | GPIOF12 | MISO1       | PWMB_FAULT2 |           |          |
| 90          | —          | —          | GPIOF13  | GPIOF13 | MOSI1       | PWMB_FAULT1 |           |          |
| 91          | —          | —          | GPIOF14  | GPIOF14 | SCLK1       | PWMB_FAULT0 |           |          |
| 92          | 72         | —          | GPIOG7   | GPIOG7  | PWMA_FAULT5 | PWMB_FAULT5 | XB_OUT9   |          |
| 93          | 73         | 57         | VCAP     | VCAP    |             |             |           |          |
| 94          | 74         | 58         | GPIOF6   | GPIOF6  | TB2         | PWMA_3X     | PWMB_3X   | XB_IN2   |
| 95          | 75         | 59         | GPIOF7   | GPIOF7  | TB3         | CMPC_O      | SS1_B     | XB_IN3   |
| 96          | 76         | 60         | VDD      | VDD     |             |             |           |          |
| 97          | 77         | 61         | VSS      | VSS     |             |             |           |          |
| 98          | 78         | 62         | TDO      | TDO     | GPIOD1      |             |           |          |
| 99          | 79         | 63         | TMS      | TMS     | GPIOD3      |             |           |          |
| 100         | 80         | 64         | TDI      | TDI     | GPIOD0      |             |           |          |

# 12.2 Pinout diagrams

The following diagrams show pinouts for the packages. For each pin, the diagrams show the default function. However, many signals may be multiplexed onto a single pin.

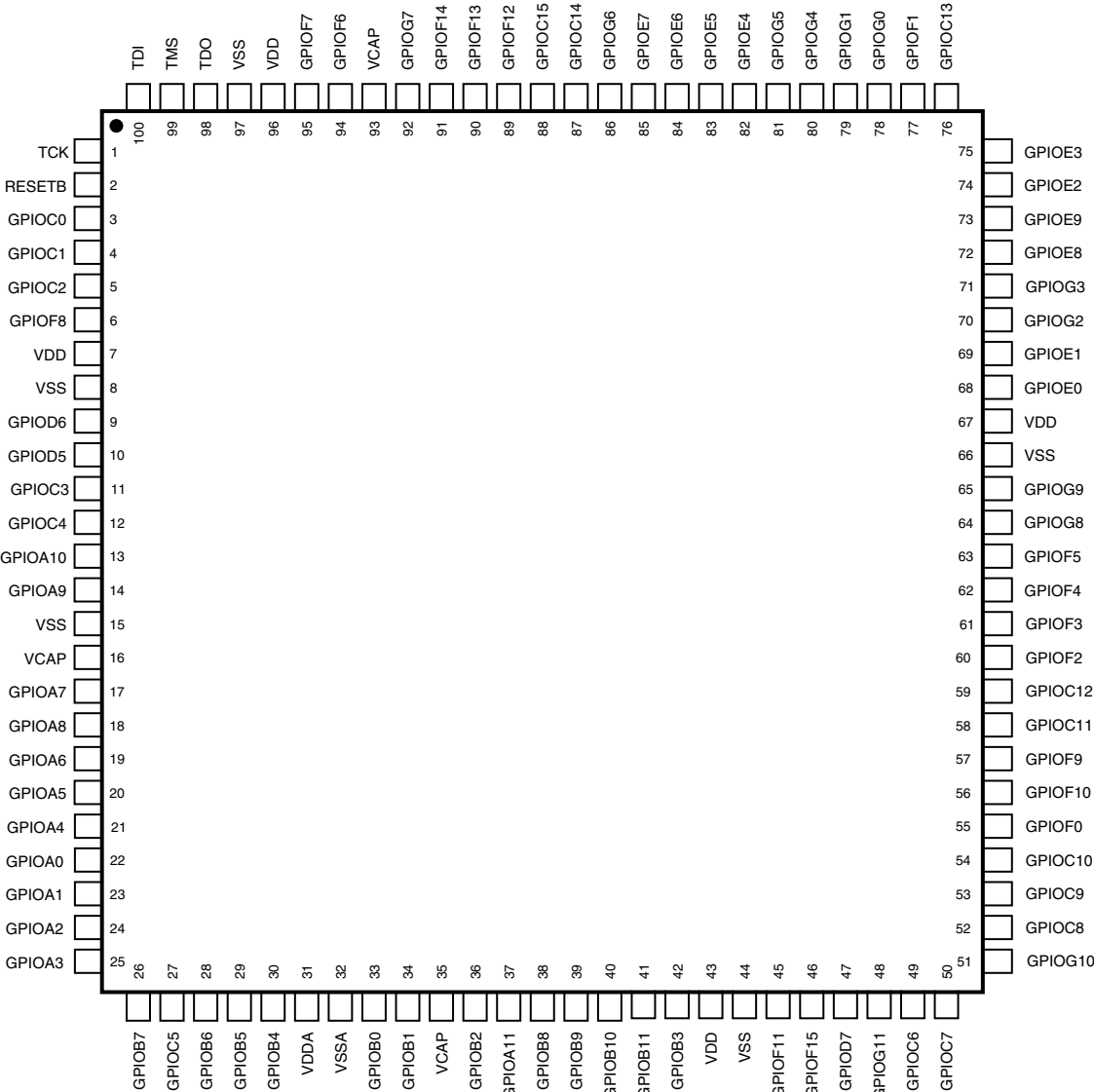


Figure 23. 100-pin LQFP

## NOTE

The RESETB pin is a 3.3 V pin only.

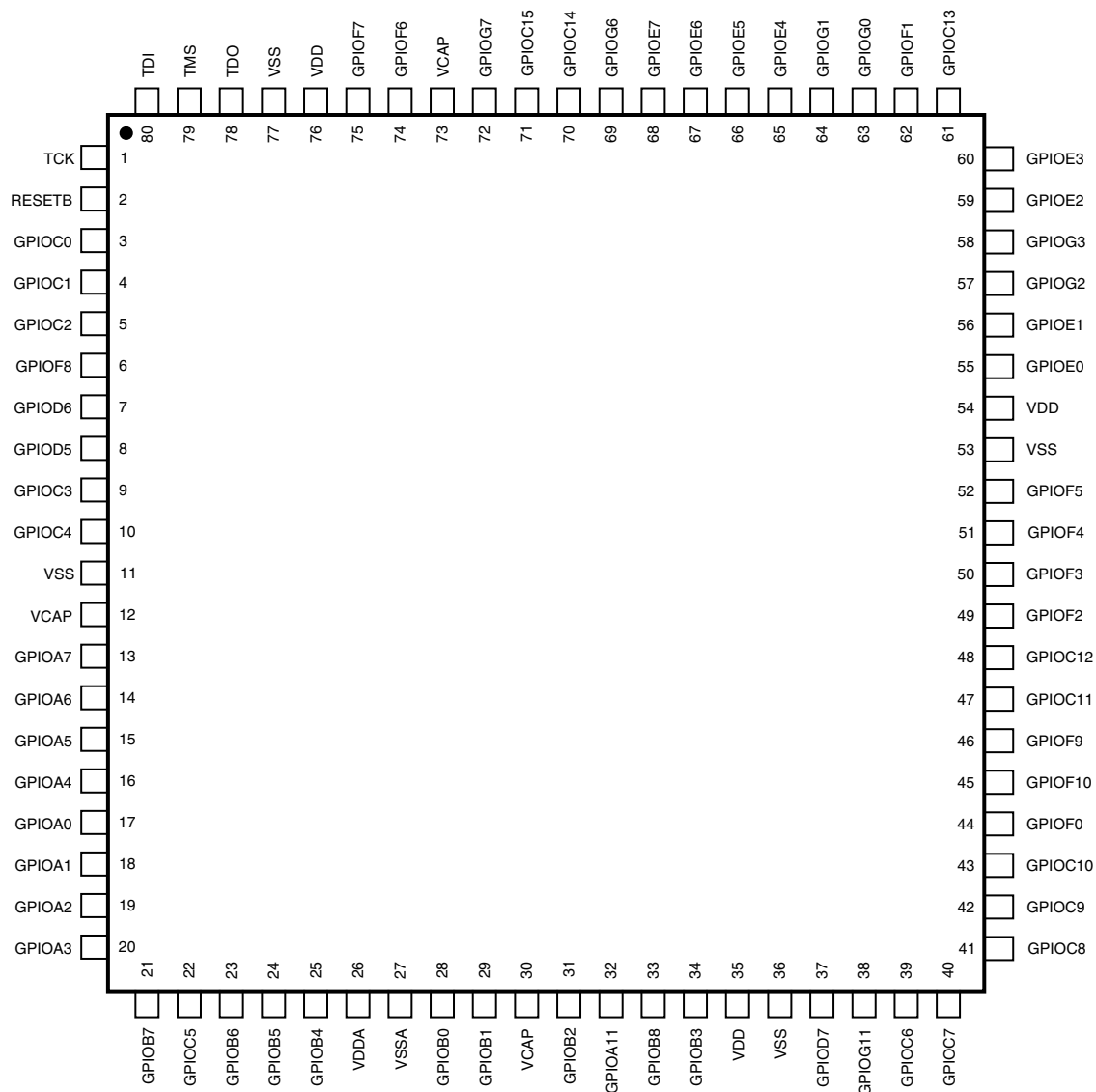


**Figure 24. 80-pin LQFP**

## NOTE

The RESETB pin is a 3.3 V pin only.

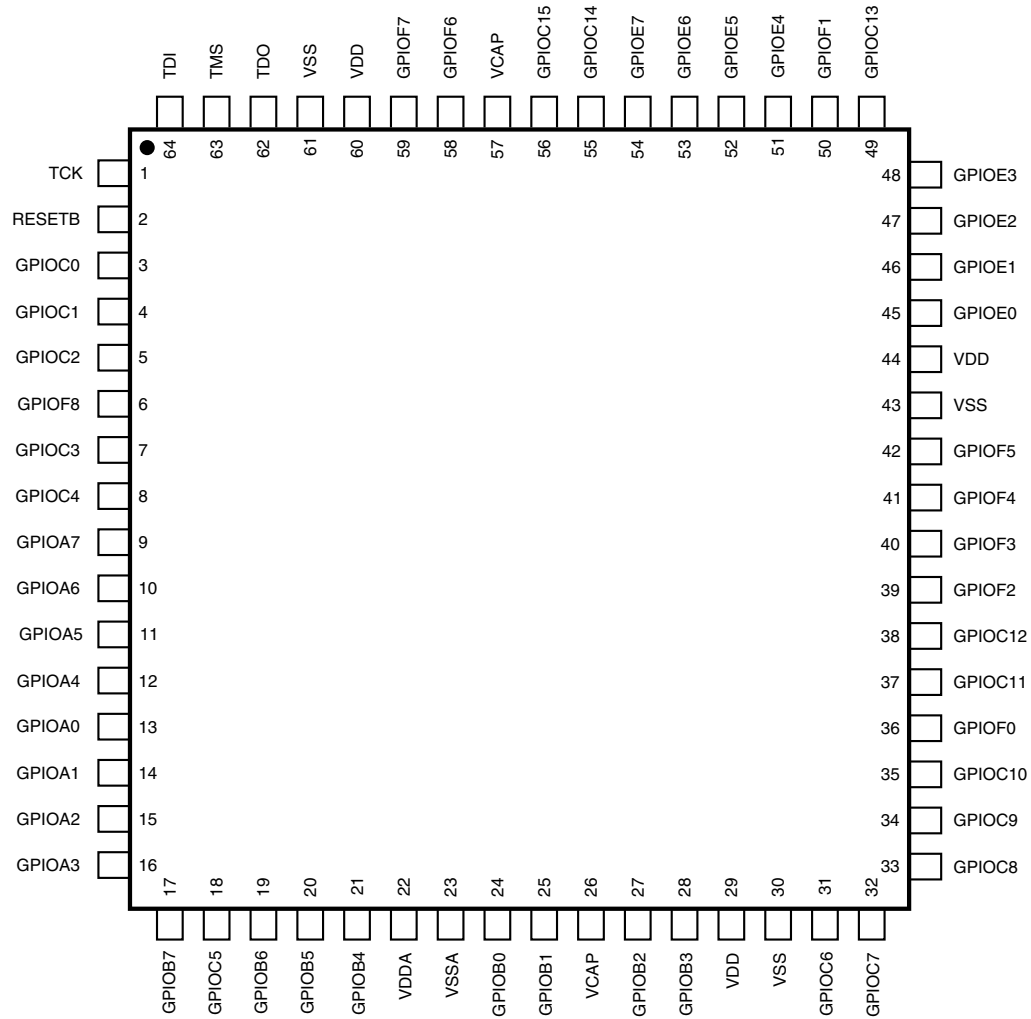


Figure 25. 64-pin LQFP

**NOTE**

The RESETB pin is a 3.3 V pin only.

## 13 Product documentation

The documents listed in [Table 38](#) are required for a complete description and proper design with the device. Documentation is available from local Freescale distributors, Freescale Semiconductor sales offices, or online at [freescale.com](http://freescale.com).

**Table 38. Device documentation**

| Topic                                 | Description                                                                                                                       | Document Number  |
|---------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|------------------|
| DSP56800E/DSP56800EX Reference Manual | Detailed description of the 56800EX family architecture, 32-bit digital signal controller core processor, and the instruction set | DSP56800ERM      |
| MC56F847xx Reference Manual           | Detailed functional description and programming model                                                                             | MC56F847XXRM     |
| MC56F847xx Data Sheet                 | Electrical and timing specifications, pin descriptions, and package information (this document)                                   | MC56F847XX       |
| MC56F84xxx Errata                     | Details any chip issues that might be present                                                                                     | MC56F84XXX_0N27E |

## 14 Revision history

The following table summarizes changes to this document since the release of the previous version.

**Table 39. Revision history**

| Rev. | Date    | Substantial Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 3.1  | 06/2014 | <p>Changes include:</p> <ul style="list-style-type: none"> <li>• Updates and corrections to "56F844xx/5xx/7xx family" table.</li> <li>• In "Signal groups" section, in "Functional Group Pin Allocations" table, made corrections to "Functional Group Pin Allocations" table.</li> <li>• For "Power mode transition operating behaviors" section, <ul style="list-style-type: none"> <li>• Changed the name to "Power mode operating behaviors".</li> </ul> </li> <li>• In "Power consumption operating behaviors" section, updated mode current values in "Current Consumption" table.</li> <li>• In "Memories and memory interfaces" section, <ul style="list-style-type: none"> <li>• "Flash Memory Characteristics" section is now called "Flash electrical specifications" section.</li> <li>• Added new section "Flash timing specifications — program and erase", where the "Flash Timing Parameters" table (now called "NVM program/erase timing specifications" table, and table was updated.</li> <li>• Added new section "Flash high voltage current behaviors".</li> </ul> </li> <li>• In "Pinout" section, in "Signal Multiplexing and Pin Assignments" section, <ul style="list-style-type: none"> <li>• Added 3 notes.</li> <li>• In pin mux table, changed SCK0 to SCLK0, SCK1 to SCLK1, updates to 64LQFP[62-64] and 48LQFP[46-48].</li> <li>• In "64-pin LQFP" figure, made updates to pins 62-64, and added a note.</li> </ul> </li> </ul> |

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